# S29NS-P MirrorBit ${ }^{\text {TM }}$ Flash Family <br> S29NS512P S29NS256P S29NS128P <br> 512/256/128 Mb (32/16/8 M x 16 bit), 1.8 V Burst Simultaneous <br> Read/Write, Multiplexed MirrorBit Flash Memory 

Data Sheet (Advance Information)

Notice to Readers: This document states the current technical specifications regarding the Spansion product(s) described herein. Each product described herein may be designated as Advance Information, Preliminary, or Full Production. See Notice On Data Sheet Designations for definitions.

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## Combination

Some data sheets contain a combination of products with different designations (Advance Information, Preliminary, or Full Production). This type of document distinguishes these products and their designations wherever necessary, typically on the first page, the ordering information page, and pages with the DC Characteristics table and the AC Erase and Program table (in the table notes). The disclaimer on the first page refers the reader to the notice on this page.

## Full Production (No Designation on Document)

When a product has been in production for a period of time such that no changes or only nominal changes are expected, the Preliminary designation is removed from the data sheet. Nominal changes may include those affecting the number of ordering part numbers available, such as the addition or deletion of a speed option, temperature range, package type, or $\mathrm{V}_{\mathrm{IO}}$ range. Changes may also include those needed to clarify a description or to correct a typographical error or incorrect specification. Spansion Inc. applies the following conditions to documents in this category:
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# S29NS-P MirrorBit ${ }^{\text {TM }}$ Flash Family <br> S29NS512P S29NS256P S29NS128P <br> 512/256/128 Mb (32/16/8 M x 16 bit), 1.8 V Burst Simultaneous Read/Write, Multiplexed MirrorBit Flash Memory 

Data Sheet (Advance Information)

## Features

■ Single 1.8 V read/program/erase (1.70-1.95 V)

- 90 nm MirrorBit Technology

■ Multiplexed Data and Address for reduced I/O count

- Simultaneous Read/Write operation
- Full/Half drive output slew rate control
- 32-word Write Buffer
- Sixteen-bank architecture consisting of 64/32/16 MB for NS512/256/128P, respectively
- Four 32 KB sectors at the top of memory array (NS256/128P)

■ 512 128KB sectors (NS512P), 255/127 128KB sectors (NS256/ 128P)

- Programmable linear ( $8 / 16 / 32$ ) with or without wrap around and continuous burst read modes
- Secured Silicon Sector region consisting of 128 words each for factory and customer
- 20-year data retention (typical)

■ Cycling Endurance: 100,000 cycles per sector (typical)

- RDY output indicates data available to system
- Command set compatible with JEDEC (42.4) standard


## Performance Characteristics

| Read Access Times |  |
| :--- | :---: |
| Speed Option (MHz) | 108 |
| Max. Synch. Latency, ns $\left(\mathrm{t}_{\mathrm{IACC}}\right)$ | 80 |
| Max. Synch. Burst Access, $\mathrm{ns}\left(\mathrm{t}_{\mathrm{BACC}}\right)$ | 7.0 |
| Max. Asynch. Access Time, $\mathrm{ns}\left(\mathrm{t}_{\mathrm{ACC}}\right)$ | 80 |
| Max OE\# Access Time, ns $\left(\mathrm{t}_{\mathrm{OE}}\right)$ | 7.0 |

■ Hardware (WP\#) protection of highest two sectors
■ Top Boot sector configuration (NS256/128P)

- Handshaking by monitoring RDY

■ Offered Packages

- NS512P: 64-ball FBGA ( $8 \mathrm{~mm} \times 9.2 \mathrm{~mm}$ )
- NS256P/NS128P: 44-ball FBGA ( $6.2 \mathrm{~mm} \times 7.7 \mathrm{~mm}$ )
- Low $\mathrm{V}_{\mathrm{Cc}}$ write inhibit
- Persistent and Password methods of Advanced Sector Protection
- Write operation status bits indicate program and erase operation completion
- Suspend and Resume commands for Program and Erase operations
■ Unlock Bypass program command to reduce programming time
■ Synchronous or Asynchronous program operation, independent of burst control register settings
- $\mathrm{V}_{\mathrm{PP}}$ input pin to reduce factory programming time
- Support for Common Flash Interface (CFI)

| Current Consumption (typical values) |  |
| :--- | :---: |
| Continuous Burst Read @ 108 MHz | 42 mA |
| Simultaneous Operation 108 MHz | 60 mA |
| Program | 30 mA |
| Standby Mode | $20 \mu \mathrm{~A}$ |


| Typical Program \& Erase Times |  |
| :--- | :---: |
| Single Word Programming | $30 \mu \mathrm{~s}$ |
| Effective Write Buffer Programming ( $\mathrm{V}_{\mathrm{CC}}$ ) Per Word | $6 \mu \mathrm{~s}$ |
| Effective Write Buffer Programming ( $\mathrm{V}_{\mathrm{PP}}$ ) Per Word | $4 \mu \mathrm{~s}$ |
| Sector Erase (16 Kword Sector) | 350 ms |
| Sector Erase (64 Kword Sector) | 600 ms |

## General Description

The Spansion S29NS512/256/128P are MirrorBit Flash products fabricated on 90 nm process technology. These burst mode Flash devices are capable of performing simultaneous read and write operations with zero latency on two separate banks using multiplexed data and address pins. These products can operate up to 108 MHz and use a single $\mathrm{V}_{\mathrm{CC}}$ of 1.7 V to 1.95 V that makes them ideal for the demanding wireless applications of today that require higher density, better performance, and lowered power consumption.

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## 1. Ordering Information

The ordering part number is formed by a valid combination of the following:
S29NS

| Valid Combinations |  |  |  | Package Type |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Base Ordering <br> Part Number | Speed <br> Option | Package Type, Material, <br> \& Temperature Range | Packing <br> Type |  |  |
| S29NS512P |  |  |  |  | $8.0 \mathrm{~mm} \times 9.2 \mathrm{~mm}, 64$-ball |
| S29NS256P | OP, OS, AB | BJW (Lead (Pb)-free, LF35) | $0,3(1)$ | 00 | $6.2 \mathrm{~mm} \times 7.7 \mathrm{~mm}, 44$-ball |
| S29NS128P |  |  |  |  |  |

## Notes

1. Type 0 is standard. Specify other options as required.
2. BGA package marking omits leading S29 and packing type designator from ordering part number.

## Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult your local sales office to confirm availability of specific valid combinations and to check on newly released combinations.

## 2. Input/Output Descriptions \& Logic Symbol

Table 2.1 identifies the input and output package connections provided on the device.
Table 2.1 Input/Output Descriptions

| Symbol | Type | Description |
| :---: | :---: | :---: |
| A24-A16 | Input | Address inputs, S29NS512P |
| A23-A16 | Input | Address inputs, S29NS256P |
| A22-A16 | Input | Address inputs, S29NS128P |
| A/DQ15 - A/DQ0 | I/O | Multiplexed Address/Data input/output |
| CE\# | Input | Chip Enable. Asynchronous relative to CLK for the Burst mode. |
| OE\# | Input | Output Enable. Asynchronous relative to CLK for the Burst mode |
| WE\# | Input | Write Enable |
| $\mathrm{V}_{\mathrm{CC}}$ | Supply | Device Power Supply |
| $\mathrm{V}_{\mathrm{CCQ}}$ | Supply | Input/Output Power Supply (must be ramped simultaneously with $\mathrm{V}_{\mathrm{CC}}$ ) |
| $\mathrm{V}_{\text {SS }}$ | I/O | Ground |
| $\mathrm{V}_{\text {SSQ }}$ | 1/O | Input/Output Ground |
| NC | No Connect | No Connected internally |
| RDY | Output | Ready. Indicates when valid burst data is ready to be read |
| CLK | Input | The first rising edge of CLK in conjunction with AVD\# low latches address input and activates burst mode operation. After the initial word is output, subsequent rising edges of CLK increment the internal address counter. CLK should remain low during asynchronous access |
| AVD\# | Input | Address Valid input. Indicates to device that the valid address is present on the address inputs (address bits A15 - A0 are multiplexed, address bits Amax - A16 are address only). $\mathrm{V}_{\mathrm{IL}}=$ for asynchronous mode, indicates valid address; for burst mode, cause staring address to be latched on rising edge of CLK. <br> $\mathrm{V}_{\mathrm{IH}}=$ device ignores address inputs |
| RESET\# | Input | Hardware Reset. Low = device resets and returns to reading array data. |
| WP\# | Input | Write Protect. At $\mathrm{V}_{\mathrm{IL}}$, disables program and erase functions in the four top sectors. Should be at $\mathrm{V}_{\mathrm{IH}}$ for all other conditions. |
| $\mathrm{V}_{\mathrm{PP}}$ | Input | Accelerated input. <br> At $\mathrm{V}_{\mathrm{HH}}$, accelerates programming; automatically places device in unlock bypass mode. At $\mathrm{V}_{\mathrm{IL}}$,disables all program and erase functions. Should be at $\mathrm{V}_{\mathrm{IH}}$ for all other conditions. |
| RFU | Reserved | Reserved for future use |

## 3. Block Diagrams

Figure 3.1 Simultaneous Operation Circuit


## Notes

1. Amax $=$ A24 for NS512P, A23 for NS256P, A22 for NS128P.
2. Bank (n) $=15$ for NS512P/ NS256P/NS 128 P.

## 4. Physical Dimensions/Connection Diagrams

This section shows the I/O designations and package specifications for the OPN.

### 4.1 Related Documents

The following documents contain information relating to the S29NS-P devices. Click on the title or go to www.spansion.com, or request a copy from your sales office.

■ Considerations for X-ray Inspection of Surface-Mounted Flash Integrated Circuits

### 4.2 Special Handling Instructions for FBGA Package

Special handling is required for Flash Memory products in FBGA packages.
Flash memory devices in FBGA packages may be damaged if exposed to ultrasonic cleaning methods. The package and/or data integrity may be compromised if the package body is exposed to temperatures above $150^{\circ} \mathrm{C}$ for prolonged periods of time.

## 64-Ball Fine-Pitch Grid Array, S29NS5I2P

Figure 4.1 64-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS512P Top View, Balls Facing Down


Figure 2.I.

## 44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS256P

Figure 4.2 44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS256P Top View, Balls Facing Down


## 44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS128P

Figure 4.3 44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS128P Top View, Balls Facing Down


## VDD064—64-Ball Very Thin Fine-Pitch Ball Grid Array

Figure 4.4 VDD064—64-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS512P


| PACKAGE | VDD 064 |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| JEDEC | N/A |  |  |  |
|  | $8.00 \mathrm{~mm} \times 9.20 \mathrm{~mm}$ NOM <br> PACKAGE |  |  |  |
| SYMBOL | MIN | NOM | MAX | NOTE |
| A | 0.86 | --- | 1.00 | OVERALL THICKNESS |
| A1 | 0.20 | --- | --- | BALL HEIGHT |
| A2 | 0.66 | 0.71 | 0.76 | BODY THICKNESS |
| D | 7.90 | 8.00 | 8.10 | BODY SIZE |
| E | 9.10 | 9.20 | 9.30 | BODY SIZE |
| D1 | 4.50 |  |  | BALL FOOTPRINT |
| E1 | 2.50 |  |  | BALL FOOTPRINT |
| MD | 10 |  |  | ROW MATRIX SIZE D DIRECTION |
| ME | 6 |  |  | ROW MATRIX SIZE E DIRECTION |
| N | 64 |  |  | TOTAL BALL COUNT |
| $\varnothing \mathrm{b}$ | 0.25 | 0.30 | 0.35 | BALL DIAMETER |
| e | 0.50 |  |  | BALL PITCH |
| SD / SE | 0.25 |  |  | SOLDER BALL PLACEMENT |
|  |  |  |  | DEPOPULATED SOLDER BALLS |

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
2. ALL DIMENSIONS ARE IN MILLIMETERS
3. BALL POSITION DESIGNATION PER JESD 95-1, SPP-010 (EXCEPT AS NOTED).
4. e REPRESENTS THE SOLDER BALL GRID PITCH.
5. SYMBOL "MD" IS THE BALL ROW MATRIX SIZE IN THE "D" DIRECTION.
sYMBOL "ME" IS THE BALL COLUMN MATRIX SIZE IN THE "E" DIRECTION
N IS THE TOTAL NUMBER OF SOLDER BALLS.
6 DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM C.
7 SD AND SE ARE MEASURED WITH RESPECT TO DATUMS A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW.
WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN THE OUTER ROW PARALLEL TO THE D OR E DIMENSION, RESPECTIVELY, SD OR SE $=0.000$.
WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE = e/2
6. NOT USED.
7. "+" INDICATES THE THEORETICAL CENTER OF DEPOPULATED BALLS.
8. A1 CORNER TO BE IDENTIFIED BY CHAMFER, LASER OR INK MARK, METALLIZED MARK INDENTATION OR OTHER MEANS

## VDE44-44-Ball Very Thin Fine-Pitch Ball Grid Array, 6.2mm x 7.7 mm

Figure 4.5 VDE044—44-Ball Very Thin Fine-Pitch Ball Grid Array, S29NS128/256P


| PACKAGE | VDE 044 |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| JEDEC | N/A |  |  |  |
|  | $7.70 \mathrm{~mm} \times 6.20 \mathrm{~mm}$ NOM PACKAGE |  |  |  |
| SYMBOL | MIN | NOM | MAX | NOTE |
| A | 0.86 | --- | 1.00 | OVERALL THICKNESS |
| A1 | 0.20 | --- | --- | BALL HEIGHT |
| A2 | 0.66 | 0.71 | 0.76 | BODY THICKNESS |
| D | 7.6 | 7.7 | 7.8 | BODY SIZE |
| E | 6.1 | 6.2 | 6.3 | BODY SIZE |
| D1 | 4.50 |  |  | BALL FOOTPRINT |
| E1 | 1.50 |  |  | BALL FOOTPRINT |
| MD | 10 |  |  | ROW MATRIX SIZE D DIRECTION |
| ME | 4 |  |  | ROW MATRIX SIZE E DIRECTION |
| N | 44 |  |  | TOTAL BALL COUNT |
| ¢b | 0.25 | 0.30 | 0.35 | BALL DIAMETER |
| e | 0.50 BSC. |  |  | BALL PITCH |
| SD / SE | 0.25 BSC. |  |  | SOLDER BALL PLACEMENT |
| ? |  |  |  | DEPOPULATED SOLDER BALLS |

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS
3. BALL POSITION DESIGNATION PER JESD 95-1, SPP-010 (EXCEPT AS NOTED).
4. e REPRESENTS THE SOLDER BALL GRID PITCH.
5. SYMBOL "MD" IS THE BALL ROW MATRIX SIZE IN THE "D" DIRECTION.
SYMBOL "ME" IS THE BALL COLUMN MATRIX SIZE IN THE E" DIRECTION
N IS THE TOTAL NUMBER OF SOLDER BALLS.
6 DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM C.
7 SD AND SE ARE MEASURED WITH RESPECT TO DATUMS A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW.
WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN ? THE OUTER ROW PARALLEL TO THE D OR E DIMENSION, RESPECTIVELY, SD OR SE $=0.000$.
WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE = e/2
6. NOT USED.
7. "+" INDICATES THE THEORETICAL CENTER OF DEPOPULATED BALLS
8. A1 CORNER TO BE IDENTIFIED BY CHAMFER, LASER OR INK MARK, METALLIZED MARK INDENTATION OR OTHER MEANS.

## 5. Product Overview

The S29NS-P family consists of 512,256 , and $128 \mathrm{Mb}, 1.8$ volts-only, simultaneous read/write burst mode, multiplexed Flash device optimized for today's wireless designs that demand a large storage array, rich functionality, and low power consumption.

These devices are organized in 32,16 , or 8 Mwords of 16 bits each and are capable of continuous, synchronous (burst) read or linear read (8-word, 16 -word, or 32 -word aligned group) with or without wrap around. These flash devices multiplex the data and addresses for reduced I/O count. These products also offer single word programming or a 32-word buffer for programming with program/erase and suspend functionality. Additional features include:

- Advanced Sector Protection methods for protecting sectors as required
- 256 words of Secured Silicon area for storing customer and factory secured information. The Secured Silicon Sector is One Time Programmable.


### 5.1 Memory Map

The S29NS512/256/128P Mb devices consist of 16 banks organized as shown in Tables 5.1-5.3.
Table 5.1 S29NS512P Sector \& Memory Address Map (Sheet 1 of 8)

| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
|  | SAO | 64 Kwords | 000000h-00FFFFh |
|  | SA1 | 64 Kwords | 010000h-01FFFFh |
|  | SA2 | 64 Kwords | 020000h-02FFFFh |
|  | SA3 | 64 Kwords | 030000h-03FFFFh |
|  | SA4 | 64 Kwords | 040000h-04FFFFh |
|  | SA5 | 64 Kwords | 050000h-05FFFFh |
|  | SA6 | 64 Kwords | 060000h-06FFFFh |
|  | SA7 | 64 Kwords | 070000h-07FFFFh |
|  | SA8 | 64 Kwords | 080000h-08FFFFh |
|  | SA9 | 64 Kwords | 090000h-09FFFFh |
|  | SA10 | 64 Kwords | OA0000h-0AFFFFh |
|  | SA11 | 64 Kwords | OB0000h-0BFFFFh |
|  | SA12 | 64 Kwords | 0C0000h-0CFFFFh |
|  | SA13 | 64 Kwords | 0D0000h-0DFFFFh |
|  | SA14 | 64 Kwords | OE0000h-0EFFFFh |
|  | SA15 | 64 Kwords | OF0000h-0FFFFFh |
|  | SA16 | 64 Kwords | 100000h-10FFFFh |
|  | SA17 | 64 Kwords | 110000h-11FFFFh |
|  | SA18 | 64 Kwords | 120000h-12FFFFh |
|  | SA19 | 64 Kwords | 130000h-13FFFFh |
|  | SA20 | 64 Kwords | 140000h-14FFFFh |
|  | SA21 | 64 Kwords | 150000h-15FFFFh |
|  | SA22 | 64 Kwords | 160000h-16FFFFh |
|  | SA23 | 64 Kwords | 170000h-17FFFFh |
|  | SA24 | 64 Kwords | 180000h-18FFFFh |
|  | SA25 | 64 Kwords | 190000h-19FFFFh |
|  | SA26 | 64 Kwords | 1A0000h-1AFFFFh |
|  | SA27 | 64 Kwords | 1B0000h-1BFFFFh |
|  | SA28 | 64 Kwords | 1C0000h-1CFFFFh |
|  | SA29 | 64 Kwords | 1D0000h-1DFFFFh |
|  | SA30 | 64 Kwords | 1E0000h-1EFFFFh |
|  | SA31 | 64 Kwords | 1F0000h-1FFFFFh |


| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
|  | SA32 | 64 Kwords | 200000h-20FFFFh |
|  | SA33 | 64 Kwords | 210000h-21FFFFh |
|  | SA34 | 64 Kwords | 220000h-22FFFFh |
|  | SA35 | 64 Kwords | 230000h-23FFFFh |
|  | SA36 | 64 Kwords | 240000h-24FFFFh |
|  | SA37 | 64 Kwords | 250000h-25FFFFh |
|  | SA38 | 64 Kwords | 260000h-26FFFFh |
|  | SA39 | 64 Kwords | 270000h-27FFFFh |
|  | SA40 | 64 Kwords | 280000h-28FFFFh |
|  | SA41 | 64 Kwords | 290000h-29FFFFh |
|  | SA42 | 64 Kwords | 2A0000h-2AFFFFFh |
|  | SA43 | 64 Kwords | 2B0000h-2BFFFFFh |
|  | SA44 | 64 Kwords | 2C0000h-2CFFFFh |
|  | SA45 | 64 Kwords | 2D0000h-2DFFFFh |
|  | SA46 | 64 Kwords | 2E0000h-2EFFFFh |
|  | SA47 | 64 Kwords | 2F0000h-2FFFFFh |
|  | SA48 | 64 Kwords | 300000h-30FFFFh |
|  | SA49 | 64 Kwords | 310000h-31FFFFh |
|  | SA50 | 64 Kwords | 320000h-32FFFFh |
|  | SA51 | 64 Kwords | 330000h-33FFFFh |
|  | SA52 | 64 Kwords | 340000h-34FFFFh |
|  | SA53 | 64 Kwords | 350000h-35FFFFh |
|  | SA54 | 64 Kwords | 360000h-36FFFFh |
|  | SA55 | 64 Kwords | 370000h-37FFFFh |
|  | SA56 | 64 Kwords | 380000h-38FFFFh |
|  | SA57 | 64 Kwords | 390000h-39FFFFh |
|  | SA58 | 64 Kwords | 3A0000h-3AFFFFFh |
|  | SA59 | 64 Kwords | 3B0000h-3BFFFFFh |
|  | SA60 | 64 Kwords | 3C0000h-3CFFFFh |
|  | SA61 | 64 Kwords | 3D0000h-3DFFFFh |
|  | SA62 | 64 Kwords | 3E0000h-3EFFFFFh |
|  | SA63 | 64 Kwords | 3F0000h-3FFFFFFh |

Table 5.1 S29NS512P Sector \& Memory Address Map (Sheet 2 of 8)

| Bank | Sector | Sector Size | Address Range | Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { N } \\ & \stackrel{\rightharpoonup}{\bar{L}} \\ & \text { © } \end{aligned}$ | SA64 | 64 Kwords | 400000h-40FFFFh | $\begin{aligned} & \infty \\ & \stackrel{n}{\bar{N}} \\ & \stackrel{\sim}{\tilde{\infty}} \end{aligned}$ | SA96 | 64 K words | 600000h-60FFFFh |
|  | SA65 | 64 Kwords | 410000h-41FFFFh |  | SA97 | 64 K words | 610000h-61FFFFh |
|  | SA66 | 64 Kwords | 420000h-42FFFFh |  | SA98 | 64 K words | 620000h-62FFFFh |
|  | SA67 | 64 Kwords | 430000h-43FFFFh |  | SA99 | 64 K words | 630000h-63FFFFh |
|  | SA68 | 64 Kwords | 440000h-44FFFFh |  | SA100 | 64 K words | 640000h-64FFFFh |
|  | SA69 | 64 Kwords | 450000h-45FFFFh |  | SA101 | 64 K words | 650000h-65FFFFh |
|  | SA70 | 64 Kwords | 460000h-46FFFFh |  | SA102 | 64 K words | 660000h-66FFFFh |
|  | SA71 | 64 Kwords | 470000h-47FFFFh |  | SA103 | 64 K words | 670000h-67FFFFh |
|  | SA72 | 64 Kwords | 480000h-48FFFFh |  | SA104 | 64 K words | 680000h-68FFFFh |
|  | SA73 | 64 Kwords | 490000h-49FFFFh |  | SA105 | 64 K words | 690000h-69FFFFh |
|  | SA74 | 64 Kwords | 4A0000h-4AFFFFh |  | SA106 | 64 K words | 6A0000h-6AFFFFFh |
|  | SA75 | 64 Kwords | 4B0000h-4BFFFFh |  | SA107 | 64 K words | 6B0000h-6BFFFFFh |
|  | SA76 | 64 Kwords | 4C0000h-4CFFFFh |  | SA108 | 64 K words | 6C0000h-6CFFFFh |
|  | SA77 | 64 Kwords | 4D0000h-4DFFFFh |  | SA109 | 64 K words | 6D0000h-6DFFFFh |
|  | SA78 | 64 Kwords | 4E0000h-4EFFFFh |  | SA110 | 64 K words | 6E0000h-6EFFFFFh |
|  | SA79 | 64 Kwords | 4F0000h-4FFFFFh |  | SA111 | 64 K words | 6F0000h-6FFFFFh |
|  | SA80 | 64 Kwords | 500000h-50FFFFh |  | SA112 | 64 K words | 700000h-70FFFFh |
|  | SA81 | 64 Kwords | 510000h-51FFFFh |  | SA113 | 64 K words | 710000h-71FFFFh |
|  | SA82 | 64 Kwords | 520000h-52FFFFh |  | SA114 | 64 K words | 720000h-72FFFFh |
|  | SA83 | 64 Kwords | 530000h-53FFFFh |  | SA115 | 64 K words | $730000 \mathrm{~h}-73 \mathrm{FFFFh}$ |
|  | SA84 | 64 Kwords | 540000h-54FFFFh |  | SA116 | 64 K words | 740000h-74FFFFh |
|  | SA85 | 64 Kwords | 550000h-55FFFFh |  | SA117 | 64 K words | 750000h-75FFFFh |
|  | SA86 | 64 Kwords | 560000h-56FFFFh |  | SA118 | 64 K words | 760000h-76FFFFh |
|  | SA87 | 64 Kwords | 570000h-57FFFFh |  | SA119 | 64 K words | 770000h-77FFFFh |
|  | SA88 | 64 Kwords | 580000h-58FFFFh |  | SA120 | 64 K words | 780000h-78FFFFh |
|  | SA89 | 64 Kwords | 590000h-59FFFFh |  | SA121 | 64 K words | 790000h-79FFFFh |
|  | SA90 | 64 Kwords | 5A0000h-5AFFFFh |  | SA122 | 64 K words | 7A0000h-7AFFFFh |
|  | SA91 | 64 Kwords | 5B0000h-5BFFFFh |  | SA123 | 64 K words | 7B0000h-7BFFFFFh |
|  | SA92 | 64 Kwords | 5C0000h-5CFFFFh |  | SA124 | 64 K words | 7C0000h-7CFFFFh |
|  | SA93 | 64 Kwords | 5D0000h-5DFFFFh |  | SA125 | 64 K words | 7D0000h-7DFFFFh |
|  | SA94 | 64 Kwords | 5E0000h-5EFFFFh |  | SA126 | 64 K words | 7E0000h-7EFFFFF |
|  | SA95 | 64 Kwords | 5F0000h-5FFFFFh |  | SA127 | 64 K words | 7F0000h-7FFFFFh |

Table 5.1 S29NS512P Sector \& Memory Address Map (Sheet 3 of 8)

| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
| $\begin{aligned} & \underset{\sim}{\mathbf{c}} \\ & \underset{\sim}{\mathbb{N}} \end{aligned}$ | SA128 | 64 Kwords | 800000h-80FFFFh |
|  | SA129 | 64 Kwords | 810000h-81FFFFh |
|  | SA130 | 64 Kwords | 820000h-82FFFFh |
|  | SA131 | 64 Kwords | 830000h-83FFFFh |
|  | SA132 | 64 Kwords | 840000h-84FFFFh |
|  | SA133 | 64 Kwords | 850000h-85FFFFh |
|  | SA134 | 64 Kwords | 860000h-86FFFFh |
|  | SA135 | 64 Kwords | 870000h-87FFFFh |
|  | SA136 | 64 Kwords | 880000h-88FFFFh |
|  | SA137 | 64 Kwords | 890000h-89FFFFh |
|  | SA138 | 64 Kwords | 8A0000h-8AFFFFh |
|  | SA139 | 64 Kwords | 8B0000h-8BFFFFh |
|  | SA140 | 64 Kwords | 8C0000h-8CFFFFh |
|  | SA141 | 64 Kwords | 8D0000h-8DFFFFh |
|  | SA142 | 64 Kwords | 8E0000h-8EFFFFh |
|  | SA143 | 64 Kwords | 8F0000h-8FFFFFh |
|  | SA144 | 64 Kwords | 900000h-90FFFFh |
|  | SA145 | 64 Kwords | 910000h-91FFFFh |
|  | SA146 | 64 Kwords | 920000h-92FFFFh |
|  | SA147 | 64 Kwords | 930000h-93FFFFh |
|  | SA148 | 64 Kwords | 940000h-94FFFFh |
|  | SA149 | 64 Kwords | 950000h-95FFFFh |
|  | SA150 | 64 Kwords | 960000h-96FFFFh |
|  | SA151 | 64 Kwords | 970000h-97FFFFh |
|  | SA152 | 64 Kwords | 980000h-98FFFFh |
|  | SA153 | 64 Kwords | 990000h-99FFFFh |
|  | SA154 | 64 Kwords | 9A0000h-9AFFFFh |
|  | SA155 | 64 Kwords | 9B0000h-9BFFFFh |
|  | SA156 | 64 Kwords | 9C0000h-9CFFFFh |
|  | SA157 | 64 Kwords | 9D0000h-9DFFFFh |
|  | SA158 | 64 Kwords | 9E0000h-9EFFFFh |
|  | SA159 | 64 Kwords | 9F0000h-9FFFFFh |


| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
|  | SA160 | 64 Kwords | A00000h-A0FFFFFh |
|  | SA161 | 64 Kwords | A10000h-A1FFFFh |
|  | SA162 | 64 Kwords | A20000h-A2FFFFFh |
|  | SA163 | 64 Kwords | A30000h-A3FFFFFh |
|  | SA164 | 64 Kwords | A40000h-A4FFFFF |
|  | SA165 | 64 Kwords | A50000h-A5FFFFFh |
|  | SA166 | 64 Kwords | A60000h-A6FFFFh |
|  | SA167 | 64 Kwords | A70000h-A7FFFFh |
|  | SA168 | 64 Kwords | A80000h-A8FFFFh |
|  | SA169 | 64 Kwords | A90000h-A9FFFFFh |
|  | SA170 | 64 Kwords | AA0000h-AAFFFFh |
|  | SA171 | 64 Kwords | AB0000h-ABFFFFh |
|  | SA172 | 64 Kwords | AC0000h-ACFFFFh |
|  | SA173 | 64 Kwords | AD0000h-ADFFFFh |
|  | SA174 | 64 Kwords | AE0000h-AEFFFFh |
|  | SA175 | 64 Kwords | AF0000h-AFFFFFh |
|  | SA176 | 64 Kwords | B00000h-B0FFFFh |
|  | SA177 | 64 Kwords | B10000h-B1FFFFh |
|  | SA178 | 64 Kwords | B20000h-B2FFFFFh |
|  | SA179 | 64 Kwords | B30000h-B3FFFFFh |
|  | SA180 | 64 Kwords | B40000h-B4FFFFFh |
|  | SA181 | 64 Kwords | B50000h-B5FFFFF |
|  | SA182 | 64 Kwords | B60000h-B6FFFFh |
|  | SA183 | 64 Kwords | B70000h-B7FFFFF |
|  | SA184 | 64 Kwords | B80000h-B8FFFFFh |
|  | SA185 | 64 Kwords | B90000h-B9FFFFh |
|  | SA186 | 64 Kwords | BA0000h-BAFFFFh |
|  | SA187 | 64 Kwords | BB0000h-BBFFFFh |
|  | SA188 | 64 Kwords | BC0000h-BCFFFFh |
|  | SA189 | 64 Kwords | BD0000h-BDFFFFh |
|  | SA190 | 64 Kwords | BE0000h-BEFFFFh |
|  | SA191 | 64 Kwords | BF0000h-BFFFFFh |

Table 5.1 S29NS512P Sector \& Memory Address Map (Sheet 4 of 8)

| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { o } \\ & \stackrel{\rightharpoonup}{\check{L}} \\ & \tilde{\sim} \end{aligned}$ | SA192 | 64 Kwords | C00000h-C0FFFFh |
|  | SA193 | 64 Kwords | C10000h-C1FFFFh |
|  | SA194 | 64 Kwords | C20000h-C2FFFFh |
|  | SA195 | 64 Kwords | C30000h-C3FFFFh |
|  | SA196 | 64 Kwords | C40000h-C4FFFFh |
|  | SA197 | 64 Kwords | C50000h-C5FFFFh |
|  | SA198 | 64 Kwords | C60000h-C6FFFFh |
|  | SA199 | 64 Kwords | C70000h-C7FFFFh |
|  | SA200 | 64 Kwords | C80000h-C8FFFFh |
|  | SA201 | 64 Kwords | C90000h-C9FFFFh |
|  | SA202 | 64 Kwords | CA0000h-CAFFFFh |
|  | SA203 | 64 Kwords | CB0000h-CBFFFFh |
|  | SA204 | 64 Kwords | CC0000h-CCFFFFh |
|  | SA205 | 64 Kwords | CD0000h-CDFFFFh |
|  | SA206 | 64 Kwords | CE0000h-CEFFFFh |
|  | SA207 | 64 Kwords | CF0000h-CFFFFFh |
|  | SA208 | 64 Kwords | D00000h-D0FFFFh |
|  | SA209 | 64 Kwords | D10000h-D1FFFFh |
|  | SA210 | 64 Kwords | D20000h-D2FFFFh |
|  | SA211 | 64 Kwords | D30000h-D3FFFFh |
|  | SA212 | 64 Kwords | D40000h-D4FFFFh |
|  | SA213 | 64 Kwords | D50000h-D5FFFFh |
|  | SA214 | 64 Kwords | D60000h-D6FFFFh |
|  | SA215 | 64 Kwords | D70000h-D7FFFFh |
|  | SA216 | 64 Kwords | D80000h-D8FFFFh |
|  | SA217 | 64 Kwords | D90000h-D9FFFFh |
|  | SA218 | 64 Kwords | DA0000h-DAFFFFh |
|  | SA219 | 64 Kwords | DB0000h-DBFFFFh |
|  | SA220 | 64 Kwords | DC0000h-DCFFFFh |
|  | SA221 | 64 Kwords | DD0000h-DDFFFFh |
|  | SA222 | 64 Kwords | DE0000h-DEFFFFh |
|  | SA223 | 64 Kwords | DF0000h-DFFFFFh |


| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
|  | SA224 | 64 K words | E00000h-E0FFFFh |
|  | SA225 | 64 K words | E10000h-E1FFFFh |
|  | SA226 | 64 K words | E20000h-E2FFFFh |
|  | SA227 | 64 K words | E30000h-E3FFFFh |
|  | SA228 | 64 K words | E40000h-E4FFFFh |
|  | SA229 | 64 K words | E50000h-E5FFFFh |
|  | SA230 | 64 K words | E60000h-E6FFFFh |
|  | SA231 | 64 K words | E70000h-E7FFFFh |
|  | SA232 | 64 K words | E80000h-E8FFFFh |
|  | SA233 | 64 K words | E90000h-E9FFFFh |
|  | SA234 | 64 K words | EA0000h-EAFFFFh |
|  | SA235 | 64 K words | EB0000h-EBFFFFh |
|  | SA236 | 64 K words | EC0000h-ECFFFFh |
|  | SA237 | 64 K words | ED0000h-EDFFFFh |
|  | SA238 | 64 K words | EE0000h-EEFFFFh |
|  | SA239 | 64 K words | EF0000h-EFFFFFh |
|  | SA240 | 64 K words | F00000h-F0FFFFh |
|  | SA241 | 64 K words | F10000h-F1FFFFh |
|  | SA242 | 64 K words | F20000h-F2FFFFh |
|  | SA243 | 64 K words | F30000h-F3FFFFh |
|  | SA244 | 64 K words | F40000h-F4FFFFh |
|  | SA245 | 64 K words | F50000h-F5FFFFh |
|  | SA246 | 64 K words | F60000h-F6FFFFh |
|  | SA247 | 64 K words | F70000h-F7FFFFh |
|  | SA248 | 64 K words | F80000h-F8FFFFh |
|  | SA249 | 64 K words | F90000h-F9FFFFh |
|  | SA250 | 64 K words | FA0000h-FAFFFFh |
|  | SA251 | 64 K words | FB0000h-FBFFFFh |
|  | SA252 | 64 K words | FC0000h-FCFFFFh |
|  | SA253 | 64 K words | FD0000h-FDFFFFh |
|  | SA254 | 64 K words | FE0000h-FEFFFFh |
|  | SA255 | 64 K words | FF0000h-FFFFFFh |

Table 5.1 S29NS512P Sector \& Memory Address Map (Sheet 5 of 8)

| Bank | Sector | Sector Size | Address Range | Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \infty \\ & \stackrel{\sim}{L} \\ & \stackrel{\sim}{\bar{N}} \end{aligned}$ | SA256 | 64 Kwords | 1000000h-100FFFFh |  | SA288 | 64 Kwords | 1200000h-120FFFFh |
|  | SA257 | 64 Kwords | 1010000h-101FFFFh |  | SA289 | 64 Kwords | 1210000h-121FFFFh |
|  | SA258 | 64 Kwords | 1020000h-102FFFFh |  | SA290 | 64 Kwords | 1220000h-122FFFFh |
|  | SA259 | 64 Kwords | 1030000h-103FFFFh |  | SA291 | 64 Kwords | 1230000h-123FFFFh |
|  | SA260 | 64 Kwords | 1040000h-104FFFFh |  | SA292 | 64 Kwords | 1240000h-124FFFFh |
|  | SA261 | 64 Kwords | 1050000h-105FFFFh |  | SA293 | 64 Kwords | 1250000h-125FFFFh |
|  | SA262 | 64 Kwords | 1060000h-106FFFFh |  | SA294 | 64 Kwords | 1260000h-126FFFFh |
|  | SA263 | 64 Kwords | 1070000h-107FFFFh |  | SA295 | 64 Kwords | 1270000h-127FFFFh |
|  | SA264 | 64 Kwords | 1030000h-108FFFFh |  | SA296 | 64 Kwords | 1230000h-128FFFFh |
|  | SA265 | 64 Kwords | 1090000h-109FFFFh |  | SA297 | 64 Kwords | 1290000h-129FFFFh |
|  | SA266 | 64 Kwords | 10A0000h-10AFFFFh |  | SA298 | 64 Kwords | 12A0000h-12AFFFFh |
|  | SA267 | 64 Kwords | 10B0000h-10BFFFFh |  | SA299 | 64 Kwords | 12B0000h-12BFFFFh |
|  | SA268 | 64 Kwords | 10C0000h-10CFFFFh |  | SA300 | 64 Kwords | 12C0000h-12CFFFFh |
|  | SA269 | 64 Kwords | 10D0000h-10DFFFFh |  | SA301 | 64 Kwords | 12D0000h-12DFFFFh |
|  | SA270 | 64 Kwords | 10E0000h-10EFFFFh |  | SA302 | 64 Kwords | 12E0000h-12EFFFFh |
|  | SA271 | 64 Kwords | 10F0000h-10FFFFFh |  | SA303 | 64 Kwords | 12F0000h-12FFFFFh |
|  | SA272 | 64 Kwords | 1100000h-110FFFFh |  | SA304 | 64 Kwords | 1300000h-130FFFFh |
|  | SA273 | 64 Kwords | 1110000h-111FFFFh |  | SA305 | 64 Kwords | 1310000h-131FFFFh |
|  | SA274 | 64 Kwords | 1120000h-112FFFFh |  | SA306 | 64 Kwords | 1320000h-132FFFFh |
|  | SA275 | 64 Kwords | 1130000h-113FFFFh |  | SA307 | 64 Kwords | 1330000h-133FFFFh |
|  | SA276 | 64 Kwords | 1140000h-114FFFFh |  | SA308 | 64 Kwords | 1340000h-134FFFFh |
|  | SA277 | 64 Kwords | 1150000h-115FFFFh |  | SA309 | 64 Kwords | 1350000h-135FFFFh |
|  | SA278 | 64 Kwords | 1160000h-116FFFFh |  | SA310 | 64 Kwords | 1360000h-136FFFFh |
|  | SA279 | 64 Kwords | 1170000h-117FFFFh |  | SA311 | 64 Kwords | 1370000h-137FFFFh |
|  | SA280 | 64 Kwords | 1180000h-118FFFFh |  | SA312 | 64 Kwords | 1380000h-138FFFFh |
|  | SA281 | 64 Kwords | 1190000h-119FFFFh |  | SA313 | 64 Kwords | 1390000h-139FFFFh |
|  | SA282 | 64 Kwords | 11A0000h-11AFFFFh |  | SA314 | 64 Kwords | 13A0000h-13AFFFFh |
|  | SA283 | 64 Kwords | 11B0000h-11BFFFFh |  | SA315 | 64 Kwords | 13B0000h-13BFFFFh |
|  | SA284 | 64 Kwords | 11C0000h-11CFFFFh |  | SA316 | 64 Kwords | 13C0000h-13CFFFFh |
|  | SA285 | 64 Kwords | 11D0000h-11DFFFFh |  | SA317 | 64 Kwords | 13D0000h-13DFFFFh |
|  | SA286 | 64 Kwords | 11E0000h-11EFFFFh |  | SA318 | 64 Kwords | 13E0000h-13EFFFFh |
|  | SA287 | 64 Kwords | 11F0000h-11FFFFFh |  | SA319 | 64 Kwords | 13F0000h-13FFFFFh |

Table 5.1 S29NS512P Sector \& Memory Address Map (Sheet 6 of 8)

| Bank | Sector | Sector Size | Address Range | Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | SA320 | 64 Kwords | 1400000h-140FFFFh | $\begin{aligned} & \underset{\sim}{\Sigma} \\ & \stackrel{y}{\tilde{N}} \end{aligned}$ | SA352 | 64 K words | 1600000h-160FFFFh |
|  | SA321 | 64 Kwords | 1410000h-141FFFFh |  | SA353 | 64 K words | 1610000h-161FFFFh |
|  | SA322 | 64 Kwords | 1420000h-142FFFFh |  | SA354 | 64 K words | 1620000h-162FFFFh |
|  | SA323 | 64 Kwords | 1430000h-143FFFFh |  | SA355 | 64 K words | 1630000h-163FFFFh |
|  | SA324 | 64 Kwords | 1440000h-144FFFFh |  | SA356 | 64 K words | 1640000h-164FFFFh |
|  | SA325 | 64 Kwords | 1450000h-145FFFFh |  | SA357 | 64 K words | 1650000h-165FFFFh |
|  | SA326 | 64 Kwords | 1460000h-146FFFFh |  | SA358 | 64 K words | 1660000h-166FFFFh |
|  | SA327 | 64 Kwords | 1470000h-147FFFFh |  | SA359 | 64 K words | 1670000h-167FFFFh |
|  | SA328 | 64 Kwords | 1430000h-148FFFFh |  | SA360 | 64 K words | 1630000h-168FFFFh |
|  | SA329 | 64 Kwords | 1490000h-149FFFFh |  | SA361 | 64 K words | 1690000h-169FFFFh |
|  | SA330 | 64 Kwords | 14A0000h-14AFFFFh |  | SA362 | 64 K words | 16A0000h-16AFFFFFh |
|  | SA331 | 64 Kwords | 14B0000h-14BFFFFh |  | SA363 | 64 K words | 16B0000h-16BFFFFh |
|  | SA332 | 64 Kwords | 14C0000h-14CFFFFh |  | SA364 | 64 K words | 16C0000h-16CFFFFh |
|  | SA333 | 64 Kwords | 14D0000h-14DFFFFh |  | SA365 | 64 K words | 16D0000h-16DFFFFh |
|  | SA334 | 64 Kwords | 14E0000h-14EFFFFh |  | SA366 | 64 K words | 16E0000h-16EFFFFFh |
|  | SA335 | 64 Kwords | 14F0000h-14FFFFFh |  | SA367 | 64 K words | 16F0000h-16FFFFFh |
|  | SA336 | 64 Kwords | 1500000h-150FFFFh |  | SA368 | 64 K words | 1700000h-170FFFFh |
|  | SA337 | 64 Kwords | 1510000h-151FFFFh |  | SA369 | 64 K words | 1710000h-171FFFFh |
|  | SA338 | 64 Kwords | 1520000h-152FFFFh |  | SA370 | 64 K words | 1720000h-172FFFFh |
|  | SA339 | 64 Kwords | 1530000h-153FFFFh |  | SA371 | 64 K words | 1730000h-173FFFFh |
|  | SA340 | 64 Kwords | 1540000h-154FFFFh |  | SA372 | 64 K words | 1740000h-174FFFFh |
|  | SA341 | 64 Kwords | 1550000h-155FFFFh |  | SA373 | 64 K words | 1750000h-175FFFFh |
|  | SA342 | 64 Kwords | 1560000h-156FFFFh |  | SA374 | 64 K words | 1760000h-176FFFFh |
|  | SA343 | 64 Kwords | 1570000h-157FFFFh |  | SA375 | 64 K words | 1770000h-177FFFFh |
|  | SA344 | 64 Kwords | 1580000h-158FFFFh |  | SA376 | 64 K words | 1780000h-178FFFFh |
|  | SA345 | 64 Kwords | 1590000h-159FFFFh |  | SA377 | 64 K words | 1790000h-179FFFFh |
|  | SA346 | 64 Kwords | 15A0000h-15AFFFFh |  | SA378 | 64 K words | 17A0000h-17AFFFFFh |
|  | SA347 | 64 Kwords | 15B0000h-15BFFFFh |  | SA379 | 64 K words | 17B0000h-17BFFFFFh |
|  | SA348 | 64 Kwords | 15C0000h-15CFFFFh |  | SA380 | 64 K words | 15C0000h-17CFFFFh |
|  | SA349 | 64 Kwords | 15D0000h-15DFFFFh |  | SA381 | 64 K words | 17D0000h-17DFFFFh |
|  | SA350 | 64 Kwords | 15E0000h-15EFFFFh |  | SA382 | 64 K words | 17E0000h-17EFFFFF |
|  | SA351 | 64 Kwords | 15F0000h-15FFFFFh |  | SA383 | 64 K words | 17F0000h-17FFFFFh |

Table 5.1 S29NS512P Sector \& Memory Address Map (Sheet 7 of 8)

| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
|  | SA384 | 64 Kwords | 1800000h-180FFFFh |
|  | SA385 | 64 Kwords | 1810000h-181FFFFh |
|  | SA386 | 64 Kwords | 1820000h-182FFFFh |
|  | SA387 | 64 Kwords | 1830000h-183FFFFh |
|  | SA388 | 64 Kwords | 1840000h-184FFFFh |
|  | SA389 | 64 Kwords | 1850000h-185FFFFh |
|  | SA390 | 64 Kwords | 1860000h-186FFFFh |
|  | SA391 | 64 Kwords | 1870000h-187FFFFh |
|  | SA392 | 64 Kwords | 1830000h-188FFFFh |
|  | SA393 | 64 Kwords | 1890000h-189FFFFh |
|  | SA394 | 64 Kwords | 18A0000h-18AFFFFh |
|  | SA395 | 64 Kwords | 18B0000h-18BFFFFh |
|  | SA396 | 64 Kwords | 18C0000h-18CFFFFh |
|  | SA397 | 64 Kwords | 18D0000h-18DFFFFh |
|  | SA398 | 64 Kwords | 18E0000h-18EFFFFh |
|  | SA399 | 64 Kwords | 18F0000h-18FFFFFh |
|  | SA400 | 64 Kwords | 1900000h-190FFFFh |
|  | SA401 | 64 Kwords | 1910000h-191FFFFh |
|  | SA402 | 64 Kwords | 1920000h-192FFFFh |
|  | SA403 | 64 Kwords | 1930000h-193FFFFh |
|  | SA404 | 64 Kwords | 1940000h-194FFFFh |
|  | SA405 | 64 Kwords | 1950000h-195FFFFh |
|  | SA406 | 64 Kwords | 1960000h-196FFFFh |
|  | SA407 | 64 Kwords | 1970000h-197FFFFh |
|  | SA408 | 64 Kwords | 1980000h-198FFFFh |
|  | SA409 | 64 Kwords | 1990000h-199FFFFh |
|  | SA410 | 64 Kwords | 19A0000h-19AFFFFh |
|  | SA411 | 64 Kwords | 19B0000h-19BFFFFh |
|  | SA412 | 64 Kwords | 19C0000h-19CFFFFh |
|  | SA413 | 64 Kwords | 19D0000h-19DFFFFh |
|  | SA414 | 64 Kwords | 19E0000h-19EFFFFh |
|  | SA415 | 64 Kwords | 19F0000h-19FFFFFh |


| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
|  | SA416 | 64 Kwords | 1A00000h-1A0FFFFh |
|  | SA417 | 64 Kwords | 1A10000h-1A1FFFFh |
|  | SA418 | 64 Kwords | 1A20000h-1A2FFFFh |
|  | SA419 | 64 Kwords | 1A30000h-1A3FFFFh |
|  | SA420 | 64 Kwords | 1A40000h-1A4FFFFh |
|  | SA421 | 64 Kwords | 1A50000h-1A5FFFFh |
|  | SA422 | 64 Kwords | 1A60000h-1A6FFFFh |
|  | SA423 | 64 Kwords | 1A70000h-1A7FFFFh |
|  | SA424 | 64 Kwords | 1A30000h-1A8FFFFh |
|  | SA425 | 64 Kwords | 1A90000h-1A9FFFFh |
|  | SA426 | 64 Kwords | 1AA0000h-1AAFFFFh |
|  | SA427 | 64 Kwords | 1AB0000h-1ABFFFFF |
|  | SA428 | 64 Kwords | 1AC0000h-1ACFFFFh |
|  | SA429 | 64 Kwords | 1AD0000h-1ADFFFFh |
|  | SA430 | 64 Kwords | 1AE0000h-1AEFFFFFh |
|  | SA431 | 64 Kwords | 1AF0000h-1AFFFFFF |
|  | SA432 | 64 Kwords | 1B00000h-1B0FFFFh |
|  | SA433 | 64 Kwords | 1B10000h-1B1FFFFh |
|  | SA434 | 64 Kwords | 1B20000h-1B2FFFFh |
|  | SA435 | 64 Kwords | 1B30000h-1B3FFFFh |
|  | SA436 | 64 Kwords | 1B40000h-1B4FFFFh |
|  | SA437 | 64 Kwords | 1B50000h-1B5FFFFh |
|  | SA438 | 64 Kwords | 1B60000h-1B6FFFFh |
|  | SA439 | 64 Kwords | 1B70000h-1B7FFFFh |
|  | SA440 | 64 Kwords | 1B80000h-1B8FFFFh |
|  | SA441 | 64 Kwords | 1B90000h-1B9FFFFh |
|  | SA442 | 64 Kwords | 1BA0000h-1BAFFFFh |
|  | SA443 | 64 Kwords | 1BB0000h-1BBFFFFFh |
|  | SA444 | 64 Kwords | 1BC0000h-1BCFFFFh |
|  | SA445 | 64 Kwords | 1BD0000h-1BDFFFFh |
|  | SA446 | 64 Kwords | 1BE0000h-1BEFFFFF |
|  | SA447 | 64 Kwords | 1BF0000h-1BFFFFFh |

Table 5.1 S29NS512P Sector \& Memory Address Map (Sheet 8 of 8)

| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
|  | SA448 | 64 Kwords | 1C00000h-1C0FFFFh |
|  | SA449 | 64 Kwords | 1C10000h-1C1FFFFh |
|  | SA450 | 64 Kwords | 1C20000h-1C2FFFFh |
|  | SA451 | 64 Kwords | 1C30000h-1C3FFFFh |
|  | SA452 | 64 Kwords | 1C40000h-1C4FFFFh |
|  | SA453 | 64 Kwords | 1C50000h-1C5FFFFh |
|  | SA454 | 64 Kwords | 1C60000h-1C6FFFFh |
|  | SA455 | 64 Kwords | 1C70000h-1C7FFFFh |
|  | SA456 | 64 Kwords | 1C30000h-1C8FFFFh |
|  | SA457 | 64 Kwords | 1C90000h-1C9FFFFh |
|  | SA458 | 64 Kwords | 1CA0000h-1CAFFFFh |
|  | SA459 | 64 Kwords | 1CB0000h-1CBFFFFh |
|  | SA460 | 64 Kwords | 1CC0000h-1CCFFFFh |
|  | SA461 | 64 Kwords | 1CD0000h-1CDFFFFh |
|  | SA462 | 64 Kwords | 1CE0000h-1CEFFFFh |
|  | SA463 | 64 Kwords | 1CF0000h-1CFFFFFh |
|  | SA464 | 64 Kwords | 1D00000h-1D0FFFFh |
|  | SA465 | 64 Kwords | 1D10000h-1D1FFFFh |
|  | SA466 | 64 Kwords | 1D20000h-1D2FFFFh |
|  | SA467 | 64 Kwords | 1D30000h-1D3FFFFh |
|  | SA468 | 64 Kwords | 1D40000h-1D4FFFFh |
|  | SA469 | 64 Kwords | 1D50000h-1D5FFFFh |
|  | SA470 | 64 Kwords | 1D60000h-1D6FFFFh |
|  | SA471 | 64 Kwords | 1D70000h-1D7FFFFh |
|  | SA472 | 64 Kwords | 1D80000h-1D8FFFFh |
|  | SA473 | 64 Kwords | 1D90000h-1D9FFFFh |
|  | SA474 | 64 Kwords | 1DA0000h-1DAFFFFh |
|  | SA475 | 64 Kwords | 1DB0000h-1DBFFFFh |
|  | SA476 | 64 Kwords | 1DC0000h-1DCFFFFh |
|  | SA477 | 64 Kwords | 1DD0000h-1DDFFFFh |
|  | SA478 | 64 Kwords | 1DE0000h-1DEFFFFh |
|  | SA479 | 64 Kwords | 1DF0000h-1DFFFFFh |


| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
|  | SA480 | 64 K words | 1E00000h-1E0FFFFh |
|  | SA481 | 64 K words | 1E10000h-1E1FFFFh |
|  | SA482 | 64 K words | 1E20000h-1E2FFFFh |
|  | SA483 | 64 K words | 1E30000h-1E3FFFFh |
|  | SA484 | 64 K words | 1E40000h-1E4FFFFh |
|  | SA485 | 64 K words | 1E50000h-1E5FFFFh |
|  | SA486 | 64 K words | 1E60000h-1E6FFFFh |
|  | SA487 | 64 K words | 1E70000h-1E7FFFFh |
|  | SA488 | 64 K words | 1E30000h-1E8FFFFh |
|  | SA489 | 64 K words | 1E90000h-1E9FFFFh |
|  | SA490 | 64 K words | 1EA0000h-1EAFFFFh |
|  | SA491 | 64 K words | 1EB0000h-1EBFFFFh |
|  | SA492 | 64 K words | 1EC0000h-1ECFFFFh |
|  | SA493 | 64 K words | 1ED0000h-1EDFFFFh |
|  | SA494 | 64 K words | 1EE0000h-1EEFFFFh |
|  | SA495 | 64 K words | 1EF0000h-1EFFFFFFh |
|  | SA496 | 64 K words | 1F00000h-1F0FFFFh |
|  | SA497 | 64 K words | 1F10000h-1F1FFFFh |
|  | SA498 | 64 K words | 1F20000h-1F2FFFFh |
|  | SA499 | 64 K words | 1F30000h-1F3FFFFh |
|  | SA500 | 64 K words | 1F40000h-1F4FFFFh |
|  | SA501 | 64 K words | 1F50000h-1F5FFFFh |
|  | SA502 | 64 K words | 1F60000h-1F6FFFFh |
|  | SA503 | 64 K words | 1F70000h-1F7FFFFh |
|  | SA504 | 64 K words | 1F80000h-1F8FFFFh |
|  | SA505 | 64 K words | 1F90000h-1F9FFFFh |
|  | SA506 | 64 K words | 1FA0000h-1FAFFFFh |
|  | SA507 | 64 K words | 1FB0000h-1FBFFFFh |
|  | SA508 | 64 K words | 1FC0000h-1FCFFFFh |
|  | SA509 | 64 K words | 1FD0000h-1FDFFFFh |
|  | SA510 | 64 K words | 1FE0000h-1FEFFFFh |
|  | SA511 | 64 K words | 1FF0000h-1FFFFFFF |

Table 5.2 S29NS256P Sector \& Memory Address Map (Sheet 1 of 3)

| Bank | Sector | Sector Size | Address Range | Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | SAO | 64 Kwords | 000000h-00FFFFFh | $\begin{aligned} & \text { N } \\ & \stackrel{y}{ً} \\ & \underset{\sim}{\bar{N}} \end{aligned}$ | SA32 | 64 Kwords | 200000h-20FFFFh |
|  | SA1 | 64 Kwords | 010000h-01FFFFh |  | SA33 | 64 Kwords | 210000h-21FFFFh |
|  | SA2 | 64 Kwords | 020000h-02FFFFFh |  | SA34 | 64 Kwords | 220000h-22FFFFh |
|  | SA3 | 64 Kwords | 030000h-03FFFFFh |  | SA35 | 64 Kwords | 230000h-23FFFFh |
|  | SA4 | 64 Kwords | 040000h-04FFFFh |  | SA36 | 64 Kwords | 240000h-24FFFFh |
|  | SA5 | 64 Kwords | 050000h-05FFFFFh |  | SA37 | 64 Kwords | 250000h-25FFFFh |
|  | SA6 | 64 Kwords | 060000h-06FFFFFh |  | SA38 | 64 Kwords | 260000h-26FFFFh |
|  | SA7 | 64 Kwords | 070000h-07FFFFFh |  | SA39 | 64 Kwords | 270000h-27FFFFh |
|  | SA8 | 64 Kwords | 080000h-08FFFFh |  | SA40 | 64 Kwords | 280000h-28FFFFh |
|  | SA9 | 64 Kwords | 090000h-09FFFFh |  | SA41 | 64 Kwords | 290000h-29FFFFh |
|  | SA10 | 64 Kwords | OA0000h-0AFFFFh |  | SA42 | 64 Kwords | 2A0000h-2AFFFFh |
|  | SA11 | 64 Kwords | OB0000h-0BFFFFh |  | SA43 | 64 Kwords | 2B0000h-2BFFFFh |
|  | SA12 | 64 Kwords | 0C0000h-0CFFFFh |  | SA44 | 64 Kwords | 2C0000h-2CFFFFh |
|  | SA13 | 64 Kwords | 0D0000h-0DFFFFh |  | SA45 | 64 Kwords | 2D0000h-2DFFFFh |
|  | SA14 | 64 Kwords | 0E0000h-0EFFFFh |  | SA46 | 64 Kwords | 2E0000h-2EFFFFh |
|  | SA15 | 64 Kwords | OF0000h-0FFFFFh |  | SA47 | 64 Kwords | 2F0000h-2FFFFFh |
| $\Gamma$$\underset{\sim}{\bar{W}}$© | SA16 | 64 Kwords | 100000h-10FFFFh |  | SA48 | 64 Kwords | 300000h-30FFFFh |
|  | SA17 | 64 Kwords | 110000h-11FFFFh |  | SA49 | 64 Kwords | 310000h-31FFFFh |
|  | SA18 | 64 Kwords | 120000h-12FFFFh |  | SA50 | 64 Kwords | 320000h-32FFFFh |
|  | SA19 | 64 Kwords | 130000h-13FFFFh |  | SA51 | 64 Kwords | 330000h-33FFFFh |
|  | SA20 | 64 Kwords | 140000h-14FFFFh |  | SA52 | 64 Kwords | 340000h-34FFFFh |
|  | SA21 | 64 Kwords | 150000h-15FFFFh |  | SA53 | 64 Kwords | 350000h-35FFFFh |
|  | SA22 | 64 Kwords | 160000h-16FFFFFh |  | SA54 | 64 Kwords | 360000h-36FFFFh |
|  | SA23 | 64 Kwords | 170000h-17FFFFF |  | SA55 | 64 Kwords | 370000h-37FFFFh |
|  | SA24 | 64 Kwords | 180000h-18FFFFFh |  | SA56 | 64 Kwords | 380000h-38FFFFh |
|  | SA25 | 64 Kwords | 190000h-19FFFFh |  | SA57 | 64 Kwords | 390000h-39FFFFh |
|  | SA26 | 64 Kwords | 1A0000h-1AFFFFh |  | SA58 | 64 Kwords | 3A0000h-3AFFFFFh |
|  | SA27 | 64 Kwords | 1B0000 -1 BFFFFh |  | SA59 | 64 Kwords | 3B0000h-3BFFFFF |
|  | SA28 | 64 Kwords | 1C0000h-1CFFFFh |  | SA60 | 64 Kwords | 3C0000h-3CFFFFF |
|  | SA29 | 64 Kwords | 1D0000h-1DFFFFh |  | SA61 | 64 Kwords | 3D0000h-3DFFFFh |
|  | SA30 | 64 Kwords | 1E0000h-1EFFFFh |  | SA62 | 64 Kwords | 3E0000h-3EFFFFFh |
|  | SA31 | 64 Kwords | 1F0000h-1FFFFFh |  | SA63 | 64 Kwords | 3F0000h-3FFFFFh |
| $\begin{aligned} & \underset{\sim}{\Sigma} \\ & \stackrel{\rightharpoonup}{\bar{N}} \end{aligned}$ | SA64 | 64 Kwords | 400000h-40FFFFFh |  | SA96 | 64 K words | 600000h-60FFFFh |
|  | SA65 | 64 Kwords | 410000h-41FFFFF |  | SA97 | 64 K words | 610000h-61FFFFh |
|  | SA66 | 64 Kwords | 420000h-42FFFFh |  | SA98 | 64 K words | 620000h-62FFFFh |
|  | SA67 | 64 Kwords | 430000h-43FFFFFh |  | SA99 | 64 K words | 630000h-63FFFFh |
|  | SA68 | 64 Kwords | 440000h-44FFFFh |  | SA100 | 64 K words | 640000h-64FFFFh |
|  | SA69 | 64 Kwords | 450000h-45FFFFFh |  | SA101 | 64 K words | 650000h-65FFFFh |
|  | SA70 | 64 Kwords | 460000h-46FFFFFh |  | SA102 | 64 K words | 660000h-66FFFFh |
|  | SA71 | 64 Kwords | 470000h-47FFFFh |  | SA103 | 64 K words | 670000h-67FFFFh |
|  | SA72 | 64 Kwords | 480000h-48FFFFFh |  | SA104 | 64 K words | 680000h-68FFFFh |
|  | SA73 | 64 Kwords | 490000h-49FFFFh |  | SA105 | 64 K words | 690000h-69FFFFh |
|  | SA74 | 64 Kwords | 4A0000h-4AFFFFh |  | SA106 | 64 K words | 6A0000h-6AFFFFh |
|  | SA75 | 64 Kwords | 4B0000h-4BFFFFh |  | SA107 | 64 K words | 6B0000h-6BFFFFFh |
|  | SA76 | 64 Kwords | 4C0000h-4CFFFFh |  | SA108 | 64 K words | 6C0000h-6CFFFFh |
|  | SA77 | 64 Kwords | 4D0000h-4DFFFFh |  | SA109 | 64 K words | 6D0000h-6DFFFFFh |
|  | SA78 | 64 Kwords | 4E0000h-4EFFFFh |  | SA110 | 64 K words | 6E0000h-6EFFFFFh |
|  | SA79 | 64 Kwords | 4F0000h-4FFFFFh |  | SA111 | 64 K words | 6F0000h-6FFFFFh |

Table 5.2 S29NS256P Sector \& Memory Address Map (Sheet 2 of 3)

| Bank | Sector | Sector Size | Address Range | Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | SA80 | 64 Kwords | 500000h-50FFFFh |  | SA112 | 64 K words | 700000h-70FFFFh |
|  | SA81 | 64 Kwords | 510000h-51FFFFh |  | SA113 | 64 K words | 710000h-71FFFFh |
|  | SA82 | 64 Kwords | 520000h-52FFFFFh |  | SA114 | 64 K words | 720000h-72FFFFh |
|  | SA83 | 64 Kwords | 530000h-53FFFFFh |  | SA115 | 64 K words | 730000h-73FFFFh |
|  | SA84 | 64 Kwords | 540000h-54FFFFFh |  | SA116 | 64 K words | 740000h-74FFFFh |
|  | SA85 | 64 Kwords | 550000h-55FFFFFh |  | SA117 | 64 K words | 750000h-75FFFFh |
|  | SA86 | 64 Kwords | 560000h-56FFFFFh |  | SA118 | 64 K words | 760000h-76FFFFh |
|  | SA87 | 64 Kwords | 570000h-57FFFFh |  | SA119 | 64 K words | 770000h-77FFFFh |
|  | SA88 | 64 Kwords | 580000h-58FFFFFh |  | SA120 | 64 K words | 780000h-78FFFFh |
|  | SA89 | 64 Kwords | 590000h-59FFFFFh |  | SA121 | 64 K words | 790000h-79FFFFh |
|  | SA90 | 64 Kwords | 5A0000h-5AFFFFh |  | SA122 | 64 K words | 7A0000h-7AFFFFh |
|  | SA91 | 64 Kwords | 5B0000h-5BFFFFh |  | SA123 | 64 K words | 7B0000h-7BFFFFh |
|  | SA92 | 64 Kwords | 5C0000h-5CFFFFh |  | SA124 | 64 K words | 7C0000h-7CFFFFh |
|  | SA93 | 64 Kwords | 5D0000h-5DFFFFh |  | SA125 | 64 K words | 7D0000h-7DFFFFh |
|  | SA94 | 64 Kwords | 5E0000h-5EFFFFh |  | SA126 | 64 K words | 7E0000h-7EFFFFh |
|  | SA95 | 64 Kwords | 5F0000h-5FFFFFh |  | SA127 | 64 K words | 7F0000h-7FFFFFh |
|  | SA128 | 64 Kwords | 800000h-80FFFFFh | 은드N© | SA160 | 64 Kwords | A00000h-A0FFFFh |
|  | SA129 | 64 Kwords | 810000h-81FFFFh |  | SA161 | 64 Kwords | A10000h-A1FFFFh |
|  | SA130 | 64 Kwords | 820000h-82FFFFh |  | SA162 | 64 Kwords | A20000h-A2FFFFh |
|  | SA131 | 64 Kwords | 830000h-83FFFFFh |  | SA163 | 64 Kwords | A30000h-A3FFFFh |
|  | SA132 | 64 Kwords | 840000h-84FFFFFh |  | SA164 | 64 Kwords | A40000h-A4FFFFh |
|  | SA133 | 64 Kwords | 850000h-85FFFFh |  | SA165 | 64 Kwords | A50000h-A5FFFFh |
|  | SA134 | 64 Kwords | 860000h-86FFFFh |  | SA166 | 64 Kwords | A60000h-A6FFFFh |
|  | SA135 | 64 Kwords | 870000h-87FFFFFh |  | SA167 | 64 Kwords | A70000h-A7FFFFh |
|  | SA136 | 64 Kwords | 880000h-88FFFFh |  | SA168 | 64 Kwords | A80000h-A8FFFFh |
|  | SA137 | 64 Kwords | 890000h-89FFFFFh |  | SA169 | 64 Kwords | A90000h-A9FFFFh |
|  | SA138 | 64 Kwords | 8A0000h-8AFFFFh |  | SA170 | 64 Kwords | AA0000h-AAFFFFh |
|  | SA139 | 64 Kwords | 8B0000h-8BFFFFh |  | SA171 | 64 Kwords | AB0000h-ABFFFFFh |
|  | SA140 | 64 Kwords | 8C0000h-8CFFFFh |  | SA172 | 64 Kwords | AC0000h-ACFFFFh |
|  | SA141 | 64 Kwords | 8D0000h-8DFFFFh |  | SA173 | 64 Kwords | AD0000h-ADFFFFh |
|  | SA142 | 64 Kwords | 8E0000h-8EFFFFh |  | SA174 | 64 Kwords | AE0000h-AEFFFFFh |
|  | SA143 | 64 Kwords | 8F0000h-8FFFFFh |  | SA175 | 64 Kwords | AF0000h-AFFFFFh |
| の$\stackrel{\rightharpoonup}{ً}$® | SA144 | 64 Kwords | 900000h-90FFFFh |  | SA176 | 64 Kwords | B00000h-B0FFFFh |
|  | SA145 | 64 Kwords | 910000h-91FFFFh |  | SA177 | 64 Kwords | B10000h-B1FFFFh |
|  | SA146 | 64 Kwords | 920000h-92FFFFFh |  | SA178 | 64 Kwords | B20000h-B2FFFFh |
|  | SA147 | 64 Kwords | 930000h-93FFFFh |  | SA179 | 64 Kwords | B30000h-B3FFFFh |
|  | SA148 | 64 Kwords | 940000h-94FFFFh |  | SA180 | 64 Kwords | B40000h-B4FFFFh |
|  | SA149 | 64 Kwords | 950000h-95FFFFh |  | SA181 | 64 Kwords | B50000h-B5FFFFh |
|  | SA150 | 64 Kwords | 960000h-96FFFFh |  | SA182 | 64 Kwords | B60000h-B6FFFFh |
|  | SA151 | 64 Kwords | 970000h-97FFFFh |  | SA183 | 64 Kwords | B70000h-B7FFFFh |
|  | SA152 | 64 Kwords | 980000h-98FFFFFh |  | SA184 | 64 Kwords | B80000h-B8FFFFh |
|  | SA153 | 64 Kwords | 990000h-99FFFFFh |  | SA185 | 64 Kwords | B90000h-B9FFFFh |
|  | SA154 | 64 Kwords | 9A0000h-9AFFFFh |  | SA186 | 64 Kwords | BA0000h-BAFFFFh |
|  | SA155 | 64 Kwords | 9B0000h-9BFFFFh |  | SA187 | 64 Kwords | BB0000h-BBFFFFh |
|  | SA156 | 64 Kwords | 9C0000h-9CFFFFh |  | SA188 | 64 Kwords | BC0000h-BCFFFFh |
|  | SA157 | 64 Kwords | 9D0000h-9DFFFFh |  | SA189 | 64 Kwords | BD0000h-BDFFFFh |
|  | SA158 | 64 Kwords | 9E0000h-9EFFFFh |  | SA190 | 64 Kwords | BE0000h-BEFFFFh |
|  | SA159 | 64 Kwords | 9F0000h-9FFFFFh |  | SA191 | 64 Kwords | BF0000h-BFFFFFh |

Table 5.2 S29NS256P Sector \& Memory Address Map (Sheet 3 of 3)

| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
| $N$Nn© | SA192 | 64 Kwords | C00000h-C0FFFFh |
|  | SA193 | 64 Kwords | C10000h-C1FFFFh |
|  | SA194 | 64 Kwords | C20000h-C2FFFFh |
|  | SA195 | 64 Kwords | C30000h-C3FFFFh |
|  | SA196 | 64 Kwords | C40000h-C4FFFFh |
|  | SA197 | 64 Kwords | C50000h-C5FFFFh |
|  | SA198 | 64 Kwords | C60000h-C6FFFFh |
|  | SA199 | 64 Kwords | C70000h-C7FFFFh |
|  | SA200 | 64 Kwords | C80000h-C8FFFFh |
|  | SA201 | 64 Kwords | C90000h-C9FFFFh |
|  | SA202 | 64 Kwords | CA0000h-CAFFFFh |
|  | SA203 | 64 Kwords | CB0000h-CBFFFFh |
|  | SA204 | 64 Kwords | CC0000h-CCFFFFh |
|  | SA205 | 64 Kwords | CD0000h-CDFFFFh |
|  | SA206 | 64 Kwords | CE0000h-CEFFFFh |
|  | SA207 | 64 Kwords | CF0000h-CFFFFFh |
| $\begin{aligned} & \underset{\sim}{\underset{N}{n}} \\ & \underset{\sim}{\Sigma} \end{aligned}$ | SA208 | 64 Kwords | D00000h-D0FFFFh |
|  | SA209 | 64 Kwords | D10000h-D1FFFFh |
|  | SA210 | 64 Kwords | D20000h-D2FFFFh |
|  | SA211 | 64 Kwords | D30000h-D3FFFFh |
|  | SA212 | 64 Kwords | D40000h-D4FFFFh |
|  | SA213 | 64 Kwords | D50000h-D5FFFFh |
|  | SA214 | 64 Kwords | D60000h-D6FFFFh |
|  | SA215 | 64 Kwords | D70000h-D7FFFFh |
|  | SA216 | 64 Kwords | D80000h-D8FFFFh |
|  | SA217 | 64 Kwords | D90000h-D9FFFFh |
|  | SA218 | 64 Kwords | DA0000h-DAFFFFh |
|  | SA219 | 64 Kwords | DB0000h-DBFFFFh |
|  | SA220 | 64 Kwords | DC0000h-DCFFFFh |
|  | SA221 | 64 Kwords | DD0000h-DDFFFFh |
|  | SA222 | 64 Kwords | DE0000h-DEFFFFh |
|  | SA223 | 64 Kwords | DF0000h-DFFFFFh |


| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
| $\begin{aligned} & \underset{\sim}{\underset{N}{n}} \\ & \underset{\sim}{\Sigma} \end{aligned}$ | SA224 | 64 K words | E00000h-E0FFFFh |
|  | SA225 | 64 K words | E10000h-E1FFFFh |
|  | SA226 | 64 K words | E20000h-E2FFFFh |
|  | SA227 | 64 K words | E30000h-E3FFFFh |
|  | SA228 | 64 K words | E40000h-E4FFFFh |
|  | SA229 | 64 K words | E50000h-E5FFFFh |
|  | SA230 | 64 K words | E60000h-E6FFFFh |
|  | SA231 | 64 K words | E70000h-E7FFFFh |
|  | SA232 | 64 K words | E80000h-E8FFFFh |
|  | SA233 | 64 K words | E90000h-E9FFFFh |
|  | SA234 | 64 K words | EA0000h-EAFFFFh |
|  | SA235 | 64 K words | EB0000h-EBFFFFh |
|  | SA236 | 64 K words | EC0000h-ECFFFFh |
|  | SA237 | 64 K words | ED0000h-EDFFFFh |
|  | SA238 | 64 K words | EE0000h-EEFFFFh |
|  | SA239 | 64 K words | EF0000h-EFFFFFh |
| $\begin{aligned} & \text { م } \\ & \text { x } \\ & \underset{\sim}{\bar{N}} \end{aligned}$ | SA240 | 64 K words | F00000h-F0FFFFh |
|  | SA241 | 64 K words | F10000h-F1FFFFh |
|  | SA242 | 64 K words | F20000h-F2FFFFh |
|  | SA243 | 64 K words | F30000h-F3FFFFh |
|  | SA244 | 64 K words | F40000h-F4FFFFh |
|  | SA245 | 64 K words | F50000h-F5FFFFh |
|  | SA246 | 64 K words | F60000h-F6FFFFh |
|  | SA247 | 64 K words | F70000h-F7FFFFh |
|  | SA248 | 64 K words | F80000h-F8FFFFh |
|  | SA249 | 64 K words | F90000h-F9FFFFh |
|  | SA250 | 64 K words | FA0000h-FAFFFFh |
|  | SA251 | 64 K words | FB0000h-FBFFFFh |
|  | SA252 | 64 K words | FC0000h-FCFFFFh |
|  | SA253 | 64 K words | FD0000h-FDFFFFh |
|  | SA254 | 64 K words | FE0000h-FEFFFFh |
|  | SA255 | 16 K words | FF0000h-FF3FFFh |
|  | SA256 | 16 K words | FF4000h-FF7FFFh |
|  | SA257 | 16 K words | FF8000h-FFBFFFh |
|  | SA258 | 16 K words | FFC000h-FFFFFFh |

Data Sheet (Advance Information)

Table 5.3 S29NS128P Sector \& Memory Address Map (Sheet 1 of 2)

| Bank | Sector | Sector Size | Address Range | Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | SAO | 64 Kwords | 000000h-00FFFFh | $\begin{aligned} & \underset{\sim}{\Sigma} \\ & \stackrel{\rightharpoonup}{\bar{N}} \\ & \underset{\sim}{n} \end{aligned}$ | SA32 | 64 Kwords | 200000h-20FFFFh |
|  | SA1 | 64 Kwords | 010000h-01FFFFh |  | SA33 | 64 Kwords | 210000h-21FFFFh |
|  | SA2 | 64 Kwords | 020000h-02FFFFh |  | SA34 | 64 Kwords | 220000h-22FFFFh |
|  | SA3 | 64 Kwords | 030000h-03FFFFh |  | SA35 | 64 Kwords | 230000h-23FFFFh |
|  | SA4 | 64 Kwords | 040000h-04FFFFh |  | SA36 | 64 Kwords | 240000h-24FFFFh |
|  | SA5 | 64 Kwords | 050000h-05FFFFh |  | SA37 | 64 Kwords | 250000h-25FFFFh |
|  | SA6 | 64 Kwords | 060000h-06FFFFh |  | SA38 | 64 Kwords | 260000h-26FFFFh |
|  | SA7 | 64 Kwords | 070000h-07FFFFh |  | SA39 | 64 Kwords | 270000h-27FFFFh |
| $\begin{aligned} & \overline{\mathrm{r}} \\ & \stackrel{\rightharpoonup}{\bar{\omega}} \\ & \underset{\oplus}{n} \end{aligned}$ | SA8 | 64 Kwords | 080000h-08FFFFh |  | SA40 | 64 Kwords | 280000h-28FFFFh |
|  | SA9 | 64 Kwords | 090000h-09FFFFh |  | SA41 | 64 Kwords | 290000h-29FFFFh |
|  | SA10 | 64 Kwords | 0A0000h-0AFFFFh |  | SA42 | 64 Kwords | 2A0000h-2AFFFFFh |
|  | SA11 | 64 Kwords | 0B0000h-0BFFFFh |  | SA43 | 64 Kwords | 2B0000h-2BFFFFFh |
|  | SA12 | 64 Kwords | 0C0000h-0CFFFFh |  | SA44 | 64 Kwords | 2C0000h-2CFFFFh |
|  | SA13 | 64 Kwords | 0D0000h-0DFFFFh |  | SA45 | 64 Kwords | 2D0000h-2DFFFFh |
|  | SA14 | 64 Kwords | OE0000h-0EFFFFh |  | SA46 | 64 Kwords | 2E0000h-2EFFFFh |
|  | SA15 | 64 Kwords | OF0000h-0FFFFFh |  | SA47 | 64 Kwords | 2F0000h-2FFFFFh |
|  | SA16 | 64 Kwords | 100000h-10FFFFh |  | SA48 | 64 Kwords | 300000h-30FFFFh |
|  | SA17 | 64 Kwords | 110000h-11FFFFh |  | SA49 | 64 Kwords | 310000h-31FFFFh |
|  | SA18 | 64 Kwords | 120000h-12FFFFh |  | SA50 | 64 Kwords | 320000h-32FFFFh |
|  | SA19 | 64 Kwords | 130000h-13FFFFh |  | SA51 | 64 Kwords | 330000h-33FFFFh |
|  | SA20 | 64 Kwords | 140000h-14FFFFh |  | SA52 | 64 Kwords | 340000h-34FFFFh |
|  | SA21 | 64 Kwords | 150000h-15FFFFh |  | SA53 | 64 Kwords | 350000h-35FFFFh |
|  | SA22 | 64 Kwords | 160000h-16FFFFh |  | SA54 | 64 Kwords | 360000h-36FFFFh |
|  | SA23 | 64 Kwords | 170000h-17FFFFh |  | SA55 | 64 Kwords | 370000h-37FFFFh |
| $\begin{aligned} & \text { n } \\ & \stackrel{\rightharpoonup}{\bar{N}} \\ & \text { ले } \end{aligned}$ | SA24 | 64 Kwords | 180000h-18FFFFh | $\begin{aligned} & \text { N } \\ & \text { 颜 } \end{aligned}$ | SA56 | 64 Kwords | 380000h-38FFFFh |
|  | SA25 | 64 Kwords | 190000h-19FFFFh |  | SA57 | 64 Kwords | 390000h-39FFFFh |
|  | SA26 | 64 Kwords | 1A0000h-1AFFFFh |  | SA58 | 64 Kwords | 3A0000h-3AFFFFFh |
|  | SA27 | 64 Kwords | 1B0000h-1BFFFFh |  | SA59 | 64 Kwords | 3B0000h-3BFFFFFh |
|  | SA28 | 64 Kwords | 1C0000h-1CFFFFh |  | SA60 | 64 Kwords | 3C0000h-3CFFFFh |
|  | SA29 | 64 Kwords | 1D0000h-1DFFFFh |  | SA61 | 64 Kwords | 3D0000h-3DFFFFh |
|  | SA30 | 64 Kwords | 1E0000h-1EFFFFh |  | SA62 | 64 Kwords | 3E0000h-3EFFFFFh |
|  | SA31 | 64 Kwords | 1F0000h-1FFFFFh |  | SA63 | 64 Kwords | 3F0000h-3FFFFFh |
| $\begin{aligned} & \infty \\ & \stackrel{\rightharpoonup}{\bar{K}} \\ & \stackrel{\sim}{\Gamma} \end{aligned}$ | SA64 | 64 Kwords | 400000h-40FFFFh |  | SA96 | 64 K words | 600000h-60FFFFh |
|  | SA65 | 64 Kwords | 410000h-41FFFFh |  | SA97 | 64 K words | 610000h-61FFFFh |
|  | SA66 | 64 Kwords | 420000h-42FFFFh |  | SA98 | 64 K words | 620000h-62FFFFh |
|  | SA67 | 64 Kwords | 430000h-43FFFFh |  | SA99 | 64 K words | 630000h-63FFFFh |
|  | SA68 | 64 Kwords | 440000h-44FFFFh |  | SA100 | 64 K words | 640000h-64FFFFh |
|  | SA69 | 64 Kwords | 450000h-45FFFFh |  | SA101 | 64 K words | 650000h-65FFFFh |
|  | SA70 | 64 Kwords | 460000h-46FFFFh |  | SA102 | 64 K words | 660000h-66FFFFh |
|  | SA71 | 64 Kwords | 470000h-47FFFFh |  | SA103 | 64 K words | 670000h-67FFFFh |
|  | SA72 | 64 Kwords | 480000h-48FFFFh |  | SA104 | 64 K words | 680000h-68FFFFh |
|  | SA73 | 64 Kwords | 490000h-49FFFFh |  | SA105 | 64 K words | 690000h-69FFFFh |
|  | SA74 | 64 Kwords | 4A0000h-4AFFFFh |  | SA106 | 64 K words | 6A0000h-6AFFFFFh |
|  | SA75 | 64 Kwords | 4B0000h-4BFFFFh |  | SA107 | 64 K words | 6B0000h-6BFFFFFh |
|  | SA76 | 64 Kwords | 4C0000h-4CFFFFh |  | SA108 | 64 K words | 6C0000h-6CFFFFh |
|  | SA77 | 64 Kwords | 4D0000h-4DFFFFh |  | SA109 | 64 K words | 6D0000h-6DFFFFh |
|  | SA78 | 64 Kwords | 4E0000h-4EFFFFh |  | SA110 | 64 K words | 6E0000h-6EFFFFFh |
|  | SA79 | 64 Kwords | 4F0000h-4FFFFFh |  | SA111 | 64 K words | 6F0000h-6FFFFFh |

Table 5.3 S29NS128P Sector \& Memory Address Map (Sheet 2 of 2)

| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
| $\begin{aligned} & \text { 오 } \\ & \text { 듣 } \\ & \text { लि } \end{aligned}$ | SA80 | 64 Kwords | 500000h-50FFFFh |
|  | SA81 | 64 Kwords | 510000h-51FFFFh |
|  | SA82 | 64 Kwords | 520000h-52FFFFh |
|  | SA83 | 64 Kwords | 530000h-53FFFFh |
|  | SA84 | 64 Kwords | 540000h-54FFFFh |
|  | SA85 | 64 Kwords | 550000h-55FFFFh |
|  | SA86 | 64 Kwords | 560000h-56FFFFh |
|  | SA87 | 64 Kwords | 570000h-57FFFFh |
| $\begin{aligned} & \underset{\sim}{\underset{N}{N}} \\ & \underset{\sim}{\bar{N}} \end{aligned}$ | SA88 | 64 Kwords | 580000h-58FFFFh |
|  | SA89 | 64 Kwords | 590000h-59FFFFh |
|  | SA90 | 64 Kwords | 5A0000h-5AFFFFh |
|  | SA91 | 64 Kwords | 5B0000h-5BFFFFh |
|  | SA92 | 64 Kwords | 5C0000h-5CFFFFh |
|  | SA93 | 64 Kwords | 5D0000h-5DFFFFh |
|  | SA94 | 64 Kwords | 5E0000h-5EFFFFh |
|  | SA95 | 64 Kwords | 5F0000h-5FFFFFh |


| Bank | Sector | Sector Size | Address Range |
| :---: | :---: | :---: | :---: |
|  | SA112 | 64 K words | 700000h-70FFFFh |
|  | SA113 | 64 K words | 710000h-71FFFFh |
|  | SA114 | 64 K words | 720000h-72FFFFh |
|  | SA115 | 64 K words | 730000h-73FFFFh |
|  | SA116 | 64 K words | 740000h-74FFFFh |
|  | SA117 | 64 K words | 750000h-75FFFFh |
|  | SA118 | 64 K words | 760000h-76FFFFh |
|  | SA119 | 64 K words | 770000h-77FFFFh |
|  | SA120 | 64 K words | 780000h-78FFFFh |
|  | SA121 | 64 K words | 790000h-79FFFFh |
|  | SA122 | 64 K words | 7A0000h-7AFFFFh |
|  | SA123 | 64 K words | 7B0000h-7BFFFFFh |
|  | SA124 | 64 K words | 7C0000h-7CFFFFh |
|  | SA125 | 64 K words | 7D0000h-7DFFFFh |
|  | SA126 | 64 K words | 7E0000h-7EFFFFh |
|  | SA127 | 16 K words | 7F0000h-7F3FFFh |
|  | SA128 | 16 K words | 7F4000h-7F7FFFh |
|  | SA129 | 16 K words | 7F8000h-7FBFFFh |
|  | SA130 | 16 K words | 7FC000h-7FFFFFh |

## 6. Device Operations

This section describes the read, program, erase, simultaneous read/write operations, handshaking, and reset features of the Flash devices.

Operations are initiated by writing specific commands or a sequence with specific address and data patterns into the command registers (see Tables 11.1 and 11.2). The command register itself does not occupy any addressable memory location; rather, it is composed of latches that store the commands, along with the address and data information needed to execute the command. The contents of the register serve as input to the internal state machine and the state machine outputs dictate the function of the device. Writing incorrect address and data values or writing them in an improper sequence may place the device in an unknown state, in which case the system must write the reset command to return the device to the reading array data mode.

### 6.1 Device Operation Table

The device must be setup appropriately for each operation. Table 6.1 describes the required state of each control pin for any particular operation.

Table 6.1 Device Operations

| Operation | CE\# | OE\# | WE\# | CLK | AVD\# | $\begin{gathered} \text { Amax } \\ \text { A16 } \end{gathered}$ | A/DQ15A/DQ0 | RDY | RESET\# |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Asynchronous Read Addresses Latched | L | L | H | X | 5 | Addr In | I/O | H | H |
| Asynchronous Write | L | H | 4 | X | 4 | Addr In | I/O | H | H |
| Standby (CE\#) | H | X | X | X | X | X | HIGH Z | HIGH Z | H |
| Hardware Reset | X | x | x | X | X | X | HIGH Z | HIGH Z | $\boxed{L}$ |
| Burst Read Operations |  |  |  |  |  |  |  |  |  |
| Latch Starting Burst Address by CLK | L | H | H | $\uparrow$ | L | Addr In | Addr In | X | H |
| Advance Burst read to next address | L | L | H | 5 | H | X | I/O | H | H |
| Terminate current Burst read cycle | H | X | H | X | X | X | HIGH Z | HIGH Z | H |
| Terminate current Burst read cycle via RESET\# | X | X | H | X | X | X | HIGH Z | HIGH Z | L |
| Terminate current Burst read cycle and start new Burst read cycle | L | X | H | $\underline{4}$ |  | Addr In | Addr In | X | H |

## Legend



## Notes

1. Address is latched on the rising edge of clock.
2. CLK must stay low or high after CE\# goes low when device in Asynchronous Read mode.

### 6.2 Asynchronous Read

All memories require access time to output array data. In an asynchronous read operation, data is read from one memory location at a time. Addresses are presented to the device in random order, and the propagation delay through the device causes the data on its outputs to arrive asynchronously with the address on its inputs.

To read data from the memory array, the system must first assert a valid address while driving AVD\# and $C E \#$ to $\mathrm{V}_{\mathrm{IL}}$. WE\# must remain at $\mathrm{V}_{\mathrm{IH}}$. The rising edge of AVD\# latches the address. The OE\# signal must be driven to $\mathrm{V}_{\mathrm{IL}}$, once AVD\# has been driven to $\mathrm{V}_{\mathrm{IH}}$.
The data is output on A/DQ15 - A/DQ0 pins after the access time ( $\mathrm{t}_{\mathrm{OE}}$ ) has elapsed from the falling edge of OE\#.

### 6.3 Synchronous (Burst) Read Operation

The device is capable of continuous sequential burst operation and linear burst operation of a preset length. When the device first powers up, it is enabled for Asynchronous read and can be automatically enabled for burst mode and the address is latched on the first rising edge of CLK input, while AVD\# is held low for one clock cycle.
Prior to activating the clock signal, the system should determine how many wait states are desired for the initial word ( $\mathrm{t}_{\mathrm{IACC}}$ ) of each burst access, what mode of burst operation is desired and how the RDY signal transitions with valid data. The system would then write the configuration register command sequence.

At startup the system writes the Set Configuration Register command sequence to optimize the system performance.
The data is output $t_{I A C C}$ after the rising edge of the first CLK. Subsequent words are output $t_{B A C C}$ after the rising edge of each successive clock cycle, which automatically increments the internal address counter. Note that data is output only at the rising edge of the clock. RDY indicates the initial latency.

Note that the device has a fixed internal address boundary that occurs every 128 words. No boundary crossing latency is required when the device operates with wait states set from 2 to 9 .

### 6.3.1 Latency Tables for Variable Wait State

Tables $6.2-6.9$ show the latency for variable wait state in a normal Burst operation.
Table 6.2 Address Latency for 9 Wait States

| Word | Initial Wait |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 9 ws | D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 |
| 1 |  | D1 | D2 | D3 | D4 | D5 | D6 | D7 | 1 ws | D8 |
| 2 |  | D2 | D3 | D4 | D5 | D6 | D7 | 1 ws | 1 ws | D8 |
| 3 |  | D3 | D4 | D5 | D6 | D7 | 1 ws | 1 ws | 1 ws | D8 |
| 4 |  | D4 | D5 | D6 | D7 | 1 ws | 1 ws | 1 ws | 1 ws | D8 |
| 5 |  | D5 | D6 | D7 | 1 ws | 1 ws | 1 ws | 1 ws | 1 ws | D8 |
| 6 |  | D6 | D7 | 1 ws | 1 ws | 1 ws | 1 ws | 1 ws | 1 ws | D8 |
| 7 |  | D7 | 1 ws | 1 ws | 1 ws | 1 ws | 1 ws | 1 ws | 1 ws | D8 |

Table 6.3 Address Latency for 8 Wait States

| Word | Initial Wait |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 8 ws | D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 |
| 1 |  | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 |
| 2 |  | D2 | D3 | D4 | D5 | D6 | D7 | 1 ws | D8 | D9 |
| 3 |  | D3 | D4 | D5 | D6 | D7 | 1 ws | 1 ws | D8 | D9 |
| 4 |  | D4 | D5 | D6 | D7 | 1 ws | 1 ws | 1 ws | D8 | D9 |
| 5 |  | D5 | D6 | D7 | 1 ws | 1 ws | 1 ws | 1 ws | D8 | D9 |
| 6 |  | D6 | D7 | 1 ws | 1 ws | 1 ws | 1 ws | 1 ws | D8 | D9 |
| 7 |  | D7 | 1 ws | 1 ws | 1 ws | 1 ws | 1 ws | 1 ws | D8 | D9 |

Table 6.4 Address Latency for 7 Wait States

| Word | Initial Wait |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 7 ws | D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 |
| 1 |  | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 |
| 2 |  | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 | D10 |
| 3 |  | D3 | D4 | D5 | D6 | D7 | 1 ws | D8 | D9 | D10 |
| 4 |  | D4 | D5 | D6 | D7 | 1 ws | 1 ws | D8 | D9 | D10 |
| 5 |  | D5 | D6 | D7 | 1 ws | 1 ws | 1 ws | D8 | D9 | D10 |
| 6 |  | D6 | D7 | 1 ws | 1 ws | 1 ws | 1 ws | D8 | D9 | D10 |
| 7 |  | D7 | 1 ws | 1 ws | 1 ws | 1 ws | 1 ws | D8 | D9 | D10 |

Table 6.5 Address Latency for 6 Wait States

| Word | Initial Wait |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 6 ws | D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 |
| 1 |  | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 |
| 2 |  | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 | D10 |
| 3 |  | D3 | D4 | D5 | D6 | D7 | D8 | D9 | D10 | D11 |
| 4 |  | D4 | D5 | D6 | D7 | 1 ws | D8 | D9 | D10 | D11 |
| 5 |  | D5 | D6 | D7 | 1 ws | 1 ws | D8 | D9 | D10 | D11 |
| 6 |  | D6 | D7 | 1 ws | 1 ws | 1 ws | D8 | D9 | D10 | D11 |
| 7 |  | D7 | 1 ws | 1 ws | 1 ws | 1 ws | D8 | D9 | D10 | D11 |

Table 6.6 Address Latency for 5 Wait States

| Word | Initial Wait |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 5 ws | D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 |
| 1 |  | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 |
| 2 |  | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 | D10 |
| 3 |  | D3 | D4 | D5 | D6 | D7 | D8 | D9 | D10 | D11 |
| 4 |  | D4 | D5 | D6 | D7 | D8 | D9 | D10 | D11 | D12 |
| 5 |  | D5 | D6 | D7 | 1 ws | D8 | D9 | D10 | D11 | D12 |
| 6 |  | D6 | D7 | 1 ws | 1 ws | D8 | D9 | D10 | D11 | D12 |
| 7 |  | D7 | 1 ws | 1 ws | 1 ws | D8 | D9 | D10 | D11 | D12 |

Table 6.7 Address Latency for 4 Wait States

| Word | Initial Wait |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 4 ws | D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 |
| 1 |  | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 |
| 2 |  | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 | D10 |
| 3 |  | D3 | D4 | D5 | D6 | D7 | D8 | D9 | D10 | D11 |
| 4 |  | D4 | D5 | D6 | D7 | D8 | D9 | D10 | D11 | D12 |
| 5 |  | D5 | D6 | D7 | D8 | D9 | D10 | D11 | D12 | D13 |
| 6 |  | D6 | D7 | 1 ws | D8 | D9 | D10 | D11 | D12 | D13 |
| 7 |  | D7 | 1 ws | 1 ws | D8 | D9 | D10 | D11 | D12 | D13 |

Table 6.8 Address Latency for 3 Wait States

| Word | Initial Wait |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 3 ws | D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 |
| 1 |  | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 |
| 2 |  | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 | D10 |
| 3 |  | D3 | D4 | D5 | D6 | D7 | D8 | D9 | D10 | D11 |
| 4 |  | D4 | D5 | D6 | D7 | D8 | D9 | D10 | D11 | D12 |
| 5 |  | D5 | D6 | D7 | D8 | D9 | D10 | D11 | D12 | D13 |
| 6 |  | D6 | D7 | D8 | D9 | D10 | D11 | D12 | D13 | D14 |
| 7 |  | D7 | 1 ws | D8 | D9 | D10 | D11 | D12 | D13 | D14 |

Table 6.9 Address Latency for 2 Wait States

| Word | Initial Wait |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 0 | 2 ws | D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 |
| 1 |  | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 |
| 2 |  | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 | D10 |
| 3 |  | D3 | D4 | D5 | D6 | D7 | D8 | D9 | D10 | D11 |
| 4 |  | D4 | D5 | D6 | D7 | D8 | D9 | D10 | D11 | D12 |
| 5 |  | D5 | D6 | D7 | D8 | D9 | D10 | D11 | D12 | D13 |
| 6 |  | D6 | D7 | D8 | D9 | D10 | D11 | D12 | D13 | D14 |
| 7 |  | D7 | D8 | D9 | D10 | D11 | D12 | D13 | D14 | D15 |

Figure 6.1 Synchronous Read Flow Chart


### 6.3.2 Continuous Burst Read Mode

In the continuous burst read mode, the device outputs sequential burst data from the starting address given and then wraps around to address 000000h when it reaches the highest addressable memory location. The burst read mode continues until the system drives $\mathrm{CE} \#$ high, or RESET $=\mathrm{V}_{\mathrm{IL}}$. Continuous burst mode can also be aborted by asserting AVD\# low and providing a new address to the device.

If the address being read crosses a 128 -word line boundary within the same bank, but not into a program or erase suspended sector, as mentioned above, additional latency cycles are required as reflected by the configuration register table (Table 6.11) and Tables 6.2-6.9.
If the address crosses a bank boundary while the subsequent bank is programming or erasing, the device provides read status information and the clock is ignored. Upon completion of status read or program or erase operation, the host can restart a burst read operation using a new address and AVD\# pulse.

### 6.3.3 8-Word, 16-Word, and 32-Word Linear Burst Read with Wrap Around

In a linear burst read operation, a fixed number of words (8, 16, or 32 words) are read from consecutive addresses that are determined by the group within which the starting address falls. The groups are sized according to the number of words read in a single burst sequence for a given mode (see Table 6.10).
For example, if the starting address in the 8 -word mode is 3 Ch , the address range to be read is $38-3 \mathrm{Fh}$, and the burst sequence is 3C-3D-3E-3F-38-39-3A-3Bh. Thus, the device outputs all words in that burst address group until all word are read, regardless of where the starting address occurs in the address group, and then terminates the burst read.

In a similar fashion, the 16 -word and 32 -word Linear Wrap modes begin their burst sequence on the starting address provided to the device, then wrap back to the first address in the selected address group.

Note that in this mode the address pointer does not cross the boundary that occurs every 128 words; thus, no additional wait states are inserted due to boundary crossing.

Table 6.10 Burst Address Groups

| Mode | Group Size | Group Address Ranges |
| :---: | :---: | :---: |
| 8 -word | 8 words | $0-7 \mathrm{~h}, 8-\mathrm{Fh}, 10-17 \mathrm{~h}, \ldots$ |
| 16 -word | 16 words | $0-\mathrm{Fh}, 10-1 \mathrm{Fh}, 20-2 \mathrm{Fh}, \ldots$ |
| 32 -word | 32 words | $00-1 \mathrm{Fh}, 20-3 \mathrm{Fh}, 40-5 \mathrm{Fh}, \ldots$ |

### 6.3.4 8-Word, 16-Word, and 32-Word Linear Burst without Wrap Around

If wrap around is not enabled for linear burst read operations, the 8 -word, 16 -word, or 32 -word burst executes up to the maximum memory address of the selected number of words. The burst stops after 8, 16, or 32 addresses and does not wrap around to the first address of the selected group.

For example, if the starting address in the 8 -word mode is 3 Ch , the address range to be read is $3 \mathrm{C}-43 \mathrm{~h}$, and the burst sequence is $3 C-3 D-3 E-3 F-40-41-42-43 \mathrm{~h}$ if wrap around is not enabled. The next address to be read requires a new address and AVD\# pulse. Note that in this burst read mode, the address pointer may cross the boundary that occurs every 128 words, which incurs the additional boundary crossing wait state.

### 6.3.5 Configuration Registers

This device uses two 16-bit configuration registers to set various operational parameters. Upon power-up or hardware reset, the device is capable of the asynchronous read mode and synchronous read, and the configuration register settings are in their default state. The host system should determine the proper settings for the entire configuration register, and then execute the Set Configuration Register command sequence before attempting burst operations. The Configuration Register can also be read using a command sequence (see Table 11.1). The following list describes the register settings.

Table 6.11 Configuration Register

| CR Bit | Function |  | Settings (Binary) |
| :---: | :---: | :--- | :--- |
| CR0.15 | Reserved <br> (Not used) | $0=$ Reserved (Default) <br> $1=$ Reserved |  |
| CR0.14 | Reserved <br> (Not used) | $0=$ Reserved (Default) <br> $1=$ Reserved |  |

Table 6.11 Configuration Register

| CR Bit | Function | Settings (Binary) |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CR1.0 | Programmable Wait State (Note 1) | 0000 | = | initial data is valid on the | 2nd | rising CLK edge | AVD\# transition to $\mathrm{V}_{\mathrm{IH}}$ |
|  |  | 0001 |  |  | 3rd |  |  |
| CR0.13 |  | 0010 |  |  | 4th |  |  |
|  |  | 0011 |  |  | 5th |  |  |
| CR0.12 |  | 0100 |  |  | 6th |  |  |
|  |  | 0101 |  |  | 7th |  |  |
| CR0.11 |  | 0110 | $=$ | Reserved |  |  |  |
|  |  | 0111 |  |  |  |  |  |  |  |
|  |  | 1000 | = | initial data is valid on the | 8th | rising CLK edge | AVD\# transition to $\mathrm{V}_{\mathrm{IH}}$ |
|  |  | 1001 |  |  | 9th |  |  |
|  |  | ! |  |  |  |  |  |
|  |  | 1101 | $=$ | initial data is valid on the | 13th | rising <br> CLK edge | AVD\# transition to $\mathrm{V}_{\mathrm{IH}}$ (Default) |
|  |  | 1110 | = | Reserved |  |  |  |
|  |  | 1111 |  |  |  |  |  |  |  |
| CRO. 10 | RDY Polarity | $0=$ RDY signal is active low <br> 1 = RDY signal is active high (Default) |  |  |  |  |  |
| CR0.9 | Reserved (Not used) | $\begin{aligned} & 0=\text { Reserved } \\ & 1=\text { Reserved (Default) } \end{aligned}$ |  |  |  |  |  |
| CR0.8 | RDY | $0=$ RDY active one clock cycle before data <br> 1 = RDY active with data (Default) |  |  |  |  |  |
| CR0.7 | Reserved (Not used) | $\begin{aligned} & 0=\text { Reserved } \\ & 1=\text { Reserved (Default) } \end{aligned}$ |  |  |  |  |  |
| CR0.6 | Reserved (Not used) | $\begin{aligned} & 0=\text { Reserved } \\ & 1=\text { Reserved (Default) } \end{aligned}$ |  |  |  |  |  |
| CR0.5 | Reserved (Not used) | $\begin{aligned} & 0=\text { Reserved (Default) } \\ & 1=\text { Reserved } \end{aligned}$ |  |  |  |  |  |
| CR1.4 | Output Drive Strength | $0=$ Full Drive= Current Driver Strength (Default) 1 = Half Drive |  |  |  |  |  |
| CR0.4 | RDY Function | $\begin{aligned} & 0=\text { RDY (Default) } \\ & 1=\text { Reserved } \end{aligned}$ |  |  |  |  |  |
| CRO.3 | Burst Wrap Around | $0=$ No Wrap Around Burst <br> $1=$ Wrap Around Burst (Default) |  |  |  |  |  |
| CR0.2 | Burst Length | 000 = Continuous (Default) |  |  |  |  |  |
|  |  | $010=8$-Word Linear Burst |  |  |  |  |  |
| CR0.1 |  | $011=16$-Word Linear Burst |  |  |  |  |  |
| CRO.0 |  | 100 = 32-Word Linear Burst |  |  |  |  |  |
|  |  | (All other bit settings are reserved) |  |  |  |  |  |

## Notes

1. The addresses are latched by rising edge of CLK.
2. CR1.0 to CR1.3 and CR1.5 to CR1.15 $=1$ (Default).
3. A software reset command is required after read command.
4. CRO.3 is ignored if in continuous read mode (no wrap around).

### 6.4 Autoselect

The Autoselect is used for manufacturer ID, Device identification, and sector protection information. This mode is primarily intended for programming equipment to automatically match a device with its corresponding programming algorithm. The Autoselect codes can also be accessed in the system. When verifying sector protection, the sector address must appear on the appropriate highest order address bits (see Table 6.12). The remaining address bits are don't care. The most significant four bits of the address during the third write cycle select the bank from which the Autoselect codes are read by the host. All other banks can be accessed normally for data read without exiting the Autoselect mode.

■ To access the Autoselect codes, the host system must issue the Autoselect command.
■ The Autoselect command sequence may be written to an address within a bank that is either in the read or erase-suspend-read mode.

- The Autoselect command may not be written while the device is actively programming or erasing. Autoselect does not support simultaneous operations or burst mode.
- The system must write the reset command to return to the read mode (or erase-suspend-read mode if the bank was previously in Erase Suspend).

See Table 11.1 for command sequence details.
Table 6.12 Autoselect Addresses

| Description | Address | Read Data |
| :---: | :---: | :---: |
| Manufacturer ID Byte 00 | $(\mathrm{BA})+00 \mathrm{~h}$ | 0001h |
| Device ID, Byte 01 | $(B A)+01 \mathrm{~h}$ | 307Eh(NS512P) 317Eh(NS256P) 327Eh(NS128P) |
| Sector Lock/Unlock Byte 02 | $(S A)+02 h$ | $\begin{aligned} & 0001 \mathrm{~h}=\text { Locked, } \\ & 0000 \mathrm{~h}=\text { Unlocked } \end{aligned}$ |
| Indicator Bits Byte 07 | $(B A)+07 h$ | DQ15 - DQ8 = reserved <br> DQ7 - Factory Lock Bit; 1 = Locked, $0=$ Not Locked <br> DQ6 - Customer Lock Bit; 1 = Locked, $0=$ Not Locked <br> DQ5 - Handshake Bit; <br> 1 = Reserved, <br> 0 = Standard Handshake <br> DQ4 and DQ3 - WP\# Protection Boot Code; 01 = WP\# Protects Top Boot Sectors, DQ2 - DQ0 = reserved |
| Device ID, Byte 0E | $(\mathrm{BA})+0 \mathrm{Eh}$ | 303Fh (NS512P) 3141h (NS256P) 3243h (NS128P) |
| Device ID, Byte OF | $(\mathrm{BA})+0 \mathrm{Fh}$ | 3000h (NS512P) 3100h (NS256P) 3200h (NS128P) |

## Software Functions and Sample Code

Table 6.13 Autoselect Entry
(LLD Function = lld_AutoselectEntryCmd)

| Cycle | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: |
| Unlock Cycle 1 | Write | BA $+A A A h$ | BA +555 h | 0x00AAh |
| Unlock Cycle 2 | Write | BA+555h | BA+2AAh | $0 \times 0055 \mathrm{~h}$ |
| Autoselect Command | Write | BA+AAAh | BA +555 h | $0 x 0090 \mathrm{~h}$ |

Table 6.14 Autoselect Exit
(LLD Function = lld_AutoselectExitCmd)

| Cycle | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: |
| Unlock Cycle 1 | Write | base + xxxxh | base + xxxxh | 0x00F0h |

## Notes

1. Any offset within the device works.
2. $B A=$ Bank Address. The bank address is required.
3. base = base address.

The following is a C source code example of using the autoselect function to read the manufacturer ID. Refer to the Spansion Low Level Driver User's Guide (available on www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Here is an example of Autoselect mode (getting manufacturer ID) */
/* Define UINT16 example: typedef unsigned short UINT16; */
UINT16 manuf_id;
/* Auto Select Entry */
*( (UINT16 *)bank_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
*( (UINT16 *)bank_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
*( (UINT16 *)bank_addr + 0x555 ) = 0x0090; /* write autoselect command */
/* multiple reads can be performed after entry */
manuf_id = *( (UINT16 *)bank_addr + 0x000 ); /* read manuf. id */
/* Autoselect exit */
*( (UINT16 *)base_addr + 0x000 ) = 0x00F0; /* exit autoselect (write reset command) */
```


### 6.5 Program/Erase Operations

These devices are capable of several modes of programming and or erase operations which are described in detail in the following sections. However, prior to any programming and or erase operation, devices can be setup appropriately as outlined in the configuration register (Table 6.11).

For any program and or erase operations, including writing command sequences, the system must drive AVD\# and CE\# to $\mathrm{V}_{\mathrm{IL}}$, and OE \# to $\mathrm{V}_{\mathrm{IH}}$ when providing an address to the device, and drive WE\# and CE\# to $\mathrm{V}_{\mathrm{IL}}$, and $\mathrm{OE} \#$ to $\mathrm{V}_{\mathrm{IH}}$ when writing commands or programming data.
All addresses are latched on the rising edge of AVD\# or falling edge of WE\#, and all data is latched on the first rising edge of WE\#.

## Note the following:

■ When the Embedded Program/Erase algorithm is complete, the device returns to the read mode.
■ The system can determine the status of the Program/Erase operation. Refer to the Write Operation Status section for further information.

■ While 1 can be programmed to 0 , a 0 cannot be programmed to a 1 . Any such attempt is ignored as only an erase operation can covert a 0 to a 1 .

- Any commands written to the device during the Embedded Program/Erase Algorithm are ignored except the Program/Erase Suspend command.
- Secured Silicon Sector, Autoselect, and CFI functions are unavailable when a program operation is in progress.
- A hardware reset or power removal immediately terminates the Program/Erase operation and the Program/ Erase command sequence should be reinitiated once the device has returned to the read mode, to ensure data integrity.
- Programming is allowed in any sequence and across sector boundaries only for single word programming operation. See Write Buffer Programming when using the write buffer.

Note: The system may also lock or unlock any sector while the erase operation is suspended.

### 6.5.1 Single Word Programming

Single word programming mode is the simplest method of programming. In this mode, four Flash command write cycles are used to program an individual Flash address. While the single word programming method is supported by all Spansion devices, in general it is not recommended for devices that support Write Buffer Programming. See Table 11.1 for the required bus cycles and Figure 6.2 for the flowchart.

When the Embedded Program algorithm is complete, the device then returns to the read mode and addresses are no longer latched. The system can determine the status of the program operation by using DQ7 or DQ6. Refer to the Write Operation Status section for information on these status bits.

Figure 6.2 Single Word Program


## Software Functions and Sample Code

Table 6.15 Single Word Program
(LLD Function = lld_ProgramCmd)

| Cycle | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: |
| Unlock Cycle 1 | Write | Base + AAAh | Base $+555 h$ | 00AAh |
| Unlock Cycle 2 | Write | Base $+554 h$ | Base $+2 A A h$ | $0055 h$ |
| Program Setup | Write | Base + AAAh | Base $+555 h$ | 00A0h |
| Program | Write | Word Address | Word Address | Data Word |

Note
Base = Base Address.
The following is a C source code example of using the single word program function. Refer to the Spansion Low Level Driver User's Guide (available on www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Example: Program Command * /
    *( (UINT16 *)base_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
    *( (UINT16 *)base_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
    *( (UINT16 *)base_addr + 0x555 ) = 0x00A0; /* write program setup command */
    *( (UINT16 *)pa ) = data; /* write data to be programmed */
/* Poll for program completion */
```


### 6.5.2 Write Buffer Programming

Write Buffer Programming allows the system to write a maximum of 32 words in one programming operation. This results in a faster effective word programming time than the standard word programming algorithms. The Write Buffer Programming command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle containing the Write Buffer Load command written at the Sector Address in which programming occurs. At this point, the system writes the number of word locations minus 1 that is loaded into the page buffer at the Sector Address in which programming occurs. This tells the device how many write buffer addresses will be loaded with data and therefore when to expect the Program Buffer to Flash confirm command. The number of locations to program cannot exceed the size of the write buffer or the operation aborts. (Note: the size of the write buffer is dependent upon which data are being loaded. Also note that the number loaded $=$ the number of locations to program minus 1 . For example, if the system programs 6 address locations, then 05h should be written to the device.)
The system then writes the starting address/data combination. This starting address is the first address/data pair to be programmed, and selects the write-buffer-page address. All subsequent address/data pairs must be in sequential order.

The write-buffer addresses must be in the same sector for all address/data pairs loaded into the write buffer. It is to be noted that Write Buffer Programming cannot be performed across multiple sectors. If the system attempts to load programming data outside of the selected write-buffer addresses, the operation aborts after the Write to Buffer command is executed. Also, the starting address must be the least significant address and must be incremental and that the write buffer data cannot be in different sectors.

After writing the Starting Address/Data pair, the system then writes the remaining address/data pairs into the write buffer. Write buffer locations must be loaded in sequential order starting with the lowest address in the page. Note that if the number of address/data pairs do not match the word count, the program buffer to flash command is ignored.
Note that if a Write Buffer address location is loaded multiple times, the address/data pair counter decrements for every data load operation. Also, the last data loaded at a location before the Program Buffer to Flash confirm command is programmed into the device. It is the software's responsibility to comprehend ramifications of loading a write-buffer location more than once. The counter decrements for each data load operation, NOT for each unique write-buffer-address location.

Once the specified number of write buffer locations have been loaded, the system must then write the Program Buffer to Flash command at the Sector Address. Any other address/data write combinations abort the Write Buffer Programming operation. The device then goes busy. The Data Bar polling techniques should be used while monitoring the last address location loaded into the write buffer. This eliminates the need to store an address in memory because the system can load the last address location, issue the program confirm command at the last loaded address location, and then data bar poll at that same address. DQ7, DQ6, DQ5, DQ2, and DQ1 should be monitored to determine the device status during Write Buffer Programming.

The write-buffer embedded programming operation can be suspended using the standard suspend/resume commands. Upon successful completion of the Write Buffer Programming operation, the device returns to READ mode.

The Write Buffer Programming Sequence is ABORTED in the following ways:

- Load a value that is greater than the buffer size during the Number of Locations to Program step (DQ7 is not valid in this condition).
- Write to an address in a sector different than the one specified during the Write-Buffer-Load command.
- Write an Address/Data pair to a different write-buffer-page than the one selected by the Starting Address during the write buffer data loading stage of the operation.
- Write data other than the Confirm Command after the specified number of data load cycles.


## Software Functions and Sample Code

Table 6.16 Write Buffer Program
(LLD Functions Used = Ild_WriteToBufferCmd, Ild_ProgramBufferToFlashCmd)

| Cycle | Description | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Unlock | Write | Base + AAAh | Base +555 h | 00AAh |
| 2 | Unlock | Write | Base +554 h | Base $+2 A A h$ | 0055 h |
| 3 | Write Buffer Load Command | Write | Program Address | 0025 h |  |
| 4 | Write Word Count | Write | Program Address | Word Count (N-1)h |  |
| Number of words (N) loaded into the write buffer can be from 1 to 32 words. |  |  |  |  |  |
| 5 to 36 | Load Buffer Word N | Write | Program Address, Word N | Word N |  |
| Last | Write Buffer to Flash | Write | Sector Address | 0029 h |  |

Notes

1. Base $=$ Base Address.
2. Last = Last cycle of write buffer program operation; depending on number of words written, the total number of cycles may be from 6 to 37.
3. For maximum efficiency, it is recommended that the write buffer be loaded with the highest number of words ( $N$ words) possible. The following is a C source code example of using the write buffer program function. Refer to the Spansion Low Level Driver User's Guide (www.spansion.com) for general information on Spansion Flash memory software development guidelines.
```
* Example: Write Buffer Programming Command */
/* NOTES: Write buffer programming limited to 16 words. */
/* All addresses to be written to the flash in */
/* one operation must be within the same write buffer. */
/* A write buffer begins at addresses evenly divisible */
* by 0x20.
UINT16 i; */
UINT16 *Src = source_of_data; /* address of source data */
UINT16 *dst = destination_of_data; /* flash destination address */
UINT16 wc = words_to_program -1; /* word count (minus 1) */
* (UINT16 *)base_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
*( (UINT16 *)base_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
*( (UINT16 *)dst ) = 0x0025; /* write write buffer load command */
*( (UINT16 *)dst ) = wc; /* write word count (minus 1) */
for (i=0;i<=wc;i++)
{
*dst++ = *src++; /* ALL dst MUST BE in same Write Buffer */
}
*( (UINT16 *)sector_address ) = 0x0029; /* write confirm command */
/* poll for completion */
/* Example: Write Buffer Abort Reset */
*( (UINT16 *)base_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
* (UINT16 *)base_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
*( (UINT16 *) base_addr + 0x555 ) = 0x00F0; /* write buffer abort reset */
```

Figure 6.3 Write Buffer Programming Operation


### 6.5.3 Sector Erase

The sector erase function erases one or more sectors in the memory array. (See Table 11.1 and Figure 6.4.) The device does not require the system to preprogram prior to erase. The Embedded Erase algorithm automatically programs and verifies the entire memory for an all zero data pattern prior to electrical erase. After a successful sector erase, all locations within the erased sector contain FFFFh. The system is not required to provide any controls or timings during these operations.

After the command sequence is written, a sector erase time-out of no less than $t_{\text {SEA }}$ occurs. During the timeout period, additional sector addresses and sector erase commands may be written. Loading the sector erase buffer may be done in any sequence, and the number of sectors may be from one sector to all sectors. The time between these additional cycles must be less than tsEA. Any sector erase address and command following the exceeded time-out ( $\mathrm{t}_{\text {SEA }}$ ) may or may not be accepted. Any command other than Sector Erase or Erase Suspend during the time-out period resets that bank to the read mode. The system can monitor DQ3
to determine if the sector erase timer has timed out (See the section, DQ3: Sector Erase Timeout State Indicator.) The time-out begins from the rising edge of the final WE\# pulse in the command sequence.
When the Embedded Erase algorithm is complete, the bank returns to reading array data and addresses are no longer latched. Note that while the Embedded Erase operation is in progress, the system can read data from the non-erasing banks. The system can determine the status of the erase operation by reading DQ7 or DQ6/DQ2 in the erasing bank. Refer to Write Operation Status for information on these status bits.

Once the sector erase operation has begun, only the Erase Suspend command is valid. All other commands are ignored. However, note that a hardware reset immediately terminates the erase operation. If that occurs, the sector erase command sequence should be reinitiated once that bank has returned to reading array data, to ensure data integrity.
Figure 6.4 illustrates the algorithm for the erase operation. Refer to Program/Erase Operations for parameters and timing diagrams.

## Software Functions and Sample Code

Table 6.17 Sector Erase
(LLD Function = lld_SectorEraseCmd)

| Cycle | Description | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Unlock | Write | Base + AAAh | Base + 555h | 00AAh |
| 2 | Unlock | Write | Base + 554h | Base + 2AAh | 0055h |
| 3 | Setup Command | Write | Base + AAAh | Base + 555h | 0080h |
| 4 | Unlock | Write | Base + AAAh | Base + 555h | 00AAh |
| 5 | Unlock | Write | Base + 554h | Base + 2AAh | 0055h |
| 6 | Sector Erase Command | Write | Sector Address | Sector Address | 0030h |
| Unlimited additional sectors may be selected for erase; command(s) must be written within tseA . |  |  |  |  |  |

The following is a C source code example of using the sector erase function. Refer to the Spansion Low Level Driver User's Guide (available on www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Example: Sector Erase Command */
    *( (UINT16 *)base_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
    *( (UINT16 *)base_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
    *( (UINT16 *)base_addr + 0x555 ) = 0x0080; /* write setup command */
    *( (UINT16 *)base_addr + 0x555 ) = 0x00AA; /* write additional unlock cycle 1 */
    *( (UINT16 *)base_addr + 0x2AA ) = 0x0055; /* write additional unlock cycle 2 */
    *( (UINT16 *)sector_address ) = 0x0030; /* write sector erase command */
```

Figure 6.4 Sector Erase Operation


### 6.5.4 Chip Erase Command Sequence

Chip erase is a six-bus cycle operation as indicated by Table 11.1. These commands invoke the Embedded Erase algorithm, which does not require the system to preprogram prior to erase. The Embedded Erase algorithm automatically preprograms and verifies the entire memory for an all zero data pattern prior to electrical erase. After a successful chip erase, all locations of the chip contain FFFFh. The system is not required to provide any controls or timings during these operations. Table 11.1 shows the address and data requirements for the chip erase command sequence.
When the Embedded Erase algorithm is complete, that bank returns to the read mode and addresses are no longer latched. The system can determine the status of the erase operation by using DQ7 or DQ6/DQ2. Refer to the Write Operation Status section for information on these status bits.

Any commands written during the chip erase operation are ignored. However, note that a hardware reset immediately terminates the erase operation. If that occurs, the chip erase command sequence should be reinitiated once that bank has returned to reading array data, to ensure data integrity.

## Software Functions and Sample Code

Table 6.18 Chip Erase
(LLD Function = Ild_ChipEraseCmd)

| Cycle | Description | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Unlock | Write | Base + AAAh | Base $+555 h$ | 00AAh |
| 2 | Unlock | Write | Base $+554 h$ | Base $+2 A A h$ | $0055 h$ |
| 3 | Setup Command | Write | Base + AAAh | Base $+555 h$ | 0080 h |
| 4 | Unlock | Write | Base + AAAh | Base $+555 h$ | 00AAh |
| 5 | Unlock | Write | Base $+554 h$ | Base $+2 A A h$ | 0055h |
| 6 | Chip Erase Command | Write | Base + AAAh | Base $+555 h$ | 0010h |

The following is a C source code example of using the chip erase function. Refer to the Spansion Low Level Driver User's Guide (www.spansion.comm) for general information on Spansion Flash memory software development guidelines.

```
/* Example: Chip Erase Command */
/* Note: Cannot be suspended */
    *( (UINT16 *)base_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
    *( (UINT16 *)base_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
    *( (UINT16 *) base_addr + 0x555 ) = 0x0080; /* write setup command */
    * (UINT16 *) base_addr + 0x555 ) = 0x00AA; /* write additional unlock cycle 1 */
    *( (UINT16 *) base_addr + 0x2AA ) = 0x0055; /* write additional unlock cycle 2 */
    *( (UINT16 *) base_addr + 0x000 ) = 0x0010; /* write chip erase command */
```


### 6.5.5 Erase Suspend/Erase Resume Commands

When the Erase Suspend command is written during the sector erase time-out, the device immediately terminates the time-out period and suspends the erase operation. The Erase Suspend command allows the system to interrupt a sector erase operation and then read data from, or program data to, any sector not selected for erasure. The bank address is required when writing this command. This command is valid only during the sector erase operation, including the minimum $t_{\text {SEA }}$ time-out period during the sector erase command sequence. The Erase Suspend command is ignored if written during the chip erase operation.

When the Erase Suspend command is written after the tSEA time-out period has expired and during the sector erase operation, the device requires a maximum of $t_{\text {ESL }}$ (erase suspend latency) to suspend the erase operation.

After the erase operation has been suspended, the bank enters the erase-suspend-read mode. The system can read data from or program data to any sector not selected for erasure. (The device erase suspends all sectors selected for erasure.) Reading at any address within erase-suspended sectors produces status information on DQ7-DQ0. The system can use DQ7, or DQ6, and DQ2 together, to determine if a sector is actively erasing or is erase-suspended. Refer to Table 6.27 for information on these status bits.

After an erase-suspended program operation is complete, the bank returns to the erase-suspend-read mode. The system can determine the status of the program operation using the DQ7 or DQ6 status bits, just as in the standard program operation.
In the erase-suspend-read mode, the system can also issue the Autoselect command sequence. Refer to the Write Buffer Programming section and the Autoselect section for details.

To resume the sector erase operation, the system must write the Erase Resume command. The bank address of the erase-suspended bank is required when writing this command. Further writes of the Resume command are ignored. Another Erase Suspend command can be written after the chip has resumed erasing.
Note: While an erase operation can be suspended and resumed multiple times, a minimum delay of $t_{\text {ERS }}$ (Erase Resume to Suspend) is required from resume to the next suspend.

## Software Functions and Sample Code

Table 6.19 Erase Suspend
(LLD Function = lld_EraseSuspendCmd)

| Cycle | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: |
| 1 | Write | Bank Address | Bank Address | 00BOh |

The following is a C source code example of using the erase suspend function. Refer to the Spansion Low Level Driver User's Guide (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Example: Erase suspend command */
    * ( (UINT16 *) bank_addr + 0x000 ) = 0x00B0; /* write suspend command
```

Table 6.20 Erase Resume
(LLD Function = lld_EraseResumeCmd)

| Cycle | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: |
| 1 | Write | Bank Address | Bank Address | 0030h |

The following is a C source code example of using the erase resume function. Refer to the Spansion Low Level Driver User's Guide (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
* Example: Erase resume command */
    * (UINT16 *)bank_addr + 0x000 ) = 0x0030; /* write resume command */
    /* The flash needs adequate time in the resume state */
```


### 6.5.6 Program Suspend/Program Resume Commands

The Program Suspend command allows the system to interrupt an embedded programming operation or a Write to Buffer programming operation so that data can read from any non-suspended sector. When the Program Suspend command is written during a programming process, the device halts the programming operation within $t_{\text {PSL }}$ (program suspend latency) and updates the status bits. Addresses are don't-cares when writing the Program Suspend command.
After the programming operation has been suspended, the system can read array data from any nonsuspended sector. The Program Suspend command may also be issued during a programming operation while an erase is suspended. In this case, data may be read from any addresses not in Erase Suspend or Program Suspend. If a read is needed from the Secured Silicon Sector area, then user must use the proper command sequences to enter and exit this region.
The system may also write the Autoselect command sequence when the device is in Program Suspend mode. The device allows reading Autoselect codes in the suspended sectors, since the codes are not stored in the memory array. When the device exits the Autoselect mode, the device reverts to Program Suspend mode, and is ready for another valid operation. See the Autoselect section for more information.

After the Program Resume command is written, the device reverts to programming. The system can determine the status of the program operation using the DQ7 or DQ6 status bits, just as in the standard program operation. See the Write Operation Status section for more information.

The system must write the Program Resume command (address bits are don't care) to exit the Program Suspend mode and continue the programming operation. Further writes of the Program Resume command are ignored. Another Program Suspend command can be written after the device has resumed programming.
Note: While a program operation can be suspended and resumed multiple times, a minimum delay of tpRS (Program Resume to Suspend) is required from resume to the next suspend.

## Software Functions and Sample Code

Table 6.21 Program Suspend
(LLD Function = lld_ProgramSuspendCmd)

| Cycle | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: |
| 1 | Write | Bank Address | Bank Address | 00BOh |

The following is a C source code example of using the program suspend function. Refer to the Spansion Low Level Driver User's Guide (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Example: Program suspend command */
    *( (UINT16 *)base_addr + 0x000 ) = 0x00B0; /* write suspend command */
```

Table 6.22 Program Resume
(LLD Function = lld_ProgramResumeCmd)

| Cycle | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: |
| 1 | Write | Bank Address | Bank Address | 0030h |

The following is a C source code example of using the program resume function. Refer to the Spansion Low Level Driver User's Guide (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Example: Program resume command */
    *( (UINT16 *) base_addr + 0x000 ) = 0x0030; /* write resume command */
```


### 6.5.7 Accelerated Program/Sector Erase

Accelerated single word programming, write buffer programming and sector erase, operations are enabled through the $\mathrm{V}_{\mathrm{PP}}$ function. This method is faster than the standard chip program and erase command sequences.
The accelerated chip program and erase functions must not be used more than 100 times per sector. In addition, accelerated chip program and erase should be performed at room temperature $\left(30^{\circ} \mathrm{C} \pm 10^{\circ} \mathrm{C}\right)$.
If the system asserts $\mathrm{V}_{\mathrm{HH}}$ on this input, the device automatically enters the accelerated mode and uses the higher voltage on the input to reduce the time required for program and erase operations. The system can then use the Write Buffer Load command sequence provided by the Unlock Bypass mode. Note that if a Write-to-Buffer-Abort Reset is required while in Unlock Bypass mode, the full 3-cycle RESET command sequence must be used to reset the device. Removing $\mathrm{V}_{\mathrm{HH}}$ from the $\mathrm{V}_{\mathrm{PP}}$ input, upon completion of the embedded program or erase operation, returns the device to normal operation.

■ Sectors must be unlocked prior to raising $\mathrm{V}_{\mathrm{PP}}$ to $\mathrm{V}_{\mathrm{HH}}$.

- The $\mathrm{V}_{\mathrm{PP}}$ pin must not be at $\mathrm{V}_{\mathrm{HH}}$ for operations other than accelerated programming and accelerated sector erase, or device damage may result.
■ The $\mathrm{V}_{\mathrm{PP}}$ pin must not be left floating or unconnected; inconsistent behavior of the device may result.
- $\mathrm{V}_{\mathrm{PP}}$ locks all sector if set to $\mathrm{V}_{\mathrm{IL}} ; \mathrm{V}_{\mathrm{PP}}$ should be set to $\mathrm{V}_{\mathrm{IH}}$ for all other conditions.


### 6.5.8 Unlock Bypass

The unlock bypass feature allows the system to primarily program to a bank faster than using the standard program command sequence. The unlock bypass command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle containing the unlock bypass command, 20h. The device then enters the unlock bypass mode. A two-cycle unlock bypass program command sequence is all that is required to program in this mode. The first cycle in this sequence contains the unlock bypass program command, AOh; the second cycle contains the program address and data. Additional data is programmed in the same manner. This mode dispenses with the initial two unlock cycles required in the standard program command sequence, resulting in faster total programming time. The host system may also initiate the chip erase and sector erase sequences in the unlock bypass mode. The erase command sequences are four cycles in length instead of six cycles. Table 11.1 shows the requirements for the unlock bypass command sequences.

During the unlock bypass mode, only the Read, Unlock Bypass Program, Unlock Bypass Sector Erase, Unlock Bypass Chip Erase, and Unlock Bypass Reset commands are valid. To exit the unlock bypass mode, the system must issue the two-cycle unlock bypass reset command sequence. The first cycle must contain
the bank address and the data 90 h . The second cycle need only contain the data 00h. The bank then returns to the read mode.
The device offers accelerated program operations through the $\mathrm{V}_{\mathrm{PP}}$ input. When the system asserts $\mathrm{V}_{\mathrm{HH}}$ on this input, the device automatically enters the Unlock Bypass mode. The system may then write the two-cycle Unlock Bypass program command sequence. The device uses the higher voltage on the $\mathrm{V}_{\mathrm{PP}}$ input to accelerate the operation.

Refer to the Erase/Program Timing section for parameters, and Figures 10.12 and 10.13 for timing diagrams

## Software Functions and Sample Code

The following are C source code examples of using the unlock bypass entry, program, and exit functions. Refer to the Spansion Low Level Driver User's Guide (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

Table 6.23 Unlock Bypass Entry

> (LLD Function = lld_UnlockBypassEntryCmd)

| Cycle | Description | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Unlock | Write | Base + AAAh | Base +555 h | 00 AAh |
| 2 | Unlock | Write | Base +554 h | Base $+2 A A h$ | 0055 h |
| 3 | Entry Command | Write | Base + AAAh | Base +555 h | 0020 h |

$$
\begin{aligned}
& \text { /* Example: Unlock Bypass Entry Command */ } \\
& \text { * (UINT16 *) bank_addr + 0x555 ) = 0x00AA; /* write unlock cycle } 1 \text { */ } \\
& \text { * (UINT16 *) bank_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */ } \\
& \text { * (UINT16 *) bank_addr + 0x555 ) = 0x0020; /* write unlock bypass command */ } \\
& \text { /* At this point, programming only takes two write cycles. */ } \\
& \text { /* Once you enter Unlock Bypass Mode, do a series of like */ } \\
& \text { /* operations (programming or sector erase) and then exit */ } \\
& \text { /* Unlock Bypass Mode before beginning a different type of */ } \\
& \text { /* operations. */ }
\end{aligned}
$$

Table 6.24 Unlock Bypass Program
(LLD Function = Ild_UnlockBypassProgramCmd)

| Cycle | Description | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Program Setup Command | Write | Base $+x x x h$ | Base $+x x x h$ | 00A0h |
| 2 | Program Command | Write | Program Address | Program Address | Program Data |

```
/* Example: Unlock Bypass Program Command */
/* Do while in Unlock Bypass Entry Mode! */
    *( (UINT16 *) bank_addr + 0x555 ) = 0x00A0; /* write program setup command */
    *( (UINT16 *)pa ) = data; /* write data to be programmed */
    /* Poll until done or error. */
    /* If done and more to program, */
    /* do above two cycles again. */
```

Table 6.25 Unlock Bypass Reset
(LLD Function = lld_UnlockBypassResetCmd)

| Cycle | Description | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | Reset Cycle 1 | Write | Base $+x x x h$ | Base $+x x x h$ | 0090 h |
| 2 | Reset Cycle 2 | Write | Base $+x x x h$ | Base $+x x x h$ | 0000 h |

```
/* Example: Unlock Bypass Exit Command */
    *( (UINT16 *)base_addr + 0x000 ) = 0x0090;
    *( (UINT16 *)base_addr + 0x000 ) = 0x0000;
```


### 6.5.9 Write Operation Status

The device provides several bits to determine the status of a program or erase operation. The following subsections describe the function of DQ1, DQ2, DQ3, DQ5, DQ6, and DQ7.

## DQ7: Data\# Polling

The Data\# Polling bit, DQ7, indicates to the host system whether an Embedded Program or Erase algorithm is in progress or completed, or whether a bank is in Erase Suspend. Data\# Polling is valid after the rising edge of the final WE\# pulse in the command sequence. Note that the Data\# Polling is valid only for the last word being programmed in the write-buffer-page during Write Buffer Programming. Reading Data\# Polling status on any word other than the last word to be programmed in the write-buffer-page returns false status information. Similarly, attempting to program 1 over a 0 does not return valid Date\# information.

During the Embedded Program algorithm, the device outputs on DQ7 the complement of the datum programmed to DQ7. This DQ7 status also applies to programming during Erase Suspend. The system must provide the program address to read valid status information on DQ7. If a program address falls within a protected sector, Data\# polling on DQ7 is active for approximately $t_{P S P}$, then that bank returns to the read mode.

During the Embedded Erase Algorithm, Data\# polling produces a 0 on DQ7. When the Embedded Erase algorithm is complete, or if the bank enters the Erase Suspend mode, Data\# Polling produces a 1 on DQ7. The system must provide an address within any of the sectors selected for erasure to read valid status information on DQ7.

After an erase command sequence is written, if all sectors selected for erasing are protected, Data\# Polling on DQ7 is active for approximately $\mathrm{t}_{\text {ASP }}$, then the bank returns to the read mode. If not all selected sectors are protected, the Embedded Erase algorithm erases the unprotected sectors, and ignores the selected sectors that are protected. However, if the system reads DQ7 at an address within a protected sector, the status may not be valid.

Just prior to the completion of an Embedded Program or Erase operation, DQ7 may change asynchronously with DQ6-DQ1 while Output Enable (OE\#) is asserted low. That is, the device may change from providing status information to valid data on DQ7. Even if the device has completed the program or erase operation and DQ7 has valid data, the data outputs on DQ6-DQ1 may be still invalid. Valid data on DQ7-D01 appears on successive read cycles.

See the following for more information: Table 6.27, Write Operation Status, shows the outputs for Data\# Polling on DQ7. Table 6.5, Write Operation Status Flowchart, shows the Data\# Polling algorithm; and Figure 10.15, Data\# Polling Timings (During Embedded Algorithm), shows the Data\# Polling timing diagram.

Figure 6.5 Write Operation Status Flowchart


## DQ6: Toggle Bit I

Toggle Bit I on DQ6 indicates whether an Embedded Program or Erase algorithm is in progress or complete, or whether the device has entered the Erase Suspend mode. Toggle Bit I may be read at any address in the same bank, and is valid after the rising edge of the final WE\# pulse in the command sequence (prior to the program or erase operation), and during the sector erase time-out.
During an Embedded Program or Erase algorithm operation, successive read cycles to any address cause DQ6 to toggle. When the operation is complete, DQ6 stops toggling.
After an erase command sequence is written, if all sectors selected for erasing are protected, DQ6 toggles for approximately $\mathrm{t}_{\mathrm{ASP}}$ [all sectors protected toggle time], then returns to reading array data. If not all selected sectors are protected, the Embedded Erase algorithm erases the unprotected sectors, and ignores the selected sectors that are protected.

The system can use DQ6 and DQ2 together to determine whether a sector is actively erasing or is erasesuspended. When the device is actively erasing (that is, the Embedded Erase algorithm is in progress), DQ6 toggles. When the device enters the Erase Suspend mode, DQ6 stops toggling. However, the system must also use DQ2 to determine which sectors are erasing or erase-suspended. Alternatively, the system can use DQ7 (see the subsection on DQ7: Data\# Polling).
If a program address falls within a protected sector, DQ6 toggles for approximately $t_{\text {PSP }}$ after the program command sequence is written, then returns to reading array data.
DQ6 also toggles during the erase-suspend-program mode, and stops toggling once the Embedded Program Algorithm is complete.
See the following for additional information: Figure 6.5, Write Operation Status Flowchart, Figure 10.16, Toggle Bit Timings (During Embedded Algorithm), and Tables 6.26 and 6.27.

Toggle Bit I on DQ6 requires either OE\# or CE\# to be de-asserted and reasserted to show the change in state

## DQ2: Toggle Bit II

The Toggle Bit II on DQ2, when used with DQ6, indicates whether a particular sector is actively erasing (that is, the Embedded Erase algorithm is in progress), or whether that sector is erase-suspended. Toggle Bit II is valid after the rising edge of the final WE\# pulse in the command sequence. DQ2 toggles when the system reads at addresses within those sectors that have been selected for erasure. But DQ2 cannot distinguish whether the sector is actively erasing or is erase-suspended. DQ6, by comparison, indicates whether the device is actively erasing, or is in Erase Suspend, but cannot distinguish which sectors are selected for erasure. Thus, both status bits are required for sector and mode information. Refer to Table 6.26 to compare outputs for DQ2 and DQ6. See the following for additional information: Figure 6.5, the DQ6: Toggle Bit I section, and Figures 10.15-10.18.

Table 6.26 DQ6 and DQ2 Indications

| If device is | and the system reads | then DQ6 | and DQ2 |
| :---: | :---: | :---: | :---: |
| programming, | any address at the bank being programmed | toggles, | does not toggle. |
| actively erasing, | at an address within a sector selected for erasure, | toggles, | also toggles. |
|  | at an address within sectors not selected for erasure, | toggles, | does not toggle. |
| erase suspended, | at an address within a sector selected for erasure, | does not toggle, | toggles. |
|  | at an address within sectors not selected for erasure, | returns array data, | returns array data. The system can read from any sector not selected for erasure. |
| programming in erase suspend | any address at the bank being programmed | toggles, | is not applicable. |

## Reading Toggle Bits DQ6/DQ2

Whenever the system initially begins reading toggle bit status, it must read DQ7 - DQ0 at least twice in a row to determine whether a toggle bit is toggling. Typically, the system notes and stores the value of the toggle bit after the first read. After the second read, the system compares the new value of the toggle bit with the first. If the toggle bit is not toggling, the device has completed the program or erases operation. The system can read array data on DQ7 - DQ0 on the following read cycle. However, if after the initial two read cycles, the system determines that the toggle bit is still toggling, the system also should note whether the value of DQ5 is high (see the section on DQ5). If it is, the system should then determine again whether the toggle bit is toggling, since the toggle bit may have stopped toggling just as DQ5 went high. If the toggle bit is no longer toggling, the device has successfully completed the program or erases operation. If it is still toggling, the device did not complete the operation successfully, and the system must write the reset command to return to reading array data. The remaining scenario is that the system initially determines that the toggle bit is toggling and DQ5 has not gone high. The system may continue to monitor the toggle bit and DQ5 through successive read cycles, determining the status as described in the previous paragraph. Alternatively, it may choose to perform other system tasks. In this case, the system must start at the beginning of the algorithm when it returns to determine the status of the operation. Refer to Figure 6.5 for more details.
Note: When verifying the status of a write operation (embedded program/erase) of a memory bank, DQ6 and DQ2 toggle between high and low states in a series of consecutive and contiguous status read cycles. In order for this toggling behavior to be properly observed, the consecutive status bit reads must not be interleaved with read accesses to other memory banks. If it is not possible to temporarily prevent reads to
other memory banks, then it is recommended to use the DQ7 status bit as the alternative method of determining the active or inactive status of the write operation.

## DQ5: Exceeded Timing Limits

DQ5 indicates whether the program or erase time has exceeded a specified internal pulse count limit. Under these conditions DQ5 produces a 1, indicating that the program or erase cycle was not successfully completed. The device may output a 1 on DQ5 if the system tries to program a 1 to a location that was previously programmed to 0 . Only an erase operation can change a 0 back to a 1 . Under this condition, the device halts the operation, and when the timing limit has been exceeded, DQ5 produces a 1 . Under both these conditions, the system must write the reset command to return to the read mode (or to the erase-suspend-read mode if a bank was previously in the erase-suspend-program mode).

## DQ3: Sector Erase Timeout State Indicator

After writing a sector erase command sequence, the system may read DQ3 to determine whether or not erasure has begun. (The sector erase timer does not apply to the chip erase command.) If additional sectors are selected for erasure, the entire time-out also applies after each additional sector erase command. When the time-out period is complete, DQ3 switches from a 0 to a 1 . If the time between additional sector erase commands from the system can be assumed to be less than $t_{\text {SEA }}$, the system need not monitor DQ3. See the Sector Erase Command Sequence, for more details.
After the sector erase command is written, the system should read the status of DQ7 (Data\# Polling) or DQ6 (Toggle Bit I) to ensure that the device has accepted the command sequence, and then read DQ3. If DQ3 is 1, the Embedded Erase algorithm has begun; all further commands (except Erase Suspend) are ignored until the erase operation is complete. If DQ3 is 0 , the device accepts additional sector erase commands. To ensure the command has been accepted, the system software should check the status of DQ3 prior to and following each sub-sequent sector erase command. If DQ3 is high on the second status check, the last command might not have been accepted. Table 6.27 shows the status of DQ3 relative to the other status bits.

## DQ1: Write to Buffer Abort

DQ1 indicates whether a Write to Buffer operation was aborted. Under these conditions DQ1 produces a 1. The system must issue the Write to Buffer Abort Reset command sequence to return the device to reading array data. See Write Buffer Programming Operation for more details.

Table 6.27 Write Operation Status

| Status |  |  | DQ7 (2) | DQ6 | DQ5 (1) | DQ3 | DQ2 (2) | DQ1 (4) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Standard Mode | Embedded Program Algorithm |  | DQ7\# | Toggle | 0 | N/A | No toggle | 0 |
|  | Embedded Erase Algorithm |  | 0 | Toggle | 0 | 1 | Toggle | N/A |
| Program Suspend Mode (3) | Reading within Program Suspended Sector |  |  | INVALID <br> (Not Allowed) |  |  | INVALID <br> (Not Allowed) |  |
|  | Reading within Non-Program Suspended Sector |  | Data | Data | Data | Data | Data | Data |
| Erase Suspend Mode | Erase-SuspendRead | Erase <br> Suspended <br> Sector | 1 | No toggle | 0 | N/A | Toggle | N/A |
|  |  | Non-Erase <br> Suspended <br> Sector | Data | Data | Data | Data | Data | Data |
|  | Erase-Suspend-Program |  | DQ7\# | Toggle | 0 | N/A | N/A | N/A |
| Write to Buffer (5) | BUSY State |  | DQ7\# | Toggle | 0 | N/A | N/A | 0 |
|  | Exceeded Timing Limits |  | DQ7\# | Toggle | 1 | N/A | N/A | 0 |
|  | ABORT State |  | DQ7\# | Toggle | 0 | N/A | N/A | 1 |

## Notes

1. DQ5 switches to 1 when an Embedded Program or Embedded Erase operation has exceeded the maximum timing limits. Refer to the section on DQ5 for more information.
2. DQ7 and DQ2 require a valid address when reading status information. Refer to the appropriate subsection for further details.
3. Data are invalid for addresses in a Program Suspended sector.
4. DQ1 indicates the Write to Buffer ABORT status during Write Buffer Programming operations.
5. The data-bar polling algorithm should be used for Write Buffer Programming operations. Note that DQ7\# during Write Buffer Programming indicates the data-bar for DQ7 data for the LAST LOADED WRITE-BUFFER ADDRESS location.

### 6.6 Simultaneous Read/Write

The simultaneous read/write feature allows the host system to read data from one bank of memory while programming or erasing another bank of memory. An erase operation may also be suspended to read from or program another location within the same bank (except the sector being erased). Figure 10.21, Back-to-Back Read/Write Cycle Timings, shows how read and write cycles may be initiated for simultaneous operation with zero latency. Refer to the DC Characteristics table for read-while-program and read-while-erase current specification.

### 6.7 Writing Commands/Command Sequences

When the device is in Asynchronous read, only Asynchronous write operations are allowed. During an asynchronous write operation, the system must drive CE\# and $W E \#$ to $\mathrm{V}_{\mathrm{IL}}$ and $\mathrm{OE} \#$ to $\mathrm{V}_{\mathrm{IH}}$ when providing an address, command, and data. Addresses are latched on the rising edge of AVD\#, while data is latched on the rising edge of WE\#. An erase operation can erase one sector, multiple sectors, or the entire device. Table 5.1 - Table 5.3 indicate the address space that each sector occupies. The device address space is divided into sixteen banks: for NS512P, all 16 banks contain 64-Kword sectors while for NS256P and NS128P, Banks 0 through 14 contain only 64 Kword sectors, Bank 15 contains 16 -Kword boot sectors in addition to 64 Kword sectors. A bank address is the set of address bits required to uniquely select a bank. Similarly, a sector address is the address bits required to uniquely select a sector. I $\mathrm{I}_{\mathrm{C} 2}$ in the DC Characteristics section represents the active current specification for the write mode. AC Characteristics-Synchronous and AC Characteristics-Asynchronous contain timing specification tables and timing diagrams for write operations.

### 6.8 Handshaking

The handshaking feature allows the host system to detect when data is ready to be read by simply monitoring the RDY pin which is a dedicated output and is controlled by CE\#.

### 6.9 Hardware Reset

The RESET\# input provides a hardware method of resetting the device to reading array data. When RESET\# is driven low for at least a period of $t_{\mathrm{RP}}$, the device immediately terminates any operation in progress, tristates all outputs, resets the configuration register, and ignores all read/write commands for the duration of the RESET\# pulse. The device also resets the internal state machine to reading array data.
To ensure data integrity the operation that was interrupted should be reinitiated once the device is ready to accept another command sequence.
When RESET\# is held at $\mathrm{V}_{\mathrm{SS}}$, the device draws CMOS standby current ( $\mathrm{I}_{\mathrm{CC} 4}$ ). If RESET\# is held at $\mathrm{V}_{\mathrm{IL}}$, but not at $\mathrm{V}_{\mathrm{SS}}$, the standby current is greater.
RESET\# may be tied to the system reset circuitry which enables the system to read the boot-up firmware from the Flash memory upon a system reset.

See Figures 10.5 and 10.11 for timing diagrams.

### 6.10 Software Reset

Software reset is part of the command set (see Table 11.1) that also returns the device to array read mode and must be used for the following conditions:

1. to exit Autoselect mode
2. when DQ5 goes high during write status operation that indicates program or erase cycle was not successfully completed
3. exit sector lock/unlock operation.
4. to return to erase-suspend-read mode if the device was previously in Erase Suspend mode.
5. after any aborted operations
6. exiting read configuration registration Mode

## Software Functions and Sample Code

Table 6.28 Reset
(LLD Function = lld_ResetCmd)

| Cycle | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: |
| Reset Command | Write | Base $+x x x h$ | Base $+x x x h$ | 00F0h |

## Note

Base $=$ Base Address .
The following is a C source code example of using the reset function. Refer to the Spansion Low Level Driver User's Guide (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Example: Reset (software reset of Flash state machine) */
* ( (UINT16 *) base_addr + 0x000 ) = 0x00F0;
```

The following are additional points to consider when using the reset command:
■ This command resets the banks to the read and address bits are ignored.

- Reset commands are ignored once erasure has begun until the operation is complete.

■ Once programming begins, the device ignores reset commands until the operation is complete

- The reset command may be written between the cycles in a program command sequence before programming begins (prior to the third cycle). This resets the bank to which the system was writing to the read mode.
- If the program command sequence is written to a bank that is in the Erase Suspend mode, writing the reset command returns that bank to the erase-suspend-read mode.
- The reset command may be also written during an Autoselect command sequence.
- If a bank has entered the Autoselect mode while in the Erase Suspend mode, writing the reset command returns that bank to the erase-suspend-read mode.
- If DQ1 goes high during a Write Buffer Programming operation, the system must write the Write to Buffer Abort Reset command sequence to RESET the device to reading array data. The standard RESET command does not work during this condition.

■ To exit the unlock bypass mode, the system must issue a two-cycle unlock bypass reset command sequence [see command table for details].

### 6.11 Programmable Output Slew Rate Control

This feature allows the user to change the output slew rate during a read operation by setting the configuration register bit CR1.4. It allows 2 programmable slew rates. This feature is for users who do not want to run the part at its maximum speed and could live with a slower output slew rate thereby reducing noise variations at the output.

Table 6.29 Programmable Output Slew Rate

| Mode | Description | $\mathbf{I}_{\mathbf{O L}} \& I_{\mathbf{O H}}$ |
| :---: | :---: | :---: |
| 1 | Full Drive (Default) | $100 \mu \mathrm{~A}$ |
| 2 | Half Drive | $50 \mu \mathrm{~A}$ |

## 7. Advanced Sector Protection/Unprotection

The Advanced Sector Protection/Unprotection feature disables or enables programming or erase operations in any or all sectors and can be implemented through software and/or hardware methods, which are independent of each other. This section describes the various methods of protecting data stored in the memory array. An overview of these methods in shown in Figure 7.1.

Figure 7.1 Advanced Sector Protection/Unprotection

## Hardware Methods




1. Bit is volatile, and defaults to 1 on reset.
2. Programming to 0 locks all PPBs to their current state.
3. Once programmed to 0 , requires hardware reset to unlock.

## Dynamic

 Protection Bit(DYB) ${ }^{6,7,8}$

3. $\mathrm{N}=$ Highest Address Sector
4. 0 = Sector Protected, 1 = Sector Unprotected
5. PPBs programmed individually, but cleared collectively
$0=$ Sector Protected 1 = Sector Unprotected.
7. Protect effective only if PPB Lock Bit is unlocked and corresponding PPB is 1 (unprotected).
8. Volatile Bits: defaults to protected after power up.

### 7.1 Lock Register

The Lock Register consists of 5 bits. The Secured Silicon Sector Protection Bit is DQO, Persistent Protection Mode Lock Bit is DQ1, Password Protection Mode Lock Bit is DQ2, Persistent Sector Protection OTP bit is DQ3 and Volatile Sector Protection Boot bit is DQ4. If DQ0 is 0 , it means that the Customer Secured Silicon area is locked and if DQ0 is 1 , it means that it is unlocked. When DQ2 is set to 1 and DQ1 is set to 0 , the
device can only be used in the Persistent Protection Mode. When the device is set to Password Protection Mode, DQ1 is required to be set to 1 and DQ2 is required to be set to 0 . DQ3 is programmed in the Spansion factory. When the device is programmed to disable all PPB erase command, DQ3 outputs a 0 , when the lock register bits are read. Similarly, if the device is programmed to enable all PPB erase command, DQ3 outputs a 1 when the lock register bits are read. Likewise the DQ4 bit is also programmed in the Spansion Factory. DQ4 is the bit which indicates whether Volatile Sector Protection Bit (DYB) is protected or not after boot up. When the device is programmed to set all Volatile Sector Protection Bit protected after power up, DQ4 outputs a 0 when the lock register bits are read. Similarly, when the device is programmed to set all Volatile Sector Protection Bit unprotected after power up, DQ4 outputs a 1. Each of these bits in the lock register are non-volatile. DQ15 - DQ5 are reserved and are 1s.

Lock Register

| DQ15-5 | DQ4 | DQ3 | DQ2 | DQ1 |
| :---: | :---: | :---: | :---: | :---: |
|  | DYB Lock Boot Bit | PPB One Time |  |  |
| 1s | $0=$ DYB bits power up | Programmable Bit | DQ0 |  |
|  | protected (Default) | 0=All PPB Erase | Password <br> Protection <br> Command disabled <br> Mode Lock Bit | Persistent <br> Protection <br> Mode Lock Bit <br> unprotected |

For programming lock register bits refer to Table 11.2.
Notes

1. If the password mode is chosen, the password must be programmed and verified before setting the corresponding lock register bit.
2. It is recommended that a sector protection method to be chosen by programming DQ1 or DQ2 prior to shipment
3. After the Lock Register Bits Command Set Entry command sequence is written, reads and writes for Bank 0 are disabled, while reads from other banks are allowed until exiting this mode.
4. If both lock bits are selected to be programmed (to zeros) at the same time, the operation aborts.
5. Once the Password Mode Lock Bit is programmed, the Persistent Mode Lock Bit is permanently disabled, and no changes to the protection scheme are allowed. Similarly, if the Persistent Mode Lock Bit is programmed, the Password Mode is permanently disabled.
6. During erase/program suspend, ASP entry commands are not allowed.
7. Data Polling can be done immediately after the lock register programming command sequence (no delay required). Note that status polling can be done only in bank 0.
8. Reads from other banks (simultaneous operation) are not allowed during lock register programming. This restriction applies to both synchronous and asynchronous read operations.
After selecting a sector protection method, each sector can operate in any of the following three states:
9. Constantly locked. The selected sectors are protected and can not be reprogrammed unless PPB lock bit is cleared via a password, hardware reset, or power cycle.
10. Dynamically locked. The selected sectors are protected and can be altered via software commands.
11. Unlocked. The sectors are unprotected and can be erased and/or programmed.

These states are controlled by the bit types described in Sections 7.2-7.6.

### 7.2 Persistent Protection Bits

The Persistent Protection Bits are unique and nonvolatile for each sector and have the same endurances as the Flash memory. Preprogramming and verification prior to erasure are handled by the device, and therefore do not require system monitoring.

## Notes

1. Each PPB is individually programmed and all are erased in parallel.
2. While programming PPB for a sector, array data can be read from any other bank, except Bank 0 (used for Data\# Polling) and the bank in which sector PPB is being programmed.
3. Entry command disables reads and writes for the bank selected.
4. Reads within that bank return the PPB status for that sector.
5. Reads from other banks are allowed while writes are not allowed.
6. All Reads must be performed using the Asynchronous mode.
7. The specific sector address (Amax - A14) are written at the same time as the program command.
8. If the PPB Lock Bit is set, the PPB Program or erase command does not execute and time out without programming or erasing the PPB.
9. There are no means for individually erasing a specific PPB and no specific sector address is required for this operation.
10. PPB exit command must be issued after the execution which resets the device to read mode and re-enables reads and writes for Bank 0
11. The programming state of the PPB for a given sector can be verified by writing a PPB Status Read Command to the device as described by the flow chart shown in Figure 7.2.
12. During PPB program/erase data polling can be done synchronously.
13. If customers attempt to program or erase a protected sector, the device ignores the command and returns to read mode.

Figure 7.2 PPB Program/Erase Algorithm


### 7.3 Dynamic Protection Bits

Dynamic Protection Bits are volatile and unique for each sector and can be individually modified. DYBs only control the protection scheme for unprotected sectors that have their PPBs cleared (erased to 1). By issuing the DYB Set or Clear command sequences, the DYBs are set (programmed to 0 ) or cleared (erased to 1), thus placing each sector in the protected or unprotected state respectively. This feature allows software to easily protect sectors against inadvertent changes yet does not prevent the easy removal of protection when changes are needed.

Notes

1. The DYBs can be set (programmed to 0 ) or cleared (erased to 1 ) as often as needed.
2. When the parts are first shipped, the DYBs are set and programmed to 0 upon power up or reset.
3. The default state of DYB is protected after power up and all sectors can be modified depending on the status of PPB bit for that sector, (erased to 1). Then the sectors can be modified depending upon the PPB state of that sector (see Table 7.1).
4. It is possible to have sectors that are persistently locked with sectors that are left in the dynamic state.
5. The DYB Set or Clear commands for the dynamic sectors signify protected or unprotectedstate of the sectors respectively. However, if there is a need to change the status of the persistently locked sectors, a few more steps are required. First, the PPB Lock Bit must be cleared by either putting the device through a power cycle, or hardware reset. The PPBs can then be changed to reflect the desired settings. Setting the PPB Lock Bit once again locks the PPBs, and the device operates normally again.
6. To achieve the best protection, it is recommended to execute the PPB Lock Bit Set command early in the boot code and protect the boot code by holding WP\# = $\mathrm{V}_{\mathrm{IL}}$.
7. Data polling is not available for DYB program/erase.
8. DYB read data can be done synchronously.
9. If customers attempt to program or erase a protected sector, the device ignores the command and returns to read mode.

### 7.4 Persistent Protection Bit Lock Bit

The Persistent Protection Bit Lock Bit is a global volatile bit for all sectors. When set (programmed to 0 ), it locks all PPBs and when cleared (programmed to 1), allows the PPBs to be changed. There is only one PPB Lock Bit per device.

Notes

1. If the password mode is chosen, then the password must be programmed and verified before setting the corresponding lock register bit.
2. No software command sequence unlocks this bit unless the device is in the password protection mode; only a hardware reset or a power up clears this bit.
3. The PPB Lock Bit must be set (programmed to 0 ) only after all PPBs are configured to the desired settings.

### 7.5 Password Protection Method

The Password Protection Method allows an even higher level of security than the Persistent Sector Protection Mode by requiring a 64 bit password for unlocking the device PPB Lock Bit. In addition to this password requirement, after power up and reset, the PPB Lock Bit is set $O$ to maintain the password mode of operation. Successful execution of the Password Unlock command by entering the entire password clears the PPB Lock Bit, allowing for sector PPBs modifications.
Notes

1. There is no special addressing order required for programming the password. Once the Password is written and verified, the Password Mode Locking Bit must be set in order to prevent access.
2. The Password Program Command is only capable of programming Os. Programming a 1 after a cell is programmed as a 0 results in a time out with the cell as a 0 .
3. The password is all 1 s when shipped from the factory.
4. All 64-bit password combinations are valid as a password.
5. There is no means to verify what the password is after it is set.
6. The Password Mode Lock Bit, once set, prevents reading the 64 -bit password on the data bus and further password programming.
7. The Password Mode Lock Bit is not erasable.
8. The lower two address bits (A1-A0) are valid during the Password Read, Password Program, and Password Unlock.
9. The exact password must be entered in order for the unlocking function to occur.
10. The Password Unlock command cannot be issued any faster than $1 \mu \mathrm{~s}$ at a time to prevent a hacker from running through all the 64-bit combinations in an attempt to correctly match a password.
11. Approximately $1 \mu \mathrm{~s}$ is required for unlocking the device after the valid 64 -bit password is given to the device.
12. Password verification is only allowed during the password programming operation.
13. All further commands to the password region are disabled and all operations are ignored.
14. If the password is lost after setting the Password Mode Lock Bit, there is no way to clear the PPB Lock Bit.
15. Entry command sequence must be issued prior to any of any operation and it disables reads and writes for Bank 0 . Reads and writes for other banks excluding Bank 0 are allowed.
16. If the user attempts to program or erase a protected sector, the device ignores the command and returns to read mode.
17. A program or erase command to a protected sector enables status polling and returns to read mode without having modified the contents of the protected sector.
18. The programming of the DYB, PPB, and PPB Lock for a given sector can be verified by writing individual status read commands DYB Status, PPB Status, and PPB Lock Status to the device.

Figure 7.3 Lock Register Program Algorithm


### 7.6 Advanced Sector Protection Software Examples

Table 7.1 Sector Protection Schemes

| Unique Device PPB Lock Bit <br> $\mathbf{0}=$ locked <br> $\mathbf{1}=$ unlocked |  | Sector PPB <br> $\mathbf{0}=$ protected <br> $\mathbf{1}=$ unprotected | Sector DYB <br> $\mathbf{0}=$ protected <br> $\mathbf{1}=$ unprotected | Sector Protection Status |
| :---: | :---: | :---: | :---: | :---: |
| Any Sector | 0 | 0 | $x$ | Protected through PPB |
| Any Sector | 0 | 0 | $x$ | Protected through PPB |
| Any Sector | 0 | 1 | 1 | Unprotected |
| Any Sector | 0 | 1 | 0 | Protected through DYB |
| Any Sector | 1 | 0 | $x$ | Protected through PPB |
| Any Sector | 1 | 0 | $x$ | Protected through PPB |
| Any Sector | 1 | 1 | 0 | Protected through DYB |
| Any Sector | 1 | 1 | 1 | Unprotected |

Table 7.1 contains all possible combinations of the DYB, PPB, and PPB Lock Bit relating to the status of the sector.

### 7.7 Hardware Data Protection Methods

The device offers two main types of data protection at the sector level via hardware control:
■ When WP\# is at $\mathrm{V}_{\mathrm{IL}}$, the highest two sectors are locked (device specific).

- When $V_{P P}$ is at $V_{I L}$, all sectors are locked.

There are additional methods by which intended or accidental erasure of any sectors can be prevented via hardware means. The following subsections describes these methods:

## WP\# Method

The Write Protect feature provides a hardware method of protecting the highest two sectors (NS256P and NS128P). This function is provided by the WP\# pin and overrides the previously discussed Sector Protection/ Unprotection method.

If the system asserts $\mathrm{V}_{\text {IL }}$ on the WP\# pin, the device disables program and erase functions in the highest two sectors (NS256P and NS128P) as well as Secured Silicon Area.

If the system asserts $\mathrm{V}_{\mathbb{I H}}$ on the WP\# pin, the device reverts to whether the boot sectors were last set to be protected or unprotected. That is, sector protection or unprotection for these sectors depends on whether they were last protected or unprotected.
Note that the WP\# pin must not be left floating or unconnected as inconsistent behavior of the device may result.

The WP\# pin must be held stable during a command sequence execution

## $V_{\text {PP }}$ Method

This method is similar to above, except it protects all sectors (including the Secured Silicon Area). Once $\mathrm{V}_{\mathrm{PP}}$ input is set to $\mathrm{V}_{\mathrm{IL}}$, all program and erase functions are disabled and hence all sectors are protected.

## Low $\mathrm{V}_{\text {cc }}$ Write Inhibit

When $\mathrm{V}_{\mathrm{CC}}$ is less than $\mathrm{V}_{\mathrm{LKO}}$, the device does not accept any write cycles. This protects data during $\mathrm{V}_{\mathrm{CC}}$ power up and power down.
The command register and all internal program/erase circuits are disabled, and the device resets to reading array data. Subsequent writes are ignored until $\mathrm{V}_{\mathrm{CC}}$ is greater than $\mathrm{V}_{\mathrm{LKO}}$. The system must provide the proper signals to the control inputs to prevent unintentional writes when $\mathrm{V}_{\mathrm{CC}}$ is greater than $\mathrm{V}_{\mathrm{LKO}}$.

## Write Pulse Glitch Protection

Noise pulses of less than 3 ns (typical) on OE\#, CE\# or WE\# do not initiate a write cycle.

## Power-Up Write Inhibit

If $\mathrm{WE} \#=\mathrm{CE} \#=\mathrm{RESET} \#=\mathrm{V}_{\mathrm{IL}}$ and OE\# = $\mathrm{V}_{\mathrm{IH}}$ during power up, the device does not accept commands on the rising edge of WE\#. The internal state machine is automatically reset to the read mode on power up.

## 8. Power Conservation Modes

### 8.1 Standby Mode

When the system is not reading or writing to the device, it can place the device in the standby mode. In this mode, current consumption is greatly reduced, and the outputs are placed in the high impedance state, independent of the OE\# input. The device enters the CMOS standby mode when the CE\# and RESET\# inputs are both held at $\mathrm{V}_{C C} \pm 0.2 \mathrm{~V}$. The device requires standard access time ( $\mathrm{t}_{\mathrm{CE}}$ ) for read access, before it is ready to read data. If the device is deselected during erasure or programming, the device draws active current until the operation is completed. $\mathrm{I}_{\mathrm{CC} 3}$ in the DC Characteristics section represents the standby current specification

### 8.2 Automatic Sleep Mode

The automatic sleep mode minimizes Flash device energy consumption while in asynchronous mode. the device automatically enables this mode when addresses remain stable for $\mathrm{t}_{\mathrm{ACC}}+20 \mathrm{~ns}$. The automatic sleep mode is independent of the CE\#, WE\#, and OE\# control signals. Standard address access timings provide new data when addresses are changed. While in sleep mode, output data is latched and always available to the system. While in synchronous mode, the automatic sleep mode is disabled. Note that a new burst operation is required to provide new data. $\mathrm{I}_{\mathrm{CC} 6}$ in the DC Characteristics section represents the automatic sleep mode current specification.

### 8.3 Hardware RESET\# Input Operation

The RESET\# input provides a hardware method of resetting the device to reading array data. When RESET\# is driven low for at least a period of $t_{\mathrm{RP}}$, the device immediately terminates any operation in progress, tristates all outputs, resets the configuration register, and ignores all read/write commands for the duration of the RESET\# pulse. The device also resets the internal state machine to reading array data. The operation that was interrupted should be reinitiated once the device is ready to accept another command sequence to ensure data integrity.
When RESET\# is held at $\mathrm{V}_{\mathrm{SS}} \pm 0.2 \mathrm{~V}$, the device draws CMOS standby current $\left(\mathrm{I}_{\mathrm{CC} 4}\right)$. If RESET\# is held at $\mathrm{V}_{\text {IL }}$ but not within $\mathrm{V}_{S S} \pm 0.2 \mathrm{~V}$, the standby current is greater.
RESET\# may be tied to the system reset circuitry and thus, a system reset also resets the Flash memory, enabling the system to read the boot-up firmware from the Flash memory.

### 8.4 Output Disable (OE\#)

When the OE\# input is at $\mathrm{V}_{\mathrm{IH}}$, output from the device is disabled. The outputs are placed in the high impedance state.

## 9. Secured Silicon Sector Flash Memory Region

The Secured Silicon Sector provides an extra Flash memory region that enables permanent part identification through an Electronic Serial Number (ESN). The Secured Silicon Sector is 256 words in length that consists of 128 words for factory data and 128 words for customer-secured areas. All Secured Silicon reads outside of the 256 -word address range returns invalid data. The Factory Indicator Bit, DQ7, (at Autoselect address 03h) is used to indicate whether or not the Factory Secured Silicon Sector is locked when shipped from the factory. The Customer Indicator Bit (DQ6) is used to indicate whether or not the Customer Secured Silicon Sector is locked when shipped from the factory.
Please note the following general conditions:

- While Secured Silicon Sector access is enabled, simultaneous operations are allowed except for Bank 0.

■ On power-up, or following a hardware reset, the device reverts to sending commands to the normal address space.

- Reads can be performed in the Asynchronous or Synchronous mode.

■ Burst mode reads within Secured Silicon Sector wrap from address FFh back to address 00h.

- Reads outside of sector 0 return memory array data.
- Continuous burst read past the maximum address is undefined.

■ Sector 0 is remapped from memory array to Secured Silicon Sector array.
■ Once the Secured Silicon Sector Entry Command is issued, the Secured Silicon Sector Exit command must be issued to exit Secured Silicon Sector Mode.

■ The Secured Silicon Sector is not accessible when the device is executing an Embedded Program or Embedded Erase algorithm.

Table 9.1 Secured Silicon SectorSecure Sector Addresses

| Sector | Sector Size | Address Range |
| :---: | :---: | :---: |
| Customer | 128 words | $000080 \mathrm{~h}-0000 \mathrm{FFh}$ |
| Factory | 128 words | $000000 \mathrm{~h}-00007 \mathrm{Fh}$ |

### 9.1 Factory Secured Silicon Sector

The Factory Secured Silicon Sector is always protected when shipped from the factory and has the Factory Indicator Bit (DQ7) permanently set to a 1. This prevents cloning of a factory locked part and ensures the security of the ESN and customer code once the product is shipped to the field.

These devices are available pre programmed with one of the following:
■ A random, 8 Word secure ESN only within the Factory Secured Silicon Sector

- Customer code within the Customer Secured Silicon Sector through the Spansion ${ }^{\top \mathrm{TM}}$ programming service.

■ Both a random, secure ESN and customer code through the Spansion programming service.
Customers may opt to have their code programmed through the Spansion programming services. Spansion programs the customer's code, with or without the random ESN. The devices are then shipped from the Spansion factory with the Factory Secured Silicon Sector and Customer Secured Silicon Sector permanently locked. Contact your local representative for details on using Spansion programming services.

### 9.2 Customer Secured Silicon Sector

The Customer Secured Silicon Sector is typically shipped unprotected (DQ6 set to 0), allowing customers to utilize that sector in any manner they choose. If the security feature is not required, the Customer Secured Silicon Sector can be treated as an additional Flash memory space.

Please note the following:
■ Once the Customer Secured Silicon Sector area is protected, the Customer Indicator Bit is permanently set to 1 .

- The Customer Secured Silicon Sector can be read any number of times, but can be programmed and locked only once. The Customer Secured Silicon Sector lock must be used with caution as once locked, there is no procedure available for unlocking the Customer Secured Silicon Sector area and none of the bits in the Customer Secured Silicon Sector memory space can be modified in any way.
■ The accelerated programming ( $\mathrm{V}_{\mathrm{PP}}$ ) and unlock bypass functions are not available when programming the Customer Secured Silicon Sector, but reading in Banks 1 through 15 is available.

■ Once the Customer Secured Silicon Sector is locked and verified, the system must write the Exit Secured Silicon Sector Region command sequence which return the device to the memory array at sector 0.

### 9.3 Secured Silicon Sector Entry and Exit Command Sequences

The system can access the Secured Silicon Sector region by issuing the three-cycle Enter Secured Silicon Sector command sequence. The device continues to access the Secured Silicon Sector region until the system issues the four-cycle Exit Secured Silicon Sector command sequence.
See Command Definition Table [Secured Silicon Sector Command Table, Appendix
Table 11.1 for address and data requirements for both command sequences.
The Secured Silicon Sector Entry Command allows the following commands to be executed

- Read customer and factory Secured Silicon areas
- Program the customer Secured Silicon Sector

After the system has written the Enter Secured Silicon Sector command sequence, it may read the Secured Silicon Sector by using the addresses normally occupied by sector SAO within the memory array. This mode of operation continues until the system issues the Exit Secured Silicon Sector command sequence, or until power is removed from the device.

## Software Functions and Sample Code

The following are C functions and source code examples of using the Secured Silicon Sector Entry, Program, and exit commands. Refer to the Spansion Low Level Driver User's Guide (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

Table 9.2 Secured Silicon Sector Entry (LLD Function = Ild_SecSiSectorEntryCmd)

| Cycle | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: |
| Unlock Cycle 1 | Write | Base + AAAh | Base +555 h |  |
| Unlock Cycle 2 | Write | Base +554 h | Base +2 AAh |  |
| Entry Cycle | Write | Base +AAAh | Base +555 h | 0055 h |

Note
Base = Base Address.

```
/* Example: Secured Silicon Sector Entry Command */
    *( (UINT16 *) base_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
    *( (UINT16 *)base_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
    *( (UINT16 *) base_addr + 0x555 ) = 0x0088; /* write Secured Silicon Sector Entry
Cmd */
```

Table 9.3 Secured Silicon Sector Program (LLD Function = Ild_ProgramCmd)

| Cycle | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: |
| Unlock Cycle 1 | Write | Base + AAAh | Base $+555 h$ | 00AAh |
| Unlock Cycle 2 | Write | Base +554 h | Base $+2 A A h$ | 0055 h |
| Program Setup | Write | Base + AAAh | Base $+555 h$ | 00A0h |
| Program | Write | Word Address | Word Address | Data Word |

## Note

Base $=$ Base Address.

```
/* Once in the Secured Silicon Sector mode, you program */
/* words using the programming algorithm.
```

Table 9.4 Secured Silicon Sector Exit (LLD Function = Ild_SecSiSectorExitCmd)

| Cycle | Operation | Byte Address | Word Address | Data |
| :---: | :---: | :---: | :---: | :---: |
| Unlock Cycle 1 | Write | Base + AAAh | Base +555 h | 00AAh |
| Unlock Cycle 2 | Write | Base +554 h | Base +2 AAh | 0055 h |
| Exit Cycle 3 | Write | Base + AAAh | Base +555 h | 0090h |
| Exit Cycle 4 | Write | Any address | Any address | 0000h |

Note
Base $=$ Base Address .

```
/* Example: Secured Silicon Sector Exit Command */
    *( (UINT16 *)base_addr + 0x555 ) = 0x00AA; /* write unlock cycle 1 */
    *( (UINT16 *)base_addr + 0x2AA ) = 0x0055; /* write unlock cycle 2 */
    *( (UINT16 *)base_addr + 0x555 ) = 0x0090; /* write Secured Silicon Sector Exit
cycle 3 */
    *( (UINT16 *) base_addr + 0x000 ) = 0x0000; /* write Secured Silicon Sector Exit
cycle 4 */
```


## 10. Electrical Specifications

### 10.1 Absolute Maximum Ratings

| Storage Temperature Plastic Packages | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| :--- | :---: |
| Ambient Temperature with Power Applied | $-65^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |
| Voltage with Respect to Ground: All Inputs and I/Os except as noted below (1) | -0.5 V to +2.5 V |
| $\mathrm{~V}_{\mathrm{CC}}(1)$ | -0.5 V to +2.5 V |
| $\mathrm{~V}_{\mathrm{PP}}(2)$ | -0.5 V to +9.5 V |
| Output Short Circuit Current (3) | 100 mA |

## Notes

1. Minimum $D C$ voltage on input or I/Os is -0.5 V . During voltage transitions, inputs or I/Os may undershoot $V_{S S}$ to -2.0 V for periods of up to 20 ns. See Figure 10.1. Maximum DC voltage on input or I/Os is $V_{C C}+0.5 \mathrm{~V}$. During voltage transitions outputs may overshoot to $V_{C C}$ +2.0 V for periods up to 20 ns . See Figure 10.2.
2. Minimum DC input voltage on pin $V_{P P}$ is -0.5 V . During voltage transitions, $V_{P P}$ may overshoot $V_{S S}$ to -2.0 V for periods of up to 20 ns . See Figure 10.1. Maximum DC voltage on pin $V_{P P}$ is +9.5 V , which may overshoot to 10.5 V for periods up to 20 ns .
3. No more than one output may be shorted to ground at a time. Duration of the short circuit should not be greater than one second.
4. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational sections of this data sheet is not implied. Exposure of the device to absolute maximum rating conditions for extended periods may affect device reliability.

Figure 10.1 Maximum Negative Overshoot Waveform


Figure 10.2 Maximum Positive Overshoot Waveform


### 10.2 Operating Ranges

| Wireless (I) Devices | Ambient Temperature $\left(\mathrm{T}_{\mathrm{A}}\right)$ | $-25^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| :--- | :--- | :--- |
| Supply Voltages | $\mathrm{V}_{\mathrm{CC}}$ Supply Voltages | +1.70 V to +1.95 V |

## Note

Operating ranges define those limits between which the functionality of the device is guaranteed.

### 10.3 DC Characteristics

### 10.3.1 CMOS Compatible

Table 10.1 DC Characteristics-CMOS Compatible

| Parameter | Description | Test Conditions (1) |  | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{l}_{\mathrm{LI}}$ | Input Load Current | $\mathrm{V}_{\text {IN }}=\mathrm{V}_{\text {SS }}$ to $\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{CC}}$ max |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| ILO | Output Leakage Current | $\mathrm{V}_{\text {OUT }}=\mathrm{V}_{\text {SS }}$ to $\mathrm{V}_{\mathrm{CC}}, \mathrm{V}_{\text {CC }}=\mathrm{V}_{\mathrm{CC}}$ max |  |  |  | $\pm 1$ | $\mu \mathrm{A}$ |
| $I_{\text {cCB }}$ | $\mathrm{V}_{\mathrm{CC}}$ Active burst Read Current | $\begin{aligned} & \mathrm{CE} \mathrm{\#}=\mathrm{V}_{\mathrm{IL}}, \mathrm{OE} \#=\mathrm{V}_{\mathrm{IH}}, \\ & \mathrm{WE} \mathrm{\#}=\mathrm{V}_{\mathrm{IH}}, \text { burst length }= \\ & 8 \end{aligned}$ | 108 Mhz |  | 33 | 44 | mA |
|  |  |  | 83 Mhz |  | 26 | 36 | mA |
|  |  |  | 66 Mhz |  | 24 | 33 | mA |
|  |  | $\begin{aligned} & C E \#=V_{\mathrm{IL}}, O E \#=\mathrm{V}_{\mathrm{IH}}, \\ & \mathrm{WE} \mathrm{\#}=\mathrm{V}_{\mathrm{IH}}, \text { burst length }= \\ & 16 \end{aligned}$ | 108 Mhz |  | 30 | 40 | mA |
|  |  |  | 83 Mhz |  | 26 | 38 | mA |
|  |  |  | 66 Mhz |  | 24 | 35 | mA |
|  |  | $\mathrm{CE} \#=\mathrm{V}_{\mathrm{IL}}, \mathrm{OE} \#=\mathrm{V}_{\mathrm{IH}},$ <br> $\mathrm{WE}=\mathrm{V}_{\mathrm{IH}}$, burst length $=$ 32 | 108 Mhz |  | 25 | 33 | mA |
|  |  |  | 83 Mhz |  | 28 | 40 | mA |
|  |  |  | 66 Mhz |  | 26 | 37 | mA |
|  |  | CE\# $=\mathrm{V}_{\mathrm{IL}}, \mathrm{OE} \#=\mathrm{V}_{\mathrm{IH}}$, $\mathrm{WE}=\mathrm{V}_{1 \mathrm{H}}$, burst length $=$ Continuous | 108 Mhz |  | 32 | 44 | mA |
|  |  |  | 83 Mhz |  | 30 | 42 | mA |
|  |  |  | 66 Mhz |  | 28 | 39 | mA |
| ${ }^{\text {CC1 }}$ | $\mathrm{V}_{\mathrm{CC}}$ Active Asynchronous Read Current (2) | $\begin{aligned} & \text { CE\# }=\mathrm{V}_{\mathrm{IL}}, O E \#=\mathrm{V}_{\mathrm{IH}}, \\ & \text { WE\# }=\mathrm{V}_{\mathrm{IH}} \end{aligned}$ | 10 MHz |  | 40 | 80 | mA |
|  |  |  | 5 MHz |  | 20 | 40 | mA |
|  |  |  | 1 MHz |  | 10 | 20 | mA |
| $\mathrm{I}_{\mathrm{CC} 2}$ | $\mathrm{V}_{\mathrm{CC}}$ Active Write Current (3) | $\begin{aligned} & C E \#=V_{\mathrm{IL}}, O E \#=V_{\mathrm{IH}}, \\ & V_{P P}=V_{\mathrm{H}} \end{aligned}$ | $\mathrm{V}_{\mathrm{PP}}$ |  | 1 | 5 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}$ |  | <20 | <40 | mA |
| $\mathrm{I}_{\mathrm{CC3}}$ | $\mathrm{V}_{\text {CC }}$ Standby Current (4) | $\begin{aligned} & \text { CE\# }=\text { RESET\# }= \\ & \mathrm{V}_{\mathrm{CC}} \pm 0.2 \mathrm{~V} \end{aligned}$ | $\mathrm{V}_{\mathrm{PP}}$ |  | 1 | 5 | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}$ |  | 20 | 70 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{CC} 4}$ | $\mathrm{V}_{\text {CC }}$ Reset Current | RESET\# = $\mathrm{V}_{\mathrm{IL}}$, CLK $=\mathrm{V}_{\mathrm{IL}}$ |  |  | 150 | 250 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{CC5}}$ | $\mathrm{V}_{\mathrm{CC}}$ Active Current <br> (Read While Write) | $C E \#=\mathrm{V}_{\mathrm{IL}}, O E \#=\mathrm{V}_{\mathrm{IH}}, \mathrm{V}_{\mathrm{PP}}=\mathrm{V}_{\mathrm{IH}},(7)$ |  |  | 50 | 60 | mA |
| $\mathrm{I}_{\mathrm{CC} 6}$ | $\mathrm{V}_{\text {CC }}$ Sleep Current | CE\# = $\mathrm{V}_{\mathrm{IL}}$, OE\# $=\mathrm{V}_{\mathrm{IH}}$ |  |  | 5 | 40 | $\mu \mathrm{A}$ |
| IPPW | Accelerated Program Current(5) | $\begin{aligned} & C E \#=V_{\mathrm{IL}}, \mathrm{OE}=\mathrm{V}_{\mathrm{IH}}, \\ & \mathrm{~V}_{\mathrm{PP}}=9.5 \mathrm{~V} \end{aligned}$ | $\mathrm{V}_{\mathrm{PP}}$ |  | <7 | <10 | mA |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}$ |  | <15 | <20 | mA |
| $\mathrm{V}_{\mathrm{IL}}$ | Input Low Voltage |  |  | -0.2 |  | 0.4 | V |
| $\mathrm{V}_{\mathrm{IH}}$ | Input High Voltage |  |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}- \\ 0.4 \end{gathered}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}+ \\ 0.4 \end{gathered}$ |  |
| $\mathrm{V}_{\mathrm{OL}}$ | Output Low Voltage | $\mathrm{I}_{\mathrm{OL}}=100 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{V}_{\mathrm{CC} \text { min }}=\mathrm{V}_{\mathrm{CC}}$ |  |  |  | 0.1 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | Output High Voltage | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CC}}=\mathrm{V}_{\text {CC min }}$ |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}- \\ 0.1 \end{gathered}$ |  |  | V |
| $\mathrm{V}_{\mathrm{HH}}$ | Voltage for Accelerated Program |  |  | 8.5 |  | 9.5 | V |
| $\mathrm{V}_{\text {LKO }}$ | Low $\mathrm{V}_{\text {CC }}$ Lock-out Voltage |  |  |  |  | 1.4 | V |

Notes

1. Maximum $I_{C C}$ specifications are tested with $V_{C C}=V_{C C} \max$.
2. The $I_{C C}$ current listed is typically less than $2 \mathrm{~mA} / \mathrm{MHz}$, with $O E \#$ at $V_{I H}$.
3. ICC active while Embedded Erase or Embedded Program is in progress.
4. Device enters automatic sleep mode when addresses are stable for $t_{A C C}+20 \mathrm{~ns}$. Typical sleep mode current is equal to $I_{C C 3}$.
5. Total current during accelerated programming is the sum of $\mathrm{V}_{\mathrm{PP}}$ and $V_{C C}$ currents.
6. $V_{C C Q}=V_{C C}$ during all ICC measurements.
7. Clock frequency 66 Mhz and in Continuous Mode.
8. For $I_{C C 6}$, when $V_{I H}=V_{I O}, V_{I L}=V_{S S}$.

### 10.4 Test Conditions

Figure 10.3 Test Setup


Table 10.2 Test Specifications

| Test Condition | All Speed Options | Unit |
| :--- | :---: | :---: |
| Output Load Capacitance, $\mathrm{C}_{\mathrm{L},}$ (including jig capacitance) | 30 | pF |
| Input Rise and Fall Times | $1.0-1.50$ | ns |
| Input Pulse Levels | $0.0-\mathrm{V}_{\mathrm{CC}}$ | V |
| Input timing measurement reference levels | $\mathrm{V}_{\mathrm{CC}} / 2$ | V |
| Output timing measurement reference levels | $\mathrm{V}_{\mathrm{CCQ}} / 2$ | V |

### 10.5 Key to Switching Waveforms

| Waveform | Inputs | Outputs |
| :---: | :---: | :---: |
|  | Steady |  |
| $\square D$ | Changing from H to L |  |
|  | Changing from L to H |  |
|  | Don't Care, Any Change Permitted | Changing, State Unknown |
|  | Does Not Apply | Center Line is High Impedance State (High Z) |

### 10.6 Switching Waveforms

Figure 10.4 Input Waveforms and Measurement Levels

All Inputs and Outputs


Table 10.3 $\mathrm{V}_{\mathrm{CC}}$ Power-Up with No Ramp Rate Restriction

| Parameter | Description | Test Setup | Time | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{VCS}}$ | $\mathrm{V}_{\mathrm{CC}}$ Setup Time | Min | 30 | $\mu \mathrm{~s}$ |
| $\mathrm{t}_{\mathrm{RH}}$ | Time between RESET\# (high) and CE\# (low) | Min | 200 | ns |

Note
$V_{C C}$ and $V_{C C Q}$ must be ramped simultaneously for proper power-up.

Figure 10.5 $\mathrm{V}_{\mathrm{CC}}$ Power-Up Diagram


### 10.7 CLK Characterization

Table 10.4 CLK Characterization

| Parameter | Description |  | 66 MHz | 83 MHz | 108 MHz | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ${ }_{\text {f CLK }}$ | CLK Frequency | Max | 66 | 83 | 108 | MHz |
|  |  | Min | 60 KHz in 8 word Burst, 120 KHz in 16 word Burst, 250 KHz in 32 word Burst, 1 MHz in Continuous Mode |  |  |  |
| $\mathrm{t}_{\text {CLK }}$ | CLK Period | Min | 15.1 | 12.5 | 9.26 | ns |
| $\mathrm{t}_{\mathrm{CL}} / \mathrm{t}_{\mathrm{CH}}$ | CLK Low/High Time | Min | $0.40 \mathrm{t}_{\text {CLK }}$ |  |  | ns |
|  |  | Max | $0.60 \mathrm{t}_{\text {CLK }}$ |  |  |  |
| $\mathrm{t}_{\mathrm{CR}}$ | CLK Rise Time | Max | 3.0 | 2.5 | 1.5 | ns |
| ${ }^{\text {ctF }}$ | CLK Fall Time |  |  |  |  |  |

Figure 10.6 CLK Characterization


### 10.8 AC Characteristics

### 10.8.1 Synchronous/Burst Read

Table 10.5 Synchronous/Burst Read

| Parameter |  | Description |  | 66 MHz | 83 MHz | 108 MHz | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JEDEC | Standard |  |  |  |  |  |  |
|  | $\mathrm{t}_{\text {IACC }}$ | Synchronous Access Time | Max | 80 |  |  | ns |
|  | $t_{\text {BACC }}$ | Burst Access Time Valid Clock to Output Delay | Max | 11.2 | 9 | 7.6 | ns |
|  | $\mathrm{t}_{\text {ACS }}$ | Address Setup Time to CLK (1) | Min | 4 |  |  | ns |
|  | $t_{\text {ACH }}$ | Address Hold Time from CLK (1) | Min | 6 | 5 | 5 | ns |
|  | $\mathrm{t}_{\text {BDH }}$ | Data Hold Time | Min | 3 | 3 | 2 | ns |
|  | $\mathrm{t}_{\text {RDY }}$ | Chip Enable to RDY Active | Max | 10 |  |  | ns |

Table 10.5 Synchronous/Burst Read

| Parameter |  | Description |  | 66 MHz | 83 MHz | 108 MHz | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JEDEC | Standard |  |  |  |  |  |  |
|  | $\mathrm{t}_{\mathrm{OE}}$ | Output Enable to RDY Low | Max | 9 | 9 | 9 | ns |
|  | $\mathrm{t}_{\text {CEZ }}$ | Chip Enable to High Z | Max | 10 | 10 | 10 | ns |
|  | toez | Output Enable to High Z | Max | 10 | 10 | 10 | ns |
|  | $\mathrm{t}_{\text {CES }}$ | CE\# Setup Time to CLK | Min |  | 4 |  | ns |
|  | $t_{\text {RACC }}$ | Ready Access Time from CLK | Max | 11.2 | 9 | 7.5 | ns |
|  | ${ }_{\text {t }}^{\text {CAS }}$ | CE\# Setup Time to AVD\# | Min |  | 0 |  | ns |
|  | $\mathrm{t}_{\text {AVDS }}$ | AVD\# Low to CLK Setup Time | Min |  | 5 |  | ns |
|  | $\mathrm{t}_{\text {AVDH }}$ | AVD\# Hold Time to CLK | Min |  | 3 |  | ns |
|  | $\mathrm{t}_{\text {AVDO }}$ | AVD\# High to OE\# Low | Min |  | 0 |  | ns |
|  | $\mathrm{t}_{\text {AVD }}$ | AVD\# Pulse | Min |  | 6 |  | ns |

Notes

1. Addresses are latched on the rising edge of CLK
2. Synchronous Access Time is calculated using the formula (\#of WS - 1) ${ }^{*}$ (clock period) $+\left(t_{B A C C}\right.$ or Clock to Out)
3. Not $100 \%$ tested for $t_{C E Z}, t_{O E Z}$.

Table 10.6 Synchronous Wait State Requirements

| Max Frequency | Wait State Requirement |
| :---: | :---: |
| Frequency $\leq 14 \mathrm{MHz}$ | 2 |
| $14<$ Frequency $\leq 27 \mathrm{MHz}$ | 3 |
| $27 \mathrm{MHz}<$ Frequency $\leq 40 \mathrm{MHz}$ | 4 |
| $40 \mathrm{MHz}<$ Frequency $\leq 54 \mathrm{MHz}$ | 5 |
| $54 \mathrm{MHz}<$ Frequency $\leq 66 \mathrm{MHz}$ | 6 |
| $66 \mathrm{MHz}<$ Frequency $\leq 80 \mathrm{MHz}$ | 7 |
| $80 \mathrm{MHz}<$ Frequency $\leq 95 \mathrm{MHz}$ | 8 |
| $95 \mathrm{MHz}<$ Frequency $\leq 108 \mathrm{MHz}$ | 9 |

Figure 10.7 8-Word Linear Synchronous Single Data Rate Burst with Wrap Around


## Notes

1. Figure shows for illustration the total number of wait states set to seven cycles.
2. The device is configured synchronous single data rate mode and RDY active with data.
3. CE\# (High) drives the RDY to Hi-Z while OE\# (High) drives the A/DQ15 - A/DQ0 pins to Hi-Z

Figure 10.8 8-Word Linear Single Data Read Synchronous Burst without Wrap Around


## Notes

1. Figure shows for illustration the total number of wait states set to seven cycles.
2. The device is configured synchronous single data rate mode and RDY active with data.
3. CE\# (High) drives the RDY to Hi-Z while OE\# (High) drives the A/DQ15 - A/DQ0 pins to HI-Z

### 10.8.2 Asynchronous Mode Read

Table 10.7 Asynchronous Mode Read

| Parameter |  | Description |  |  | 66 MHz | 83 MHz | 108 MHz | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JEDEC | Standard |  |  |  |  |  |  |  |
|  | $t_{\text {CE }}$ | Access Time from CE\# Low |  | Typ | 83 |  |  | ns |
|  | $t_{\text {ACC }}$ | Asynchronous Access Time |  | Max | 80 |  |  | ns |
|  | $\mathrm{t}_{\text {AVDP }}$ | AVD\# Low Time |  | Min | 7.5 |  |  | ns |
|  | $\mathrm{t}_{\text {AAVDS }}$ | Address Setup Time to Rising Edge of AVD\# |  | Min | 5 |  |  | ns |
|  | $\mathrm{t}_{\text {AAVDH }}$ | Address Hold Time from Rising Edge of AVD\# |  | Min | 3.5 |  |  | ns |
|  | $\mathrm{t}_{\mathrm{OE}}$ | Output Enable to Output Valid |  | Max | 9 | 9 | 9 | ns |
|  | $\mathrm{t}_{\text {OEH }}$ | Output Enable Hold Time | Read | Min | 0 |  |  | ns |
|  |  |  | Toggle and Data\# Polling | Min | 10 | 10 | 10 | ns |
|  | $\mathrm{t}_{\text {OEZ }}$ | Output Enable to High Z |  | Max | 10 | 10 | 10 | ns |
|  | $\mathrm{t}_{\text {CAS }}$ | CE\# Setup Time to AVD\# |  | Min | 0 |  |  | ns |

Figure 10.9 Asynchronous Mode Read with Latched Addresses


Note
$R A=$ Read Address, $R D=$ Read Data.

Figure 10.10 Asynchronous Mode Read


Note
$R A=$ Read Address, $R D=$ Read Data.

### 10.8.3 Hardware Reset (RESET\#)

Table 10.8 Warm Reset

| Parameter |  | Description |  | All Speed Options | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| JEDEC | Std |  |  |  |  |
|  | $\mathrm{t}_{\mathrm{RP}}$ | RESET\# Pulse Width | Min | 50 | ns |
|  | $\mathrm{t}_{\mathrm{RH}}$ | Reset High Time Before Read | Min | 200 | ns |
|  | $\mathrm{t}_{\text {RPH }}$ | RESET\# Low to CE\# Low | Min | 10 | $\mu \mathrm{s}$ |

Figure 10.11 Reset Timings


### 10.8.4 Erase/Program Timing

Table 10.9 Erase/Program Timing

| Parameter |  | Description |  |  | $\begin{gathered} 66 \\ \text { MHz } \end{gathered}$ | $\begin{gathered} 83 \\ \mathrm{MHz} \end{gathered}$ | $\begin{gathered} 108 \\ \mathrm{MHz} \end{gathered}$ | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| JEDEC | Standard |  |  |  |  |  |  |  |
| $\mathrm{t}_{\text {AVAV }}$ | $\mathrm{t}_{\mathrm{wc}}$ | Write Cycle Time (1) |  | Min |  | 60 |  | ns |
| ${ }^{\text {taVWL }}$ | $\mathrm{t}_{\mathrm{AS}}$ | Address Setup Time (2) | Synchronous | Min |  | 4 |  | ns |
|  |  |  | Asynchronous |  |  | 4 |  | ns |
| ${ }^{\text {twLAX }}$ | $\mathrm{t}_{\mathrm{AH}}$ | Address Hold Time (2) | Synchronous | Min |  | 3.5 |  |  |
|  |  |  | Asynchronous |  |  | 3.5 |  |  |
|  | $\mathrm{t}_{\text {AVDP }}$ | AVD\# Low Time |  | Min |  | 6 |  | ns |
| $t_{\text {dVw }}$ | $t_{\text {DS }}$ | Data Setup Time |  | Min |  | 20 |  | ns |
| ${ }^{\text {t }}$ WHDX | $t_{\text {DH }}$ | Data Hold Time |  | Min |  | 0 |  | ns |
| $\mathrm{t}_{\text {GHWL }}$ | $\mathrm{t}_{\text {GHWL }}$ | Read Recovery Time Before Write |  | Min |  | 0 |  | ns |
|  | $\mathrm{t}_{\text {CAS }}$ | CE\# Setup Time to AVD\# |  | Min |  | 0 |  | ns |
| $\mathrm{t}_{\text {WHEH }}$ | $\mathrm{t}_{\mathrm{CH}}$ | CE\# Hold Time |  | Min |  | 0 |  | ns |
| ${ }^{\text {twLWH }}$ | $t_{\text {WP }}$ | Write Pulse Width |  | Min |  | 25 |  | ns |
| ${ }^{\text {t WhWL }}$ | ${ }^{\text {twPH }}$ | Write Pulse Width High |  | Min |  | 20 |  | ns |
|  | $\mathrm{t}_{\text {SR/W }}$ | Latency Between Read and Write Operations |  | Min |  | 0 |  | ns |
|  | $\mathrm{t}_{\mathrm{VID}}$ | $\mathrm{V}_{\text {PP }}$ Rise and Fall Time |  | Min |  | 500 |  | ns |
|  | $t_{\text {vids }}$ | $\mathrm{V}_{\mathrm{PP}}$ Setup Time (During Accelerated Programming) |  | Min |  | 1 |  | $\mu \mathrm{s}$ |
| $t_{\text {ELWL }}$ | $\mathrm{t}_{\mathrm{CS}}$ | CE\# Setup Time to WE\# |  | Min |  | 4 |  | ns |
|  | $\mathrm{t}_{\text {AVSW }}$ | AVD\# Setup Time to WE\# |  | Min |  | 6 |  | ns |
|  | $\mathrm{t}_{\text {AVHW }}$ | AVD\# Hold Time to WE\# |  | Min |  | 4 |  | ns |
|  | $\mathrm{t}_{\text {SEA }}$ | Sector Erase Accept Time out |  | Min |  | 50 |  | $\mu \mathrm{s}$ |
|  | $t_{\text {ESL }}$ | Erase Suspend Latency |  | Min |  | 20 |  | $\mu \mathrm{s}$ |
|  | $t_{\text {PSL }}$ | Program Suspend Latency |  | Min |  | 20 |  | $\mu \mathrm{s}$ |
|  | $\mathrm{t}_{\text {ASP }}$ | Toggle Time During Erase within a Protected Sector |  | Typ |  | 280 |  | $\mu \mathrm{s}$ |
|  | $t_{\text {PSP }}$ | Toggle Time During Programming Within a Protected Sector |  | Typ |  | 1 |  | $\mu \mathrm{s}$ |
|  | $t_{\text {ERS }}$ | Erase Resume to Erase Suspend |  | Min |  | 30 |  | $\mu \mathrm{s}$ |
|  | $t_{\text {PRS }}$ | Program Resume to Program Suspend |  | Min |  | 30 |  | $\mu \mathrm{s}$ |

## Notes

1. Not $100 \%$ tested.
2. In asynchronous operation timing, addresses are latched on the rising edge of AVD\#.
3. See the Erase and Programming Performance section for more information. Does not include the preprogramming time.

Figure 10.12 Asynchronous Program Operation Timings


## Notes

1. $P A=$ Program Address, $P D=$ Program Data, $V A=$ Valid Address for reading status bits.
2. In progress and complete refer to status of program operation.
3. $C L K$ can be either $V_{I L}$ or $V_{I H}$.

Figure 10.13 Chip/Sector Erase Command Sequence


Note
SA is the sector address for Sector Erase.

Figure 10.14 Accelerated Unlock Bypass Programming Timing


Figure 10.15 Data\# Polling Timings (During Embedded Algorithm)


## Notes

1. Status reads in figure are shown as asynchronous.
2. VA = Valid Address. Two read cycles are required to determine status. When the Embedded Algorithm operation is complete, and Data\# Polling outputs true data.

Figure 10.16 Toggle Bit Timings (During Embedded Algorithm)


## Notes

1. Status reads in figure are shown as asynchronous.
2. VA = Valid Address. Two read cycles are required to determine status. When the Embedded Algorithm operation is complete, the toggle bits stop toggling.

Figure 10.17 Synchronous Data Polling Timings/Toggle Bit Timings


1. The timings are similar to synchronous read timings.
2. $V A=$ Valid Address. Two read cycles are required to determine status. When the Embedded Algorithm operation is complete, the toggle bits stop toggling.
3. $R D Y$ is active with data ( $D 8=0$ in the Configuration Register). When $D 8=1$ in the Configuration Register, RDY is active one clock cycle before data.

Figure 10.18 DQ2 vs. DQ6


Note
DQ2 toggles only when read at an address within an erase-suspended sector. The system may use OE\# or CE\# to toggle DQ2 and DQ6.

Figure 10.19 Latency with Boundary Crossing
Address boundary occurs every 128 words, beginning at address 00007Fh: (0000FFh, 00017Fh, etc.) Address 000000h is also a boundary crossing.


OE\#, (stays low)

## Notes

1. RDY active with data (CRO. $=0$ in the Configuration Register).
2. RDY active one clock cycle before data (CRO.8 $=1$ in the Configuration Register).
3. Figure shows the device not crossing a bank in the process of performing an erase or program.

Figure 10.20 Wait State Configuration Register Setup


Table 10.10 Example of Programmable Wait States


Note
The addresses are latched by rising edge of CLK.

Figure 10.21 Back-to-Back Read/Write Cycle Timings


## Note

Breakpoints in waveforms indicate that system may alternately read array data from the non-busy bank while checking the status of the program or erase operation in the busy bank. The system should read status twice to ensure valid information.

### 10.9 Erase and Programming Performance

Table 10.11 Erase and Programming Performance

| Parameter |  |  | Typ (1) | Max (2) | Unit | Comments |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Sector Erase Time | 64 Kword | $\mathrm{V}_{\mathrm{CC}}$ | 0.8 | 3.5 | s | Excludes 00h programming prior to erasure (3) |
|  | 16 Kword | $\mathrm{V}_{\mathrm{CC}}$ | 0.15 | 2.0 |  |  |
|  | 64 Kword | $\mathrm{V}_{\mathrm{PP}}$ | 0.8 | 3.5 |  |  |
|  | 16 Kword | $\mathrm{V}_{\mathrm{PP}}$ | 0.15 | 2.0 |  |  |
| Sector Erase Time | 64 Kword | $\mathrm{V}_{\mathrm{CC}}$ | 0.90 | 5.00 |  | Includes 00h programming prior to erasure (3) |
|  | 16 Kword | $\mathrm{V}_{\mathrm{CC}}$ | 0.45 | 1.85 |  |  |
|  | 64 Kword | $V_{P P}$ | 0.70 | 3.75 |  |  |
|  | 16 Kword | $V_{P P}$ | 0.35 | 1.40 |  |  |
| Chip Erase Time |  | $\mathrm{V}_{\mathrm{CC}}$ | $\begin{gathered} 77 \text { (NS128P) } \\ 154 \text { (NS256P) } \\ 306 \text { (NS512P) } \end{gathered}$ | $\begin{aligned} & 154 \text { (NS128P) } \\ & 308 \text { (NS256P) } \\ & 612 \text { (NS512P) } \end{aligned}$ | s |  |
| Word Programming Time |  | $\mathrm{V}_{\mathrm{CC}}$ | 40 | 400 | $\mu \mathrm{s}$ | Excludes system level overhead (4) |
|  |  | $\mathrm{V}_{\mathrm{PP}}$ | 24 | 240 |  |  |
| Effective Word Programming Time utilizing Program Write Buffer |  | $\mathrm{V}_{\mathrm{CC}}$ | 9.4 | 94 | $\mu \mathrm{s}$ |  |
|  |  | $\mathrm{V}_{\mathrm{PP}}$ | 6 | 60 |  |  |
| Total 32-Word Buffer Programming Time |  | $\mathrm{V}_{\mathrm{CC}}$ | 300 | 3000 |  |  |
|  |  | $\mathrm{V}_{\mathrm{PP}}$ | 192 | 1920 |  |  |
| Chip Programming Time (using 32 word buffer) |  | $\mathrm{V}_{\mathrm{CC}}$ | $\begin{gathered} \hline 78.6 \text { (NS128P) } \\ 157.3 \text { (NS256P) } \\ 314.6 \text { (NS512P) } \end{gathered}$ | $\begin{aligned} & \hline 157.3 \text { (NS128P) } \\ & 314.6 \text { (NS256P) } \\ & 629.2 \text { (NS512P) } \end{aligned}$ | s | Excludes system level overhead (4) |
|  |  | $\mathrm{V}_{\mathrm{PP}}$ | 51 (NS128P) <br> 101 (NS256P) <br> 202 (NS512P) | $\begin{aligned} & 102 \text { (NS128P) } \\ & 202 \text { (NS256P) } \\ & 404 \text { (NS512P) } \end{aligned}$ |  |  |
| Erase Suspend/Erase Resume |  | Min |  | 20 | $\mu \mathrm{s}$ |  |
| Program Suspend/Program Resume |  | Min |  | 20 | $\mu \mathrm{s}$ |  |

## Notes

1. Typical program and erase times assume the following conditions: $25^{\circ} \mathrm{C}, 1.8 \mathrm{~V} V_{C C}, 10,000$ cycles using checkerboard patterns.
2. Under worst case conditions of $90^{\circ} \mathrm{C}, V_{C C}=1.70 \mathrm{~V}, 100,000$ cycles.
3. In the pre-programming step of the Embedded Erase algorithm, all words are programmed to 00h before erasure.
4. System-level overhead is the time required to execute the two- or four-bus-cycle sequence for the program command. See Table 11.1, Memory Array Commands on page 78 and Table 11.2, Sector Protection Commands on page 80for further information on command definitions.

## 11. Appendix

This section contains information relating to software control or interfacing with the Flash device. For additional information and assistance regarding software, see www.spansion.com.

Table 11.1 Memory Array Commands

| Command Sequence (Notes) |  | $\begin{aligned} & \text { 』 } \\ & \stackrel{0}{0} \\ & 0 \end{aligned}$ | Bus Cycles (1, 2, 3, 4, 5, 6) |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | First | Second |  | Third |  | Fourth |  | Fifth |  | Sixth |  |
|  |  | Addr | Data <br> (19) | Addr | Data <br> (19) | Addr | Data <br> (19) | Addr | Data <br> (19) | Addr | Data <br> (19) | Addr | Data <br> (19) |
| Asynchronous Read (7) |  |  | 1 | RA | RD |  |  |  |  |  |  |  |  |  |  |
| Reset (8) |  |  | 1 | XXX | F0 |  |  |  |  |  |  |  |  |  |  |
| Autoselect (9) | Manufacturer ID | 4 | 555 | AA | 2AA | 55 | $\begin{gathered} \hline(\mathrm{BA}) \\ 555 \end{gathered}$ | 90 | $\begin{aligned} & \hline(\mathrm{BA}) \\ & \mathrm{X} 00 \end{aligned}$ | 0001 |  |  |  |  |
|  | Device ID (10) | 6 | 555 | AA | 2AA | 55 | $\begin{gathered} \hline(\mathrm{BA}) \\ 555 \end{gathered}$ | 90 | $\begin{aligned} & \hline(\mathrm{BA}) \\ & \mathrm{X} 01 \end{aligned}$ | 3x7E | $\begin{aligned} & \text { (BA)X } \\ & 0 \mathrm{E} \end{aligned}$ | (10) | $\begin{aligned} & \text { (BA) } \\ & \text { XOF } \end{aligned}$ | (10) |
|  | Indicator Bits | 4 | 555 | AA | 2AA | 55 | $\begin{gathered} \hline(\mathrm{BA}) \\ 555 \end{gathered}$ | 90 | $\begin{aligned} & \hline(\mathrm{BA}) \\ & \mathrm{X} 07 \end{aligned}$ | (12) |  |  |  |  |
|  | Sector Unlock/Lock Verify (11) | 4 | 555 | AA | 2AA | 55 | $\begin{gathered} \hline(S A) \\ 555 \end{gathered}$ | 90 | $\begin{aligned} & \hline(\mathrm{SA}) \\ & \mathrm{X} 02 \end{aligned}$ | $\begin{aligned} & 0000 / \\ & 0001 \end{aligned}$ |  |  |  |  |
|  | Revision ID | 4 | 555 | AA | 2AA | 55 | $\begin{gathered} \hline(\mathrm{BA}) \\ 555 \end{gathered}$ | 90 | $\begin{aligned} & \hline(\mathrm{BA}) \\ & \mathrm{X03} \end{aligned}$ |  |  |  |  |  |
| Single Word Program |  | 4 | 555 | AA | 2AA | 55 | 555 | AO | PA | Data |  |  |  |  |
| Write to Buffer ( |  | 6 | 555 | AA | 2AA | 55 | SA | 25 | SA | WC | PA | PD | WBL | PD |
| Write Buffer to Flash |  | 1 | SA | 29 |  |  |  |  |  |  |  |  |  |  |
| Write to Buffer Abort Reset (10) |  | 3 | 555 | AA | 2AA | 55 | 555 | F0 |  |  |  |  |  |  |
| Chip Erase |  | 6 | 555 | AA | 2AA | 55 | 555 | 80 | 555 | AA | 2AA | 55 | 555 | 10 |
| Sector Erase |  | 6 | 555 | AA | 2AA | 55 | 555 | 80 | 555 | AA | 2AA | 55 | SA | 30 |
| Program/Erase Suspend (15) |  | 1 | BA | B0 |  |  |  |  |  |  |  |  |  |  |
| Program/Erase | Resume (16) | 1 | BA | 30 |  |  |  |  |  |  |  |  |  |  |
| Set Configuration Register (21, 22, 24) |  | 5 | 555 | AA | 2AA | 55 | 555 | D0 | X00 | CRO | X01 | CR1 |  |  |
| Read Configuration Register |  | 4 | 555 | AA | 2AA | 55 | 555 | C6 | $\begin{gathered} \text { X0 } \\ \text { (0 or } \\ 1 \text { ) } \end{gathered}$ | $\begin{aligned} & \text { CR } \\ & \text { (0 or } \\ & 1 \text { ) } \end{aligned}$ |  |  |  |  |
| CFI Query (17) |  | 1 | $\begin{gathered} \hline(\mathrm{BA}) \\ 55 \end{gathered}$ | 98 |  |  |  |  |  |  |  |  |  |  |
| Unlock Bypass <br> Mode (23) | Unlock Bypass Entry (18) | 3 | 555 | AA | 2AA | 55 | 555 | 20 |  |  |  |  |  |  |
|  | Unlock Bypass Program (13), (14) | 2 | XX | AO | PA | PD |  |  |  |  |  |  |  |  |
|  | Unlock Bypass Sector Erase (13), (14) | 2 | XX | 80 | SA | 30 |  |  |  |  |  |  |  |  |
|  | Unlock Bypass Erase (13), (14) | 2 | XX | 80 | XXX | 10 |  |  |  |  |  |  |  |  |
|  | Unlock Bypass CFI (13), (14) | 1 | XX | 98 |  |  |  |  |  |  |  |  |  |  |
|  | Unlock Bypass Reset | 2 | XX | 90 | XXX | 00 |  |  |  |  |  |  |  |  |

Legend
$X=$ Don't care.
$R A=$ Read Address.
$R D=$ Read Data.
$P A=$ Program Address. Addresses latch on the rising edge of the AVD\# pulse or active edge of CLK, whichever occurs first
$P D=$ Program Data. Data latches on the rising edge of WE\# or CE\# pulse, whichever occurs first.
$S A=$ Sector Address. NS128P = A22-A14; NS256P $=A 23-A 14$.
$B A=$ Bank Address. NS128P = A22 - A20, and A19; NS064P = A21, A20 - A18; NS256P $=$ A23 - A20.CR $=$ Configuration Register data bits D15 - DO.

WBL $=$ Write Buffer Location. Address must be within the same write buffer page as PA.
WC = Word Count. Number of write buffer locations to load minus 1.

## Notes

1. See Table 6.1 for description of bus operations.
2. All values are in hexadecimal.
3. Except for the following, all bus cycles are write cycle: read cycle, fourth through sixth cycles of the Autoselect commands, fourth cycle of the configuration register verify and password verify commands, and any cycle reading at $R D(0)$ and $R D(1)$.
4. Data bits DQ15 - DQ8 are don't care in command sequences, except for RD, PD, WD, PWD, and PWD3 - PWDO.
5. Unless otherwise noted, address bits Amax - A14 are don't cares.
6. Writing incorrect address and data values or writing them in the improper sequence may place the device in an unknown state. The system must write the reset command to return the device to reading array data.
7. No unlock or command cycles required when bank is reading array data.
8. The Reset command is required to return to reading array data (or to the erase-suspend-read mode if previously in Erase Suspend) when a bank is in the autoselect mode, or if DQ5 goes high (while the bank is providing status information) or performing sector lock/unlock.
9. The fourth cycle of the autoselect address is a read cycle. The system must provide the bank address.
10. $(B A)+$ OEh $--->$ For NS128 $=43 h$, NS256 $=41 h$, NS512 $=3 F h(B A)+0 F h ~---->$ For NS128/256/512 $=00 h$
11. The data is 0000 h for an unlocked sector and 0001 h for a locked sector
12. See Table 6.12, Autoselect Addresses on page 34.
13. The Unlock Bypass command sequence is required prior to this command sequence.
14. The Unlock Bypass Reset command is required to return to reading array data when the bank is in the unlock bypass mode.
15. The system may read and program in non-erasing sectors, or enter the autoselect mode, when in the Erase Suspend mode. The Program/Erase Suspend command is valid only during a program/ erase operation, and requires the bank address.
16. The Program/Erase Resume command is valid only during the Program/Erase Suspend mode, and requires the bank address.
17. The total number of cycles in the command sequence is determined by the number of words written to the write buffer. The maximum number of cycles in the command sequence is 37 .
18. Write Buffer Programming can be initiated after Unlock Bypass Entry.
19. Data is always output at the rising edge of clock.
20. Do not enter wrong address or data cycles.
21. Do not use 0x30 for CR data (otherwise in the erase suspend --> CR read or set sequence, the device will go into erase resume instead of CR read or set).
22. Software reset is needed after CR read (otherwise the device is still in CR read mode).
23. When device is in Unlock Bypass mode, do not enter another command before Unlock Bypass reset command is issued).
24. Configuration Registers can not be programmed out of order. CRO must be programmed prior to CR01 otherwise the configuration registers retain their previous settings.

Table 11.2 Sector Protection Commands

|  | Command Sequence (Notes) | ¢ | Bus Cycles 1, 2, 3, 4, 5, 6 |  |  |  |  |  |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | First |  | Second |  | Third |  | Fourth |  | Fifth |  | Sixth |  | Seventh |  |
|  |  |  | Addr | Data <br> (10) | Addr | Data (10) | Addr | Data <br> (10) | Addr | Data <br> (10) | Addr | Data <br> (10) | Addr | Data <br> (10) | Addr | Data (10) |
|  | Entry (5) | 3 | 555 | AA | 2AA | 55 | 555 | 88 |  |  |  |  |  |  |  |  |
|  | Program | 4 | 555 | AA | 2AA | 55 | 555 | A0 | PA | PD |  |  |  |  |  |  |
|  | Read | 1 | 00 | data |  |  |  |  |  |  |  |  |  |  |  |  |
|  | Exit (7) | 4 | 555 | AA | 2AA | 55 | 555 | 90 | XX | 00 |  |  |  |  |  |  |
|  | Register Command Set Entry (5) | 3 | 555 | AA | 2AA | 55 | 555 | 40 |  |  |  |  |  |  |  |  |
|  | Register Bits Program (6) | 2 | XX | A0 | 00 | data |  |  |  |  |  |  |  |  |  |  |
|  | Register Bits Read | 1 | 00 | data |  |  |  |  |  |  |  |  |  |  |  |  |
|  | Register Command Set Exit (7) | 2 | XX | 90 | XX | 00 |  |  |  |  |  |  |  |  |  |  |
| 응00000 | Protection Command Set Entry | 3 | 555 | AA | 2AA | 55 | 555 | 60 |  |  |  |  |  |  |  |  |
|  | Program (9) | 2 | XX | A0 | $\begin{gathered} 00 / \\ 01 / \\ 02 / 03 \end{gathered}$ | $\begin{gathered} \text { PWD0/ } \\ \text { 1/ } \\ 2 / 3 / \end{gathered}$ |  |  |  |  |  |  |  |  |  |  |
|  | Read Password (10) | 4 | 00 | $\begin{gathered} \text { PWD } \\ 0 \end{gathered}$ | 01 | PWD1 | 02 | $\begin{gathered} \text { PWD } \\ 2 \end{gathered}$ | 03 | $\begin{gathered} \text { PWD } \\ 3 \end{gathered}$ |  |  |  |  |  |  |
|  | Unlock (9) | 7 | 00 | 25 | 00 | 03 | 00 | $\begin{gathered} \text { PWD } \\ 0 \end{gathered}$ | 01 | $\begin{gathered} \text { PWD } \\ 1 \end{gathered}$ | 02 | $\begin{gathered} \text { PWD } \\ 2 \end{gathered}$ | 03 | $\begin{gathered} \text { PWD } \\ 3 \end{gathered}$ | 00 | 29 |
|  | Protection Command Set Exit | 2 | XX | 90 | XX | 00 |  |  |  |  |  |  |  |  |  |  |
|  | Non-Volatile Sector Protection Command Set Entry (5) | 3 | 555 | AA | 2AA | 55 | $\begin{gathered} (\mathrm{BA}) \\ 555 \end{gathered}$ | C0 |  |  |  |  |  |  |  |  |
|  | Program | 2 | XX | A0 | $\begin{gathered} (B A) \\ \text { SA } \end{gathered}$ | 00 |  |  |  |  |  |  |  |  |  |  |
|  | All Erase (8) | 2 | XX | 80 | SAO | 30 |  |  |  |  |  |  |  |  |  |  |
|  | Status Read | 1 | $\begin{gathered} (\mathrm{BA}) \\ \mathrm{SA} \end{gathered}$ | RD(0) |  |  |  |  |  |  |  |  |  |  |  |  |
|  | Non-Volatile Sector Protection Command Set Exit (7) | 2 | XX | 90 | XX | 00 |  |  |  |  |  |  |  |  |  |  |
|  | Global Volatile Sector Protection Freeze Command Set Entry (5) | 3 | 555 | AA | 2AA | 55 | 555 | 50 |  |  |  |  |  |  |  |  |
|  | Set | 2 | XX | AO | XX | 00 |  |  |  |  |  |  |  |  |  |  |
|  | Status Read | 1 | XX | RD(0) |  |  |  |  |  |  |  |  |  |  |  |  |
|  | Global Volatile Sector <br> Protection Freeze Command Set Exit (7) | 2 | XX | 90 | XX | 00 |  |  |  |  |  |  |  |  |  |  |
| $\underset{\sim}{\infty}$ | Volatile Sector Protection Command Set Entry (5) | 3 | 555 | AA | 2AA | 55 | $\begin{aligned} & \text { (BA) } \\ & 555 \end{aligned}$ | E0 |  |  |  |  |  |  |  |  |
|  | Set | 2 | XX | A0 | $\begin{gathered} \text { (BA) } \\ \text { SA } \end{gathered}$ | 00 |  |  |  |  |  |  |  |  |  |  |
|  | Clear | 2 | XX | A0 | $\begin{gathered} (\mathrm{BA}) \\ \mathrm{SA} \end{gathered}$ | 01 |  |  |  |  |  |  |  |  |  |  |
|  | Status Read | 1 | $\begin{gathered} \text { (BA) } \\ \text { SA } \end{gathered}$ | $\mathrm{RD}(0)$ |  |  |  |  |  |  |  |  |  |  |  |  |
|  | Volatile Sector Protection Command Set Exit (7) | 2 | XX | 90 | XX | 00 |  |  |  |  |  |  |  |  |  |  |
|  | Program | 2 | 555 | A0 | PA | Data |  |  |  |  |  |  |  |  |  |  |
|  | Sector Erase | 2 | 555 | 80 | SA | 30 |  |  |  |  |  |  |  |  |  |  |
|  | Asynchronous Read | 1 | RA | RD |  |  |  |  |  |  |  |  |  |  |  |  |
|  | Write to Buffer | 4 | SA | 25 | SA | WC | PA | PD | WBL | PD |  |  |  |  |  |  |
|  | Program Buffer to Flash | 1 | SA | 29 |  |  |  |  |  |  |  |  |  |  |  |  |

## Legend

$X=$ Don't care
$R A=$ Read Address.
$R D=$ Read Data.
PA = Program Address. Addresses latch on the rising edge of the AVD\# pulse or active edge of CLK, whichever occurs first.
PD = Program Data. Data latches on the rising edge of WE\# or CE\# pulse, whichever occurs first.
SA = Sector Address. NS128P = A22 - A14, NS256P = A23 - A14.
$B A=$ Bank Address. NS128P = A22 - A20, and A19; NS256P = A23 - A20.
$C R=$ Configuration Register data bits D15-D0.
PWD3 - PWDO = Password Data. PD3 - PDO present four 16 bit combinations that represent the 64-bit Password
PWA = Password Address. Address bits A1 and A0 are used to select each 16-bit portion of the 64-bit entity.
PWD = Password Data.
$R D(0)=D Q 0$ protection indicator bit. If protected, $D Q 0=0$, if unprotected, $D Q O=1$.
WBL $=$ Write Buffer Location. Address must be within the same write buffer page as PA.
WC = Word Count. Number of write buffer locations to load minus 1.

## Notes

1. See Table 6.1 for description of bus operations.
2. All values are in hexadecimal.
3. Except for the following, all bus cycles are write cycle: read cycle, fourth through sixth cycles of the Autoselect commands, fourth cycle of the configuration register verify and password verify commands, and any cycle reading at RD(0) and RD(1).
4. Data bits DQ15 - DQ8 are don't care in command sequences, except for RD, PD, WD, PWD, and PWD3 - PWD0.
5. Unless otherwise noted, address bits Amax - A14 are don't cares.
6. Writing incorrect address and data values or writing them in the improper sequence may place the device in an unknown state. The system must write the reset command to return the device to reading array data.
7. No unlock or command cycles required when bank is reading array data.
8. The data is 0000 h for an unlocked sector and 0001 h for a locked sector.
9. The Exit command must be issued to reset the device into read mode, otherwise the device hangs.
10. Data is always output at the rising edge of clock.

### 11.1 Common Flash Memory Interface

The Common Flash Interface (CFI) specification outlines device and host system software interrogation handshake, which allows specific vendor-specified soft-ware algorithms to be used for entire families of devices. Software support can then be device-independent, JEDEC ID-independent, and forward-compatible and backward-compatible for the specified flash device families. Flash vendors can standardize their existing interfaces for long-term compatibility.

This device enters the CFI Query mode when the system writes the CFI Query command, 98h, to address (BA)55h any time the device is ready to read array data. The system can read CFI information at the addresses given in Tables 11.3 - 11.6) within that bank. All reads outside of the CFI address range, within the bank, returns non-valid data. Reads from other banks are allowed, writes are not. To terminate reading CFI data, the system must write the reset command.

The following is a C source code example of using the CFI Entry and Exit functions. Refer to the Spansion Low Level Driver User's Guide (www.spansion.com) for general information on Spansion Flash memory software development guidelines.

```
/* Example: CFI Entry command */
    *( (UINT16 *)bank_addr + 0x0055 = 0x0098; /* write CFI entry command */
/* Example: CFI Exit command */
    *( (UINT16 *) bank_addr + 0x000 ) = 0x00F0; /* write cfi exit command
```

    */
    For further information, please refer to the CFI Specification (see JEDEC publications JEP137-A and JESD68.01and CFI Publication 100). Please contact your sales office for copies of these documents.

Table 11.3 CFI Query Identification String

| Addresses | Data |  |
| :---: | :---: | :--- |
| 10 h | 0051 h |  |
| 11 h | 0052 h | Description |
| 12 h | 0059 h |  |
| 13 h | 0002 h | Qrimary Unique ASCII string QRY Command Set |
| 14 h | 0000 h |  |
| 15 h | 0040 h | Address for Primary Extended Table |
| 16 h | 0000 h |  |
| 17 h | 0000 h | Alternate OEM Command Set (00h = none exists) |
| 18 h | 0000 h |  |
| 19 h | 0000 h | Address for Alternate OEM Extended Table (00h = none exists) |
| 1 hh | 0000 h |  |

Table 11.4 System Interface String

| Addresses | Data | Description |
| :---: | :---: | :---: |
| 1Bh | 0017h | $\mathrm{V}_{\mathrm{CC}}$ Min. (write/erase) <br> D7 - D4: volt, D3 - D0: 100 millivolt |
| 1Ch | 0019h | $\mathrm{V}_{\mathrm{CC}}$ Max. (write/erase) <br> D7 - D4: volt, D3 - D0: 100 millivolt |
| 1Dh | 0000h | $\mathrm{V}_{\mathrm{PP}}$ Min. voltage ( $00 \mathrm{~h}=$ no $\mathrm{V}_{\mathrm{PP}}$ pin present) |
| 1Eh | 0000h | $\mathrm{V}_{\mathrm{PP}}$ Max. voltage ( $00 \mathrm{~h}=$ no $\mathrm{V}_{\mathrm{PP}}$ pin present) |
| 1Fh | 0005h | Typical Program Time per single word write $2^{\mathrm{N}} \mu \mathrm{s}$ (for example, $30 \mu \mathrm{~s}$ ) |
| 20h | 0009h | Typical Program Time using buffer $2^{N} \mu \mathrm{~s}$ (for example, 300us) ( $00 \mathrm{~h}=$ not supported) |
| 21h | 000Ah | Typical time for sector erase $2^{\mathrm{N}} \mathrm{ms}$ |
| 22h | 0000h | Typical time for full chip erase $2^{\mathrm{N}} \mathrm{ms}$ ( $00 \mathrm{~h}=$ not supported) |
| 23h | 0003h | Max. Program Time per single word [2 ${ }^{\mathrm{N}}$ times typical value] |
| 24h | 0002h | Max. Program Time using buffer [ $2^{\mathrm{N}}$ times typical value] |
| 25h | 0002h | Max. time for sector erase [ $2^{\mathrm{N}}$ times typical value] |
| 26h | 0000h | Max. time for full chip erase [ $2^{\mathrm{N}}$ times typical value] ( $00 \mathrm{~h}=$ not supported) |

Table 11.5 Device Geometry Definition (Sheet 1 of 2)

| Addresses | Data | Description |
| :---: | :---: | :---: |
| 27h | 0018h (NS128P) 0019h (NS256P) 001Ah (NS512P) | Device Size $=2^{N}$ byte |
| $\begin{aligned} & 28 \mathrm{~h} \\ & 29 \mathrm{~h} \end{aligned}$ | $\begin{aligned} & \text { 0001h } \\ & \text { 0000h } \end{aligned}$ | Flash Device Interface Oh=x8; 1h=x16; 2h=x8/x16; 3h=x32 [lower byte] [upper byte] (00h = not supported) |
| $\begin{aligned} & 2 \mathrm{Ah} \\ & 2 \mathrm{Bh} \end{aligned}$ | $\begin{aligned} & \text { 0006h } \\ & 0000 \mathrm{~h} \end{aligned}$ | Max. number of bytes in multi-byte buffer write $=2^{N}$ [lower byte] [upper byte] (00h = not supported) |
| 2Ch | 0002 h (NS128P) 0002 h (NS256P) 0001h (NS512P) | Number of Erase Block Regions within device <br> 01h = Uniform Sector; 02h = Boot + Uniform; 03h = Boot + Uniform + Boot |
| 2Dh | 007Eh (NS128P) 00FEh (NS256P) 01FFh (NS512P) | Erase Block Region 1 Information (Large Sector Section) <br> [lower byte] - Number of sectors. 00h=1 sector; 01h=2 sectors... 03h=4 sectors <br> [upper byte] <br> [lower byte] - Equation =>( $\mathrm{n}=$ Density in Bytes of any 1 sector/256)h <br> [upper byte] |
| 2Eh | 0000h |  |
| 2Fh | 0000h |  |
| 30h | 0002h |  |
| 31h | 0003h (NS128P) 0003h (NS256P) 0000h (NS512P) | Erase Block Region 2 Information (Small Sector Section) <br> [lower byte] - Number of sectors. |
| 32h | 0000h |  |
| 33h | 0080h (NS128P) 0080h (NS256P) 0000h (NS512P) | [upper byte] <br> [lower byte] - Equation =>( $\mathrm{n}=$ Density in Bytes of any 1 sector/256)h [upper byte] |
| 34h | 0000h |  |

Table 11.5 Device Geometry Definition (Sheet 2 of 2)

| Addresses | Data | Description |
| :---: | :---: | :---: |
| $\begin{aligned} & 35 \mathrm{~h} \\ & 36 \mathrm{~h} \\ & 37 \mathrm{~h} \\ & 38 \mathrm{~h} \end{aligned}$ | 0000h <br> 0000h <br> 0000h <br> 0000h | Erase Block Region 3 Information <br> [lower byte] - Number of sectors. 00h=1 sector; 01h=2 sectors... 03h=4 sectors <br> [upper byte] <br> [lower byte] - Equation =>( $\mathrm{n}=$ Density in Bytes of any 1 sector/256)h <br> [upper byte] |
| $\begin{aligned} & 39 \mathrm{~h} \\ & \text { 3Ah } \\ & \text { 3Bh } \\ & \text { 3Ch } \end{aligned}$ | 0000h <br> 0000h <br> 0000h <br> 0000h | Erase Block Region 4 Information |

Table 11.6 Primary Vendor-Specific Extended Query (Sheet 1 of 2)

| Addresses | Data | Description |
| :---: | :---: | :---: |
| $\begin{aligned} & 40 h \\ & 41 \mathrm{~h} \\ & 42 \mathrm{~h} \end{aligned}$ | $\begin{aligned} & \text { 0050h } \\ & 0052 \mathrm{~h} \\ & 0049 \mathrm{~h} \end{aligned}$ | Query-unique ASCII string PRI |
| 43h | 0031h | Major CFI version number, ASCII |
| 44h | 0034h | Minor CFI version number, ASCII |
| 45h | 0014h | Address Sensitive Unlock (Bits 1 - 0 ) <br> $00 \mathrm{~b}=$ Required, 01b $=$ Not Required <br> Silicon Technology (Bits 5-2) 0011b = $130 \mathrm{~nm} ; 0100 \mathrm{~b}=110 \mathrm{~nm} ; 0101 \mathrm{~b}=90 \mathrm{~nm}$ $001010 \mathrm{~b}=000 \mathrm{Ah}$ |
| 46h | 0002h | Erase Suspend $0=$ Not Supported, $1=$ To Read Only, $2=$ To Read \& Write |
| 47h | 0001h | Sector Protection per Group $0=$ Not Supported, $\mathrm{X}=$ Number of sectors in per group |
| 48h | 0000h | Sector Temporary Unprotect $00=$ Not Supported, $01=$ Supported |
| 49h | 0008h | Sector Protect/Unprotect scheme <br> 08h = Advanced Sector Protection; 07h = New Sector Protection Scheme |
| 4Ah | 0078h (NS128P) 00FOh (NS256P) 01EOh (NS512P) | Simultaneous Operation <br> Number of Sectors in all banks except bank0 |
| 4Bh | 0001h | Burst Mode Type $00=$ Not Supported, $01=$ Supported |
| 4Ch | 0000h | Not supported |
| 4Dh | 0085h | $\mathrm{V}_{\mathrm{PP}}$ (Acceleration) Supply Minimum <br> 00h = Not Supported, D7 - D4: Volt, D3 - D0: 100 mV |
| 4Eh | 0095h | $\mathrm{V}_{\mathrm{PP}}$ (Acceleration) Supply Maximum <br> 00h = Not Supported, D7 - D4: Volt, D3 - D0: 100 mV |
| 4Fh | 0003h (NS128P) 0003h (NS256P) 0005h (NS512P) | Write Protect Function <br> $00 \mathrm{~h}=$ No Boot, $01 \mathrm{~h}=$ Dual Boot, $02 \mathrm{~h}=$ Bottom Boot, 03h = Top Boot, 04h = Uniform Bottom, 05h = Uniform Top, 06h = All Sectors |
| 50h | 0001h | Program Suspend. OOh = not supported |
| 51h | 0001h | Unlock Bypass $00=$ Not Supported, 01=Supported |
| 52h | 0008h | Secured Silicon Sector (Customer OTP Area) Size $2^{\mathrm{N}}$ bytes |
| 53h | 0014h | Hardware Reset Low Time-out during an embedded algorithm to read mode Maximum $2^{\mathrm{N}}$ ns (for example, $10 \mu \mathrm{~s}=>\mathrm{n}=14$ ) |
| 54h | 0014h | Hardware Reset Low Time-out not during an embedded algorithm to read mode Maximum $2^{\mathrm{N}} \mathrm{ns}$ (for example, $10 \mu \mathrm{~s}=>\mathrm{n}=14$ ) |
| 55h | 0005h | Erase Suspend Time-out Maximum $2^{\mathrm{N}} \mu \mathrm{s}$ |
| 56h | 0005h | Program Suspend Time-out Maximum $2^{\mathrm{N}} \mu \mathrm{s}$ |
| 57h | 0010h | Bank Organization: $\mathrm{X}=$ Number of banks |
| 58h | 0008h (NS128P) 0010h (NS256P) 0020h (NS512P) | Bank 0 Region Information. $\mathrm{X}=$ Number of sectors in bank |

Table 11.6 Primary Vendor-Specific Extended Query (Sheet 2 of 2)

| Addresses | Data | Description |
| :---: | :---: | :---: |
| 59h | 0008h (NS128P) 0010h (NS256P) 0020h (NS512P) | Bank 1 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 5Ah | 0008h (NS128P) 0010h (NS256P) 0020h (NS512P) | Bank 2 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 5Bh | 0008h (NS128P) 0010h (NS256P) 0020h (NS512P) | Bank 3 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 5Ch | 0008h (NS128P) <br> 0010h (NS256P) <br> 0020h (NS512P) | Bank 4 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 5Dh | 0008h (NS128P) 0010h (NS256P) 0020h (NS512P) | Bank 5 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 5Eh | 0008h (NS128P) <br> 0010h (NS256P) <br> 0020h (NS512P) | Bank 6 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 5Fh | 0008h (NS128P) 0010h (NS256P) 0020h (NS512P) | Bank 7 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 60h | 0008h (NS128P) 0010h (NS256P) 0020h (NS512P) | Bank 8 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 61h | 0008h (NS128P) 0010h (NS256P) 0020h (NS512P) | Bank 9 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 62h | 0008h (NS128P) 0010h (NS256P) 0020h (NS512P) | Bank 10 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 63h | 0008h (NS128P) <br> 0010h (NS256P) <br> 0020h (NS512P) | Bank 11 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 64h | 0008h (NS128P) <br> 0010h (NS256P) <br> 0020h (NS512P) | Bank 12 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 65h | 0008h (NS128P) 0010h (NS256P) 0020h (NS512P) | Bank 13 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 66h | 0008h (NS128P) 0010h (NS256P) 0020h (NS512P) | Bank 14 Region Information. $\mathrm{X}=$ Number of sectors in bank |
| 67h | 000Bh (NS128P) 0013h (NS256P) 0020h (NS512P) | Bank 15 Region Information. $\mathrm{X}=$ Number of sectors in bank |

## 12. Revision History

| Section | Description |
| :---: | :---: |
| Revision A (June 29, 2006) |  |
|  | Initial release |
| Revision A1 (February 20, 2007) |  |
| Global | The tAVDS specification is changed from 4 ns to 5 ns <br> The wait state for 83 MHz is changed to 8 <br> ICC3(Max) is changed to $70 \mu \mathrm{~A}$ and ICC6(Max) is changed to $40 \mu \mathrm{~A}$ <br> $\mathrm{VIL}(\mathrm{Min})$ is changed to -0.2 V <br> tOE (Max) in both Asynchronous \& Synchronous modes is changed to 9 ns across all frequencies <br> tCEZ (Max) is changed to 10 ns across all frequencies <br> tOEZ (Max) in both Asynchronous \& Synchronous modes is changed to 10 ns across all frequencies <br> tACH(Min) is changed to $6 \mathrm{~ns}(66 \mathrm{MHz})$ and $5 \mathrm{~ns}(83 \mathrm{MHz}$ and 108 MHz$)$ <br> tRDY(Max) is changed to 10 ns <br> tRACC(Max) is changed to 7.6 ns for 108 MHz <br> tOEH(Min) in Asynchronous mode is changed to 10 ns for 108 MHz <br> Erase and Programing Performance table is updated <br> tCE in Asynchronous mode is changed to 83ns |

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